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AMENDMENT HISTORY

Version	Date	Description
V1.0	Jul, 2017	New release.

DS-TM52F0200_E 2 Rev 1.0, 2017/07/21



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TM52_{Series} F52xx FAMILY

Common Features

CPU	MTP/Flash Program Memory	RAM Bytes	Dual Clock	Operation Mode	Timer0 Timer1 Timer2	UART	Real-time Timer3	LVD	LVR
Fast 8051 (2T)	4K~16K With IAP, ISP, ICP	256 ~ 512	SXT SRC FXT FRC	Fast Slow Idle Stop	8051 St	andard	15-bit	2.3V	1.8V 2.3V 2.9V

Note: IAP, ISP only for Flash type program memory

Family Members Features

P/N		Program Memory	RAM Bytes	IO Pin	PWM	SAR ADC	Touch Key	LCD	LED	SPI	Others
TM52F0200	Flash 8K Bytes	512	30	(8+2)-bit	12-bit	_	4x18	4x18	Yes	_	
	TM52F0200				x2	12-ch	14-ch				

P/N	Operation		peration Cur V=1, PWRS		Max. System Clock (Hz)				
F/IN	Voltage	Fast FRC	Slow SRC	Idle SRC	Stop	SXT	SRC	FXT	FRC
TM52F0200	1.8~5.5V	2.5mA	9μΑ	3μΑ	< 0.1μΑ	32K	24K	8M	7.37M

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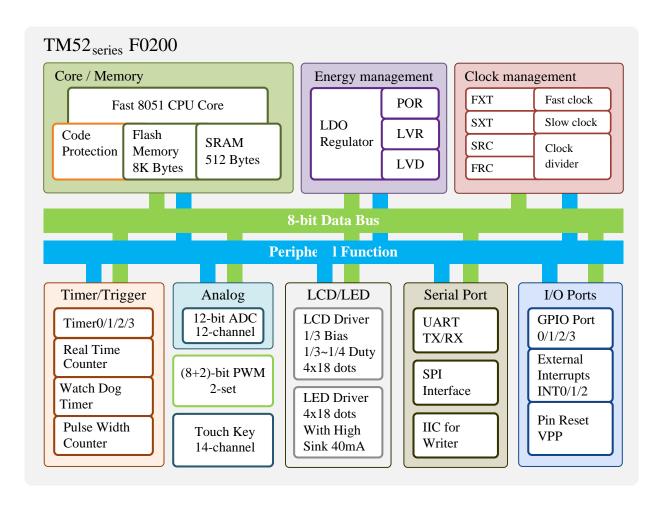


GENERAL DESCRPTION

TM52_{Series} TM52F0200 are versions of a new, fast 8051 architecture for an 8-bit microcontroller single chip with an instruction set fully compatible with industry standard 8051, and retains most 8051 peripheral's function block. Typically, the TM52 executes instructions six times faster than the standard 8051 architecture.

The TM52F0200 provides improved performance, lower cost and fast time-to-market by integrating features on the chip, including 8K Bytes Flash program memory, 512 Bytes SRAM, Low Voltage Reset (LVR), Low Voltage Detector (LVD), dual clock power saving operation mode, SPI Interface, 8051 standard UART and Timer0/1/2, real time clock Timer3, LCD/LED driver, 2 set (8+2)-bit PWMs, 12 channels 12-bit A/D Convertor, 14 channels Touch Key and Watchdog Timer. Its high reliability and low power consumption feature can be widely applied in consumer and home appliance products.

BLOCK DIAGRAM



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FEATURES

1. Standard 8051 Instruction set, fast machine cycle

• Executes instructions six times faster than the standard 8051

2. 8K Bytes Flash Program Memory

- Support "In Circuit Programming" (ICP) or "In System Programming" (ISP) for the Flash code
- Byte Write "In Application Programming" (IAP) mode is convenient as Data EEPROM access
- Code Protection Capability

3. Total 512 Bytes SRAM (IRAM + XRAM)

- 256 Bytes IRAM in the 8051 internal data memory area
- 256 Bytes XRAM in the 8051 external data memory area (accessed by MOVX Instruction)

4. Four System Clock type Selections

- Fast clock from 1~8 MHz Crystal (FXT)
- Fast clock from Internal RC (FRC 7.3728 MHz)
- Slow clock from 32768 Hz Crystal (SXT)
- Slow clock from Internal RC (SRC 24 KHz)
- System clock can be divided by 1/2/4/16 option

5. 8051 Standard Timer – Timer 0/1/2

- 16-bit Timer0, also supports T0O clock output for Buzzer application
- 16-bit Timer1
- 16-bit Timer2, also supports T2O clock output for Buzzer application

6. 15-bit Time3

- Clock source is Slow clock
- Interrupt period can be clock divided by 32768/16384/8192/128 option

7. 8051 Standard UART

• One Wire UART option can be used for ISP or other application

8. Two independent "8+2" bits PWMs with prescaler/period-adjustment

9. SPI Interface

- Master or Slave mode selectable
- Programmable transmit bit rate
- Serial clock phase and polarity options
- MSB-first or LSB-first selectable

10. 14-Channel Touch Key

11. 12-bit ADC with 10 Channels External Pin Input and 2 Channels Internal Reference Voltage

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12. LCD Controller/Driver

- 1/3~1/4 Duty
- Max. 4 COM x 18 SEG
- 1/3 LCD Bias
- 8 Brightness Level selection

13. LED Controller/Driver

- 1/3~1/4 Duty
- Max. 4 COM x 18 SEG
- 40mA High Sink COM
- Active High or Active Low Common Output
- COM Dead Time option

14. 11 Sources, 4-level Priority Interrupt

- Timer0/Timer1/Timer2/Timer3 Interrupt
- INTO/INT1 Falling-Edge/Low-Level Interrupt
- Port1 Pin Change Interrupt
- UART TX/RX Interrupt
- P3.7 (INT2) Interrupt
- ADC/Touch Key Interrupt
- SPI Interrupt

15. Pin Interrupt can Wake up CPU from Power-Down (Stop) mode

- P3.2/P3.3 (INT0/INT1) Interrupt & Wake-up
- P3.7 (INT2) Interrupt & Wake-up
- Each Port1 pin can be defined as Interrupt & Wake-up pin (by pin change)

16. Max. 30 Programmable I/O pins

- CMOS Output
- Pseudo-Open-Drain, or Open-Drain Output
- Schmitt Trigger Input
- Pin Pull-up can be Enable or Disable

17. Independent RC Oscillating Watchdog Timer

• 360ms/180ms/90ms/45ms Selectable WDT Timeout options

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18. Five types Reset

- Power on Reset
- Selectable External Pin Reset
- Software Command Reset
- Selectable Watchdog Timer Reset
- Selectable Low Voltage Reset

19. 3-level Low Voltage Reset

• TM52F0200: 1.8V/2.3V/2.9V (can be disabled)

20. 1-level Low Voltage Detect

• 2.3V (can be disabled)

21. Four Power Saving Operation Modes

• Fast/Slow/Idle/Stop Mode

22. On-chip Debug/ICE interface

- Use P3.0/P3.1 pin or P2.4/P2.5 pin
- Share with ICP programming pin

23. Operating Voltage and Current

- VCC=2.3V~5.5V @FSYSCLK=7.3728 MHz
- VCC=2.0V~5.5V @FSYSCLK=3.6864 MHz
- ICC=3µA @Stop mode, MODE3V=0, PWRSAV=1, VCC=3V
- ICC=3µA @Stop mode, MODE3V=1, PWRSAV=1, VCC=3V

24. Operating Temperature Range

• TM52F0200: -20°C ~ +70°C

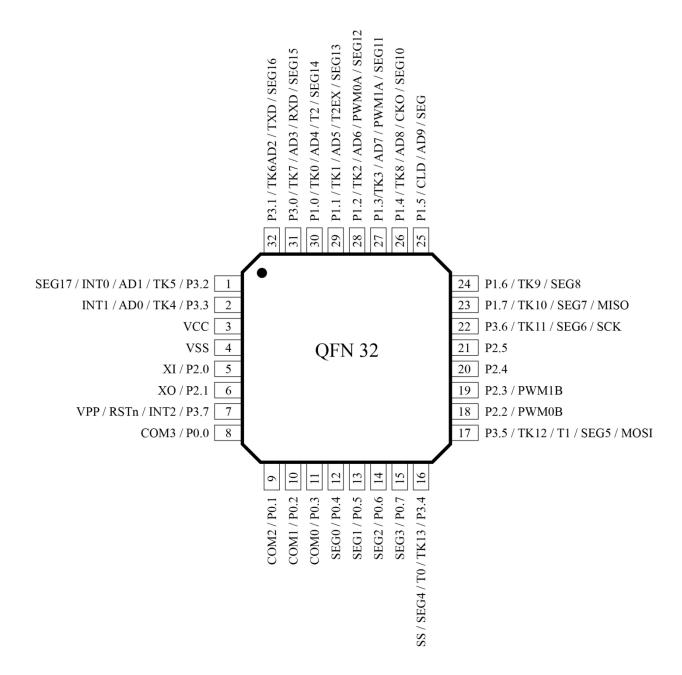
25. Package Types

• QFN32 pin (5*5*0.75 – 0.5mm)

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PIN ASSIGNMENT



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PIN DESCRIPTION

		Pin Description
P0.0~P0.7	I/O	Bit-programmable I/O port for Schmitt-trigger input or CMOS push-pull output.
P0.0~P0.7	1/0	Pull-up resistors are assignable by software.
		Bit-programmable I/O port for Schmitt-trigger input, CMOS push-pull output or
P1.0~P1.7	I/O	"open-drain" output. Pull-up resistors are assignable by software. These pin's level
		change can wake up CPU from Idle/Stop mode.
P2.0~P2.1	I/O	Bit-programmable I/O port for Schmitt-trigger input, CMOS push-pull output or "open-drain" output. Pull-up resistors are assignable by software.
		Bit-programmable I/O port for Schmitt-trigger input or CMOS push-pull output.
P2.2~P2.5	I/O	Pull-up resistors are assignable by software.
P2 0 P2 2	1/0	Bit-programmable I/O port for Schmitt-trigger input, CMOS push-pull output or
P3.0~P3.2	I/O	"pseudo open drain" output. Pull-up resistors are assignable by software.
P3.3~P3.6	I/O	Bit-programmable I/O port for Schmitt-trigger input, CMOS push-pull output or
15.5~15.0	1/0	"open-drain" output. Pull-up resistors are assignable by software.
P3.7	I/O	Bit-programmable I/O port for Schmitt-trigger input or "open-drain" output. Pull-up
		resistor is fix enable.
INTO, INT1	I	External low level or falling edge Interrupt input, Idle/Stop mode wake up input.
INT2	I	External falling edge Interrupt input, Idle/Stop mode wake up input.
RXD	I/O	UART Mode0 transmit & receive data, Mode1/2/3 receive data
TXD	I/O	UART Mode0 transmit clock, Mode1/2/3 transmit data. In One Wire UART mode,
TO T1 T2	T	this pin transmits and receives serial data.
T0, T1, T2	I	Timer0, Timer1, Timer2 event count pin input
T0O	0	Timer0 overflow divided by 64 output
T2O CKO	0	Timer2 overflow divided by 2 output
T2EX	O	System Clock divided by 2 output Timer2 external trigger input
PWM0A	1	Timerz externar trigger input
PWM0B		
PWM1A	O	8+2 bit PWM output
PWM1B		
AD0~AD9	I	ADC input
TK0~TK13	I	Touch Key input
CLD	I/O	Touch Key charge collection capacitor connection pin
SEG0~SEG17	О	LCD/LED segment output
COM0~COM3	О	LCD/LED common output
MISO	I/O	SPI data input for master mode, data output for slave mode
MOSI	I/O	SPI data output for master mode, data input for slave mode
SS	I	SPI active low slave select input for slave mode
SCK	I/O	SPI clock output for master or clock input for slave mode
RSTn	I	External active low reset input, Pull-up resistor is fixed enable
XI, XO	_	Crystal/Resonator oscillator connection for system clock
VPP	I	Flash programming high voltage input
VCC, VSS	P	Power input pin and ground

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PIN SUMMARY

TM52F0200

Pir Num				Input	t	(Outpu	ıt		Altei	nate	Fund	ction		Misc
QFN-32	Pin Name	Type	Pull-up Control	Wake up	Ext. Interrupt	P.P.	P.O.D.	0.D.	LCD/LED	ADC	SPI	UART	PWM	Timer	
1	INT0/AD1/SEG17/P3.2	I/O	0	•	•	•	•		•	•					
2	INT1/AD0/P3.3	I/O	0	•	•	•		•		•					
3	VCC	P													
4	VSS	P													
5	XI/P2.0	I/O	0			•		•							Crystal
6	XO/P2.1	I/O	0			•		•							Crystal
7	VPP/RSTn/INT2/P3.7	I/O	0	•	•			•							Reset
8	COM3/P0.0	I/O	•			•			•						
9	COM2/P0.1	I/O	•			•			•						
10	COM1/P0.2	I/O	•			•			•						
11	COM0/P0.3	I/O	•			•			•						
12	SEG0/P0.4	I/O	•			•			•						
13	SEG1/P0.5	I/O	•			•			•						
14	SEG2/P0.6	I/O	•			•			•						
15	SEG3/P0.7	I/O	•			•			•						
16	T0/T0O/SS/SEG4/P3.4	I/O	0			•		•	•		•			•	
17	T1/MOSI/SEG5/P3.5	I/O	0			•		•	•		•			•	
18	PWM0B/P2.2	I/O	•			•							•		
19	PWM1B/P2.3	I/O	•			•							•		
20	P2.4	I/O	•			•									
21	P2.5	I/O	•			•									
22	SCK/SEG6/P3.6	I/O	0			•		•	•		•				
23	MISO/SEG7/P1.7	I/O	0	•		•		•	•		•				
24	SEG8/P1.6	I/O	0	•		•		•	•						
25	AD9/SEG9/P1.5	I/O	0	•		•		•	•	•					_
26	CKO/AD8/SEG10/P1.4	I/O	0	•		•		•	•	•					
27	PWM1A/AD7/SEG11/P1.3	I/O	0	•		•		•	•	•			•		
28	PWM0A/AD6/SEG12/P1.2	I/O	0	•		•		•	•	•			•		

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	in nber				Input	t	C	utpu	ıt		Alte	rnate	Fun	ction		Misc
QFN-32		Pin Name	Type	Pull-up Control	Wake up	Ext. Interrupt	P.P.	P.O.D.	0.D.	LCD/LED	ADC	SPI	UART	PWM	Timer	
29		T2EX/AD5/SEG13/P1.1	I/O	0	•		•		•	•	•				•	
30		T2/T2O/AD4/SEG14/P1.0	I/O	0	•		•		•	•	•				•	
31		RXD/AD3/SEG15/P3.0	I/O	0			•	•		•	•		•			
32		TXD/AD2/SEG16/P3.1	I/O	0			•	•		•	•		•			

Symbol:

P.P. = Push-Pull Output O.D. = Open Drain P.O.D. = Pseudo Open Drain

PS:

- 1. ⊙ 3.7 Pull up resistor is fix enable
- 2. Port1, P2.0, P2.1, Port3 these pins control Pull up resistor by operation modes
- 3. Port0, P2.2~P2.5 these pins control Pull up resistor while PxOE.n=0 and Px.n=1

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FUNCTIONAL DESCRIPTION

1. CPU Core

In the 8051 architecture, the C programming language is used as a development platform. The TM52 device features a fast 8051 core in a highly integrated microcontroller, allowing designers to be able to achieve improved performance compared to a classic 8051 device. TM52 series microcontrollers provide a complete binary code with standard 8051 instruction set compatibility, ensuring an easy migration path to accelerate the development speed of system products. The CPU core includes an ALU, a program status word (PSW), an accumulator (ACC), a B register, a stack point (SP), DPTRs, a program counter, an instruction decoder, and core special function registers (SFRs).

1.1 Accumulator (ACC)

This register provides one of the operands for most ALU operations. Accumulators are generally referred to as A or Acc and sometimes referred to as Register A. In this document, the accumulator is represented as "A" or "ACC" including the instruction table. The accumulator, as its name suggests, is used as a general register to accumulate the intermediate results of a large number of instructions. The accumulator is the most important and frequently used register to complete arithmetic and logical operations. It holds the intermediate results of most arithmetic and logic operations and assists in data transportation.

SFR E0h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
ACC	ACC.7	ACC.6	ACC.5	ACC.4	ACC.3	ACC.2	ACC.1	ACC.0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

E0h.7~0 **ACC:** Accumulator

1.2 B Register (B)

The "B" register is very similar to the ACC and may hold a 1 Byte value. This register provides the second operand for multiply or divide instructions. Otherwise, it may be used as a scratch pad register. The B register is only used by two 8051 instructions, MUL and DIV. When A is to be multiplied or divided by another number, the other number is stored in B. For MUL and DIV instructions, it is necessary that the two operands are in A and B.

ex: DIV AB

When this instruction is executed, data inside A and B are divided, and the answer is stored in A.

SFR F0h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
В	B.7	B.6	B.5	B.4	B.3	B.2	B.1	B.0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

F0h.7~0 **B:** B register

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1.3 Stack Pointer (SP)

The SP register contains the Stack Pointer. The Stack Pointer is used to load the program counter into memory during LCALL and ACALL instructions and is used to retrieve the program counter from memory in RET and RETI instructions. The stack may also be saved or loaded using PUSH and POP instructions, which also increment and decrement the Stack Pointer. The Stack Pointer points to the top location of the stack.

SFR 81h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0				
SP		SP										
R/W		R/W										
Reset	0	0	0	0	0	1	1	1				

81h.7~0 **SP:** Stack Point

1.4 Dual Data Pointer (DPTRs)

TM52 device has two DPTRs, which share the same SFR address. Each DPTR is 16 bits in size and consists of two registers: the DPTR high byte (DPH) and the DPTR low byte (DPL). The DPTR is used for 16-bit-address external memory accesses, for offset code byte fetches, and for offset program jumps. Setting the DPSEL control bit allows the program code to switch between the two physical DPTRs.

SFR 82h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
DPL		DPL						
R/W		DPL R/W						
Reset	0	0	0	0	0	0	0	0

82h.7~0 **DPL:** Data Point low byte

SFR 83h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
DPH		DPH						
R/W		R/W						
Reset	0	0	0	0	0	0	0	0

83h.7~0 **DPH:** Data Point high byte

SFR F8h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
AUX1	CLRWDT	CLRTM3	TKSOC	ADSOC	CLRPWM0	_	_	DPSEL
R/W	R/W	R/W	R/W	R/W	R/W	_	_	R/W
Reset	0	0	0	0	0	_	_	0

F8h.0 **DPSEL:** Active DPTR Select

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1.5 Program Status Word (PSW)

This register contains status information resulting from CPU and ALU operations. The instructions that affect the PSW are listed below.

Instruction		Flag	
Histruction	C	OV	AC
ADD	X	X	X
ADDC	X	X	X
SUBB	X	X	X
MUL	0	X	
DIV	0	X	
DA	X		
RRC	X		
RLC	X		
SETB C	1		

Instruction		Flag	
instruction	C	OV	AC
CLR C	0		
CPL C	X		
ANL C, bit	X		
ANL C, /bit	X		
ORL C, bit	X		
ORL C, /bit	X		
MOV C, bit	X		
CJNE	X		

A "0" means the flag is always cleared, a "1" means the flag is always set and an "X" means that the state of the flag depends on the result of the operation.

SFR D0h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PSW	CY	AC	F0	RS1	RS0	OV	F1	P
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

D0h.7 **CY:** ALU carry flag

D0h.6 **AC:** ALU auxiliary carry flag

D0h.5 **F0:** General purpose user-definable flag

D0h.4~3 **RS1, RS0:** The contents of (RS1, RS0) enable the working register banks as:

00: Bank 0 (00h~07h)

01: Bank 1 (08h~0Fh)

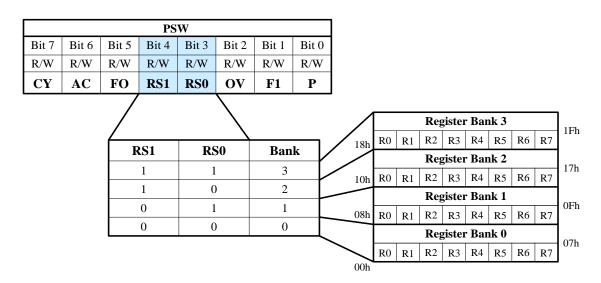
10: Bank 2 (10h~17h)

11: Bank 3 (18h~1Fh)

D0h.2 **OV:** ALU overflow flag

D0h.1 **F1:** General purpose user-definable flag

D0h.0 **P:** Parity flag. Set/cleared by hardware each instruction cycle to indicate odd/even number of "one" bits in the accumulator.



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2. Memory

2.1 Program Memory

The Chip has an 8K Bytes Flash program memory, which can support In Circuit Programming (ICP), In Application Programming (IAP) and In System Programming (ISP) function modes. The Flash write endurance is at least 50K cycles. The Flash program memory address continuous space (0000h~1FFFh) is partitioned to several sectors for device operation.

2.1.1 Program Memory Functional Partition

The last 2 bytes (1FFEh~1FFh) of program memory is defined as chip Configuration Word (CFGW), which is loaded into the device control registers upon power on reset (POR). The address space 1F00h~1FFDh is the IAP free area, while the 0000h~005Fh is occupied by Reset/Interrupt vectors as standard 8051 definition. In the in-circuit emulation (ICE) mode, user also needs to reserve the address space 0D00h~0FFFh for ICE System communication.

	8K Bytes Program Memory
0000h	
	Reset/Interrupt Vector
005Fh	
0060h	
	Han Cada ana
	User Code area
0CFFh	
0D00h	
	ICE mode reserve area
0FFFh	
1000h	
	User Code area
1EFFh	
1F00h	
	IAP-Free area
1FFDh	
1FFEh	CFGW
1FFFh	Cruw

2.1.2 Flash ICP Mode

The Flash memory can be programmed by the tenx proprietary writer (TWR98/TWR99), which needs at least four wires (VCC, VSS, P3.0 and P3.1 pins) to connect to this chip. To shorten the programming time, it is recommended to connect Writer with an additional fifth wire, which is the VPP (P3.7) pin. If the user wants to program the Flash memory on the target circuit board (In Circuit Programming, ICP), these pins must be reserved sufficient freedom to be connected to the Writer. More pins connected to Writer ensure more writing efficiency and speed. The P3.0 and P3.1 pin's can be replaced by P2.4 and P2.5.

Writer wire number	Pin connection
4-Wire	VCC, VSS, P3.0, P3.1
5-Wire	VCC, VSS, P3.0, P3.1, VPP
7-Wire	VCC, VSS, P3.0, P3.1, VPP, P3.3, P1.2 Note: P3.2 output FRC/2 and P3.5 always output Low in this mode

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2.1.3 Flash IAP Mode

The Chip has "In Application Programming" (IAP) capability, which allows software to read/write data from/to the Flash memory during CPU run time as conveniently as data EEPROM access. The IAP function is byte writable, meaning that the Chip does not need to erase one Flash page before write. The available IAP data space is 254 Bytes after chip reset, and can be re-defined by the "MVCLOCK" and "IAPALL" control register as shown below.

_	8K Bytes Flash Program Memory
0000h	MOVC-Lock area
01FFh	
0200h	
	IAP-All area
1EFFh	
1F00h	IAP-Free area
1FFEh	CECW
1FFFh	CFGW area

Flash Memory	MVCLOCK	IAPALL	MOVC Accessible	MOVX (IAP) Accessible
	1	X	No	No
0000h~01FFh	0	0	Yes	No
	0	1	Yes	Yes
0200h~1EFFh	X	0	Yes	No
020011~1EFF11	X	1	Yes	Yes
1F00h~1FFDh	X	X	Yes	Yes
1FFEh	X	0	Yes	No
IFFEII	X	1	Yes	Yes
1FFFh	X	X	Yes	No

In IAP mode, the program Flash memory is separated into four sectors: MOVC-Lock area, IAP-All area, IAP-Free area, and CFGW area. These four sectors are regulated differently.

In the MOVC-Lock area, IAP read/write is limited by MVCLOCK bit, which can be set to control the accessibility of the MOVC and MOVX instructions to this area. The size of this area is 512 Bytes. The lock function is made to protect the main program code against unconsciously writing Flash memory in IAP mode. Locking or unlocking the function should be performed by the tenx TWR98/99 writing to the CFGW in Flash memory.

The **IAP-All area** is protected by the IAPALL register to prevent IAP mode from writing application data to the program area, resulting in a program code error that cannot be repaired. The size of this area is 7424 Bytes. Enabling IAPALL requires writing 65h to SFR SWCMD 97h to set the IAPALL control flag. Then, software can use MOVX instructions to write application data to flash memory from 0200h to 1EFFh. If user wants to disable IAPALL function, user can write other values to SFR SWCMD 97h to clear the IAPALL control flag. User must be careful not to overwrite program code which is already resided on the same Flash memory area.

The **IAP-Free** area has no control bit to protect. It can be used to reliably store system application data that needs to be programmed once or periodically during system operation. Other areas of Flash memory can be used to store data, but this area is usually the best. The size of this area is 254 Bytes, equivalent to an EEPROM, and Flash memory can provide byte access to read and write commands. In the past, storage of configuration data required an additional EEPROM or the other storage device. However, this functionality can now be provided by on-chip Flash, reducing the chip count of embedded applications. An external EEPROM or SRAM may not be needed.

The **CFGW area** has 2 data bytes (CFGWH and CFGWL), which is located at the last 2 addresses of Flash memory. The CFGWH is not accessible to IAP, while the CFGWL can be read or written by IAP in case the IAPALL flag is set. CFGWL is copied to the SFR F7h after power on reset, software then take over CFGWL's control capability by modifying the SFR F7h.

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2.1.4 IAP Mode Access Routines

Flash IAP write is simply achieved by a "MOVX @DPTR, A" instruction while the DPTR contains the target Flash address (0000h~1FFEh), and the ACC contains the data being written. The Chip accepts IAP Write command only when the IAPWE SFR is enabled. Flash IAP writing requires approximately 500 μ s. Meanwhile, the CPU stays in a waiting state, but all peripheral modules (Timers, LCD, and others) continue running during the writing time. The software must handle the pending interrupts after an IAP write. Flash IAP writing needs higher V_{CC} voltage, V_{CC} >2.8V.

Because the Program memory and the IAP data space share the same entity, a Flash IAP read can be performed by the "MOVX A, @DPTR" or "MOVC" instruction as long as the target address points to the 0000h~1FFFh area. A Flash IAP read does not require extra CPU wait time.

; IAP example code ; need V_{CC}>2.8V

MOV DPTR, #1F00h ; DPTR=1F00h=target IAP address MOV A, #5Ah ; A=5Ah=target IAP write data

MOV INTE1, #A0h ; IAPWE=1

MOVX @DPTR, A ; Flash [1F00h] =5Ah, after IAP write

; 200µs~500µs H/W writing time, CPU wait

MOV INTE1, #00h ; IAPWE=0 immediately after IAP write

CLR A ; A=0 MOVX A, @DPTR ; A=5Ah CLR A ; A=0 MOVC A, @A+DPTR ; A=5Ah

Flash 1FFFh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
CFGWH	PROT	XRSTE		RE	VCCFLT	PWRSAV	MVCLOCK	_

1FFFh.1 MVCLOCK: If 1, the MOVC & MOVX instruction's accessibility to MOVC-Lock area is limited.

SFR 97h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
SWCMD		IAPALL/SWRST							
R/W		W						R/W	
Reset				-				0	

97h.7~0 **IAPALL (W):** Write 65h to set IAPALL control flag; Write other value to clear IAPALL flag. It is recommended to clear it immediately after IAP access.

97h.0 **IAPALL** (**R**): Flag indicates Flash memory sectors can be accessed by IAP or not. This bit combines with MVCLOCK to define the accessible IAP area.

SFR A9h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
INTE1		IAPWE		SPIE	TKIE	EX2	P1IE	TM3IE
R/W		R/W		R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

A9h.7~5 **IAPWE:** IAP write enable control

101: Enable IAP write. It is recommended to clear it immediately after IAP write.

Others value: Disable IAP write.

2.1.5 Flash ISP Mode

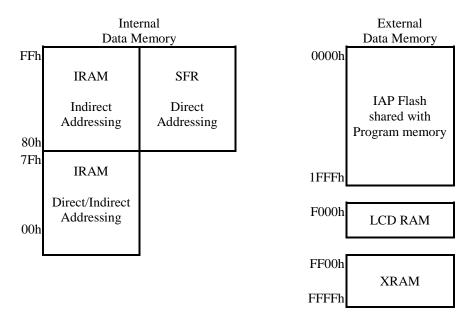
The "In System Programming" (ISP) usage is similar to IAP, except the purpose is to refresh the Program code. User can use UART/SPI or other method to get new Program code from external host, then writes code as the same way as IAP. ISP operation is complicated; basically it needs to assign a Boot code area to the Flash which does not change during the ISP process.

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2.2 Data Memory

As the standard 8051, the Chip has both Internal and External Data Memory space. The Internal Data Memory space consists of 256 Bytes IRAM and 67 SFRs, which are accessible through a rich instruction set. The External Data Memory space consists of 256 Bytes XRAM, LCDRAM and IAP Flash, which can be only accessed by MOVX instruction.



2.2.1 IRAM

IRAM is located in the 8051 internal data memory space. The whole 256 Bytes IRAM are accessible using indirect addressing but only the lower 128 Bytes are accessible using direct addressing. There are four directly addressable register banks (switching by PSW), which occupy IRAM space from 00h to 1Fh. The address 20h to 2Fh 16 Bytes IRAM space is bit-addressable. IRAM can be used as scratch pad registers or program stack.

2.2.2 XRAM

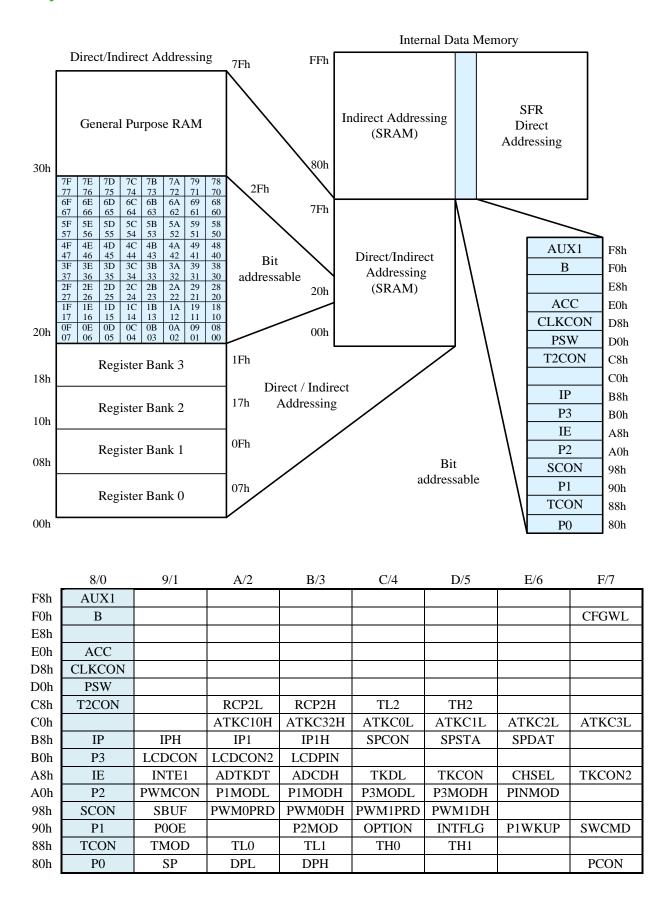
XRAM is located in the 8051 external data memory space (address from FF00h to FFFFh). The 256 Bytes XRAM can be only accessed by "MOVX" instruction.

2.2.3 SFRs

All peripheral functional modules such as I/O ports, Timers and UART operations for the chip are accessed via Special Function Registers (SFRs). These registers occupy upper 128 Bytes of direct Data Memory space locations in the range 80h to FFh. There are 14 bit-addressable SFRs (which means that eight individual bits inside a single byte are addressable), such as ACC, B register, PSW, TCON, SCON, and others. The remaining SFRs are only byte addressable. SFRs provide control and data exchange with the resources and peripherals of the Chip. The TM52 series of microcontrollers provides complete binary code with standard 8051 instruction set compatibility. Beside the standard 8051 SFRs, the Chip implements additional SFRs used to configure and access subsystems such as the SPI/LCD, which are unique to the Chip.

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3. Power

The Chip has a built-in internal low dropout regulator. When MODE3V=0, the voltage regulator outputs 3.3V power to the internal chip circuit. When MODE3V=1, the LDO is turned off, and the internal circuit receives a power supply directly from the VCC pin. Because the LDO consumes $150\mu A$ for operation, turning off LDO by setting MODE3V=1 can reduce the Chip current consumption. However, setting MODE3V=1 is only valid for an operating condition of V_{CC} <3.6V. The PWRSAV also control the LDO. When MODE3V=0 and PWRSAV=1, the LDO is turned off in Stop mode for saving power consumption. In addition, set PWRSAV will affect the LVR/LVD setting.

MODE3V=0

Operation	CFO	GW	LDO	LVD	LVD	E
Mode	PWRSAV	LVRE	LDO	LVR	LVD	Function
.	X	00	ON	ON	_	LV Reset 2.9V
Fast Slow	X	01	ON	ON	_	LV Reset 2.3V
Idle	X	10	ON	ON	ON	LV Reset Disable/2.0V
Tale	X	11	ON	ON	ON	LV Reset 1.8V/2.0V
	0	00	ON	ON	_	LV Reset 2.9V
	0	01	ON	ON	_	LV Reset 2.3V
	0	10	ON	ON	_	LV Reset Disable/2.0V
Ston	0	11	ON	ON	_	LV Reset 1.8V/2.0V
Stop	1	00	OFF	ON	_	LV Reset 1.8V/2.0V
	1	01	OFF	ON	_	LV Reset 1.8V/2.0V
	1	10	OFF	ON	_	LV Reset Disable/2.0V
	1	11	OFF	ON	_	LV Reset 1.8V/2.0V

MODE3V=1

Operation	CFO	GW	I DO	TVD	LVD	Function
Mode	PWRSAV	LVRE	LDO	LVR	LVD	runction
	0	00	OFF	ON	_	LV Reset 2.9V
	0	01	OFF	ON	_	LV Reset 2.3V
	0	10	OFF	ON	ON	LV Reset Disable/2.0V
Fast Slow	()		OFF	ON	ON	LV Reset 1.8V/2.0V
Idle	1	00	OFF	ON	_	LV Reset 1.8V/2.0V
Tule	1	01	OFF	ON	_	LV Reset 1.8V/2.0V
	1	10	OFF	ON	_	LV Reset Disable/2.0V
	1	11	OFF	ON	_	LV Reset 1.8V/2.0V
	0	00	OFF	ON	_	LV Reset 2.9V
	0	01	OFF	ON	_	LV Reset 2.3V
	0	10	OFF	ON	_	LV Reset Disable/2.0V
Ctom	0	11	OFF	ON	_	LV Reset 1.8V/2.0V
Stop	1	00	OFF	ON	_	LV Reset 1.8V/2.0V
	1	01	OFF	ON	_	LV Reset 1.8V/2.0V
	1	10	OFF	ON	-	LV Reset Disable/2.0V
	1	11	OFF	ON	_	LV Reset 1.8V/2.0V

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Flash 1FFFh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
CFGWH	PROT	XRSTE	LV	RE	VCCFLT	PWRSAV	MVCLOCK	_

1FFFh.3 **VCCFLT:** Set 1 to enhance the Chip's power noise immunity

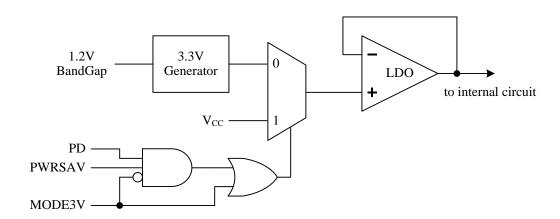
1FFFh.2 **PWRSAV:** Power saving function control bit

0: Disable Power saving function1: Enable Power saving function

SFR 94h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
OPTION	UART1W	MODE3V	WD7	ГРЅС	ADO	CKS	TM3	PSC
R/W	R/W	R/W	R/W		R/W		R/	W
Reset	0	0	0	0	0	0	0	0

94h.6 **MODE3V:** 3V mode selection control bit

If this bit is set, the Chip can be only operated in the condition of V_{CC} <3.6V, and LDO is turned off to save current



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4. Reset

The Chip has five types of reset methods. Resets can be caused by Power on Reset (POR), External Pin Reset (XRST), Software Command Reset (SWRST), Watchdog Timer Reset (WDTR), or Low Voltage Reset (LVR). The CFGW controls the Reset functionality. The SFRs are returned to their default value after Reset.

4.1 Power on Reset

After Power on Reset, the device stays on Reset state for 40 ms as chip warm up time, then downloads the CFGW register from Flash's last two bytes (Other Reset will not reload the CFGW). The Power on Reset needs VCC pin's voltage first discharge to near VSS level, then rise beyond 2.0V.

4.2 External Pin Reset

External Pin Reset is active low. It needs to keep at least 2 SRC clock cycle long to be seen by the Chip. External Pin Reset can be disabled or enabled by CFGW.

4.3 Software Command Reset

Software Reset is activated by writing the SFR 97h with data 56h.

4.4 Watchdog Timer Reset

WDT overflow Reset is disabled or enabled by SFR F7h. The WDT uses SRC as its counting time base. It runs in Fast/Slow mode and runs or stops in Idle/Stop mode. WDT overflow speed can be defined by WDTPSC SFR. WDT is cleared by device Reset or CLRWDT SFR bit.

4.5 Low Voltage Reset

The Chip offers three options for LVR and Low Voltage Detection (LVD) functions. The user can make a selection by CFGW, let LVR voltages of 2.9V, 2.3V, and 1.8V/2.0V be selected separately, and let LVD be 2.3V only. If the LVR is selected as 1.8V/2.0V, the 2.3V LVD flag is available for LVD. If LVR is selected as 2.3V or 2.9V, the LVD flag cannot be used.

System Clock frequency	8 MHz	6 MHz	4 MHz	2 MHz
Minimum LVR level	LVR=2.9V	LVR=2.9V	LVR=2.3V	LVR=1.8V/2.0V

LVR setting table

Note: LVR must be enable, also refer to AP-TM52XXXXX_02S for LVR setting information

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Flash 1FFEh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
CFGWL	WDTE		_			FRCF		

1FFEh.7~6 WDTE: Watchdog Timer Reset control

0x: Watchdog Timer Reset disable

10: Watchdog Timer Reset enable in Fast/Slow mode, disable in Idle/Stop mode

11: Watchdog Timer Reset always enable

Flash 1FFFh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
CFGWH	PROT	XRSTE	LVRE		VCCFLT	PWRSAV	MVCLOCK	_

1FFFh.6 **XRSTE:** External Pin Reset control

0: Disable External Pin Reset

1: Enable External Pin Reset

1FFFh.5~4 LVRE: Low Voltage Reset function select

00: Set LVR at 2.9V 01: Set LVR at 2.3V

10: LVR disable and set LVD at 2.3V11: Set LVR at 1.8V and LVD at 2.3V

SFR 94h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
OPTION	UART1W	MODE3V	WDT	WDTPSC		ADCKS		TM3PSC	
R/W	R/W	R/W	R/	R/W		W	R/	W	
Reset	0	0	0	0	0	0	0	0	

94h.5~4 **WDTPSC:** Watchdog Timer pre-scalar time select

00: 360ms WDT overflow rate 01: 180ms WDT overflow rate 10: 90ms WDT overflow rate 11: 45ms WDT overflow rate

SFR 95h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
INTFLG	LVD	_	TKIF	ADIF	_	IE2	P1IF	TF3
R/W	R	_	R/W	R/W	_	R/W	R/W	R/W
Reset	_	_	0	0	_	0	0	0

95h.7 **LVD:** Low Voltage Detect flag

Set by H/W when a low voltage occurs. The flag is valid when LVR is 2.0V. This flag is disabled in Stop mode or if MODE3V=1 and PWRSAV=1.

SFR 97h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
SWCMD		IAPALL/SWRST								
R/W		W								
Reset		-								

97h.7~0 **SWRST:** Write 56h to generate S/W Reset

SFR F8h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
AUX1	CLRWDT	CLRTM3	TKSOC	ADSOC	CLRPWM0	_	_	DPSEL
R/W	R/W	R/W	R/W	R/W	R/W	_	_	R/W
Reset	0	0	0	0	0	_	_	0

F8h.7 **CLRWDT:** Set to clear WDT, H/W auto clear it at next clock cycle

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5. Clock Circuitry and Operation Mode

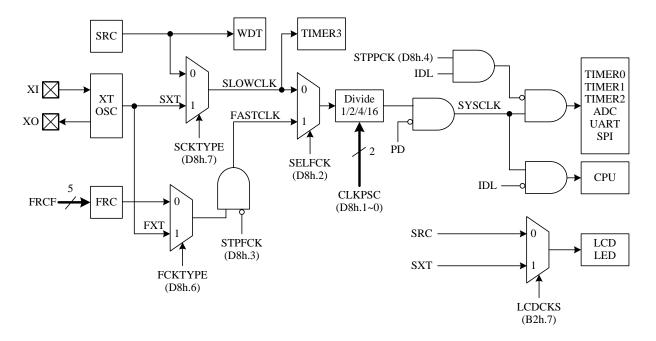
5.1 System Clock

The Chip is designed with dual-clock system. During runtime, user can directly switch the System clock from fast to slow or from slow to fast. It also can directly select a clock divider of 1, 2, 4 or 16. The Fast clock can be selected as FXT (Fast Crystal, 1~8 MHz) or FRC (Fast Internal RC, 7.3728 MHz). The Slow clock can be selected as SXT (Slow Crystal, 32 KHz) or SRC (Slow Internal RC, 24 KHz). Fast mode and Slow mode are defined as the CPU running at Fast and Slow clock speeds.

After Reset, the device is running at Slow mode with 24 KHz SRC. S/W should select the proper clock rate for chip operation safety. The higher V_{CC} allows the chip to run at a higher System clock frequency. In a typical condition, an 8 MHz System clock rate requires V_{CC} >2.5V.

The Chip has an external oscillators connected to the XI/XO pins. It relies on external circuitry for the clock signal and frequency stabilization, such as a stand-alone oscillator, quartz crystal, or ceramic resonator. In Fast mode, the fast oscillator can be used in the range from 1~8 MHz. In Slow mode, the slow oscillator can only use a clock frequency of 32.768 KHz.

The **CLKCON** SFR controls the System clock operating. H/W automatically blocks the S/W abnormally setting for this register. S/W can only change the Slow clock type in Fast mode and change the Fast clock type in Slow mode. Never to write both STPFCK=1 & SELFCK=1. It is recommended to write this SFR bit by bit.



Note: also refer to AP-TM52XXXXX 01S and AP-TM52XXXXX 02S about System Clock Application Note.

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5.2 Operation Mode

There are four operation modes for this device. **Fast Mode** is defined as the CPU running at Fast clock speed. **Slow Mode** is defined as the CPU running at Slow clock speed. When the System clock speed is lower, the power consumption is lower.

Idle Mode is entered by setting the IDL bit in PCON SFR. Both Fast and Slow clock can be set as the System clock source in Idle Mode, but Slow clock is better for power saving. In Idle mode, the CPU puts itself to sleep while the on-chip peripherals stay active. The "STPPCK" bit in CLKCON SFR can be set to furthermore reduce Idle mode current. If STPPCK=1, Timer0/1/2, ADC and UART are stopped in Idle mode. The slower System clock rate also helps current saving. It can be achieved by setup the CLKPSC SFR to divide System clock frequency. Idle mode is terminated by Reset or enabled Interrupts wake up.

Stop Mode is entered by setting the PD bit in PCON SFR. This mode is the so-called "Power Down" mode in standard 8051. In Stop mode, all clocks stop except the WDT is alive if it is enabled. Stop mode can be terminated by Reset or pin wake up.

Note: Chip cannot enter Stop Mode if INTn pin is low and wakeup is enabled. (INTn=0 and EXn=1, n=0, 1, 2)

SFR 87h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PCON	SMOD	_	_	_	GF1	GF0	PD	IDL
R/W	R/W	_	_	_	R/W	R/W	R/W	R/W
Reset	0	_	_	_	0	0	0	0

87h.1 **PD:** Stop bit. If 1 Stop mode is entered. 87h.0 **IDL:** Idle bit. If 1, Idle mode is entered.

SFR D8h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
CLKCON	SCKTYPE	FCKTYPE		STPPCK	STPFCK	SELFCK	CLK	PSC
R/W	R/W	R/W	_	R/W	R/W	R/W	R/	W
Reset	0	0	_	0	0	0	1	1

D8h.7 **SCKTYPE:** Slow clock type. This bit can be changed only in Fast mode (SELFCK=1).

0: SRC

1: SXT

D8h.6 **FCKTYPE:** Fast clock type. This bit can be changed only in Slow mode (SELFCK=0).

0: FRC

1: FXT

D8h.4 **STPPCK:** Set 1 to stop UART/Timer0/Timer1/Timer2/ADC clock in Idle mode

D8h.3 **STPFCK:** Set 1 to stop Fast clock for power saving in Slow/Idle mode.

This bit can be changed only in Slow mode.

D8h.2 **SELFCK:** System clock source selection. This bit can be changed only when STPFCK=0.

0: Slow clock

1: Fast clock

D8h.1~0 **CLKPSC:** System clock prescaler.

00: System clock is Fast/Slow clock divided by 16

01: System clock is Fast/Slow clock divided by 4

10: System clock is Fast/Slow clock divided by 2

11: System clock is Fast/Slow clock divided by 1

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6. Interrupt and Wake-up

This Chip has an 11-source four-level priority interrupt structure. All enabled Interrupts can wake up CPU from Idle mode, but only the Pin Interrupts can wake up CPU from Stop mode. Each interrupt source has its own enable control bit. An interrupt event will set its individual Interrupt Flag, no matter whether its interrupt enable control bit is 0 or 1. The Interrupt vectors and flags are list below.

Vector	Flag	Description
0003	IE0	INTO external pin Interrupt (can wake up Stop mode)
000B	TF0	Timer0 Interrupt
0013	IE1	INT1 external pin Interrupt (can wake up Stop mode)
001B	TF1	Timer1 Interrupt
0023	RI+TI	Serial Port (UART) Interrupt
002B	TF2+EXF2	Timer2 Interrupt
0033	_	Reserved for ICE mode use
003B	TF3	Timer3 Interrupt
0043	P1IF	Port1 external pin change Interrupt (can wake up Stop mode)
004B	IE2	INT2 external pin Interrupt (can wake up Stop mode)
0053	ADIF+TKIF	ADC/Touch Key Interrupt
005B	SPIF+WCOL+MODF	SPI Interrupt

Interrupt Vector & Flag

6.1 Interrupt Enable and Priority Control

The IE and INTE1 SFRs decide whether the pending interrupt is serviced by CPU. The IP, IPH, IP1 and IP1H SFRs decide the interrupt priority. An interrupt will be serviced as long as an interrupt of equal or higher priority is not already being serviced. If an interrupt of equal or higher level priority is being serviced, the new interrupt will wait until it is finished before being serviced. If a lower priority level interrupt is being serviced, it will be stopped and the new interrupt serviced. When the new interrupt is finished, the lower priority level interrupt that was stopped will be completed.

SFR 96h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
P1WKUP		P1WKUP							
R/W		R/W							
Reset	0	0	0	0	0	0	0	0	

96h.7~0 **P1WKUP:** P1.7~P1.0 pin individual Wake up/Interrupt enable control

0: Disable 1: Enable

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SFR A8h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
IE	EA	_	ET2	ES	ET1	EX1	ET0	EX0
R/W	R/W	_	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	_	0	0	0	0	0	0

A8h.7 **EA:** Global interrupt enable

0: Disable all interrupts

1: Each interrupt is enabled or disabled by its individual interrupt control bit

A8h.5 **ET2:** Timer2 interrupt enable

0: Disable Timer2 interrupt

1: Enable Timer2 interrupt

A8h.4 **ES:** Serial Port (UART) interrupt enable

0: Disable Serial Port (UART) interrupt

1: Enable Serial Port (UART) interrupt

A8h.3 **ET1:** Timer1 interrupt enable

0: Disable Timer1 interrupt

1: Enable Timer1 interrupt

A8h.2 **EX1:** INT1 pin Interrupt enable and Stop mode wake up enable

0: Disable INT1 pin Interrupt and Stop mode wake up

1: Enable INT1 pin Interrupt and Stop mode wake up, it can wake up CPU from Stop mode no matter EA is 0 or 1.

A8h.1 **ET0:** Timer0 interrupt enable

0: Disable Timer0 interrupt

1: Enable Timer0 interrupt

A8h.0 **EX0:** INTO pin Interrupt enable and Stop mode wake up enable

0: Disable INT0 pin Interrupt and Stop mode wake up

1: Enable INT0 pin Interrupt and Stop mode wake up, it can wake up CPU from Stop mode no matter EA is 0 or 1.

SFR A9h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
INTE1		IAPWE		SPIE	ADTKIE	EX2	P1IE	TM3IE
R/W		R/W		R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

A9h.4 **SPIE:** SPI interrupt enable

0: Disable SPI interrupt

1: Enable SPI interrupt

A9h.3 **ADTKIE:** ADC/Touch Key interrupt enable

0: Disable ADC/Touch Key interrupt

1: Enable ADC/Touch Key interrupt

A9h.2 **EX2:** INT2 pin Interrupt enable and Stop mode wake up enable

0: Disable INT2 pin Interrupt and Stop mode wake up

1: Enable INT2 pin Interrupt and Stop mode wake up, it can wake up CPU from Stop mode no matter EA is 0 or 1.

A9h.1 **P1IE:** Port1 pin change interrupt enable

0: Disable Port1 pin change interrupt

1: Enable Port1 pin change interrupt

A9h.0 **TM3IE:** Timer3 interrupt enable

0: Disable Timer3 interrupt

1: Enable Timer3 interrupt



SFR B9h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
IPH	_	_	PT2H	PSH	PT1H	PX1H	PT0H	PX0H
R/W	_	_	R/W	R/W	R/W	R/W	R/W	R/W
Reset	_	_	0	0	0	0	0	0

SFR B8h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
IP	_	_	PT2	PS	PT1	PX1	PT0	PX0
R/W	_	_	R/W	R/W	R/W	R/W	R/W	R/W
Reset	_		0	0	0	0	0	0

B9h.5, B8h.5 **PT2H**, **PT2:** Timer2 interrupt priority control. (PT2H, PT2) =

00: Level 0 (lowest priority)

01: Level 1 10: Level 2

11: Level 3 (highest priority)

B9h.4, B8h.4 **PSH**, **PS:** Serial Port (UART) interrupt priority control. Definition as above.

B9h.3, B8h.3 PT1H, PT1: Timer1 interrupt priority control. Definition as above.

B9h.2, B8h.2 **PX1H**, **PX1**: INT1 pin interrupt priority control. Definition as above.

B9h.1, B8h.1 **PT0H**, **PT0:** Timer0 interrupt priority control. Definition as above.

B9h.0, B8h.0 **PX0H**, **PX0:** INT0 pin interrupt priority control. Definition as above.

SFR BBh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
IP1H	_	_	_	PSPIH	PADTKIH	PX2H	PP1H	РТ3Н
R/W	_	_	_	R/W	R/W	R/W	R/W	R/W
Reset	_	_	_	0	0	0	0	0

SFR BAh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
IP1	_	_	_	PSPI	PADTKI	PX2	PP1	PT3
R/W	-	_		R/W	R/W	R/W	R/W	R/W
Reset		_		0	0	0	0	0

BBh.4, BAh.4 **PSPIH**, **PSPI**: SPI interrupt priority control. Definition as above.

BBh3, BAh3 PADTKIH, PADTKI: ADC/Touch Key interrupt priority control. Definition as above.

BBh.2, BAh.2 PX2H, PX2: INT2 pin interrupt priority control. Definition as above.

BBh.1, BAh.1 **PP1H**, **PP1:** Port1 pin change interrupt priority control. Definition as above.

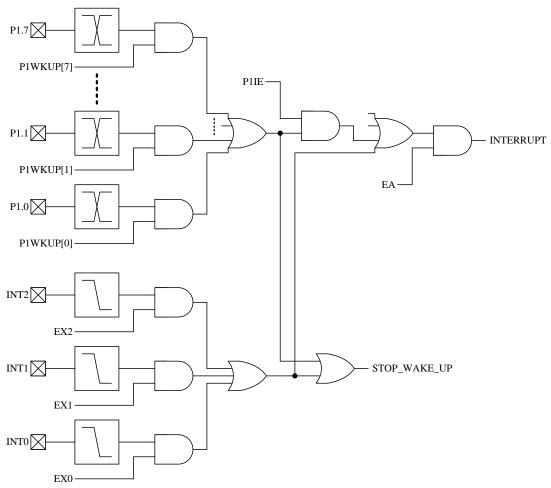
BBh.0, BAh.0 PT3, PT3: Timer3 interrupt priority control. Definition as above.

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6.2 Pin Interrupt

Pin Interrupts include INT0 (P3.2), INT1 (P3.3), INT2 (P3.7) and Port1 Change Interrupt. These pins also have the Stop mode wake up capability. INT0 and INT1 are falling edge or low level triggered as the 8051 standard. INT2 is falling edge triggered and Port1 Change Interrupt is triggered by any Port1 pin state change.



Pin Interrupt & Wake up

SFR 88h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
TCON	TF1	TR1	TF0	TR0	IE1	IT1	IE0	IT0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

88h.3 **IE1:** External Interrupt 1 (INT1 pin) edge flag

Set by H/W when an INT1 pin falling edge is detected, no matter the EX1 is 0 or 1.

It is cleared automatically when the program performs the interrupt service routine.

88h.2 **IT1:** External Interrupt 1 control bit

0: Low level active (level triggered) for INT1 pin

1: Falling edge active (edge triggered) for INT1 pin

88h.1 **IE0:** External Interrupt 0 (INT0 pin) edge flag

Set by H/W when an INT0 pin falling edge is detected, no matter the EX0 is 0 or 1.

It is cleared automatically when the program performs the interrupt service routine.

88h.0 **IT0:** External Interrupt 0 control bit

0: Low level active (level triggered) for INT0 pin

1: Falling edge active (edge triggered) for INT0 pin

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SFR 95h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
INTFLG	LVD	_	TKIF	ADIF	_	IE2	P1IF	TF3
R/W	R	_	R/W	R/W	_	R/W	R/W	R/W
Reset	_	_	0	0	_	0	0	0

95h.2 **IE2:** External Interrupt 2 (INT2 pin) edge flag

Set by H/W when a falling edge is detected on the INT2 pin state, no matter the EX2 is 0 or 1.

It is cleared automatically when the program performs the interrupt service routine.

S/W can write FBh to INTFLG to clear this bit. (Note2)

95h.1 **P1IF:** Port1 pin change interrupt flag

Set by H/W when a P1 pin state change is detected, and its interrupt enable bit is set (P1WKUP).

P1IE does not affect this flag's setting.

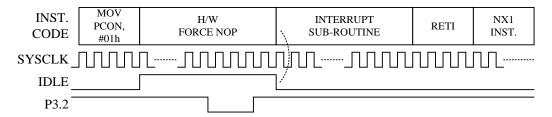
It is cleared automatically when the program performs the interrupt service routine.

S/W can write FDh to INTFLG to clear this bit. (Note2)

Note2: S/W can write 0 to clear a flag in the INTFLG, but writing 1 has no effect.

6.3 Idle Mode Wake up and Interrupt

Idle mode is waked up by enabled Interrupts, which means individual interrupt enable bit (ex: EX0) and EA bit must be both set to 1 to establish Idle mode wake up capability. All enabled Interrupts (Pins, Timers, ADC, TK, SPI and UART) can wake up CPU from Idle mode. Upon Idle wake-up, Interrupt service routine is entered immediately. "The first instruction behind IDL (PCON.0) setting" is executed after interrupt service routine return.



EA=EX0=1, Idle mode wake-up and Interrupt by P3.2 (INT0)

SFR 87h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PCON	SMOD	_	_	_	GF1	GF0	PD	IDL
R/W	R/W	_		_	R/W	R/W	R/W	R/W
Reset	0	_	_	_	0	0	0	0

87h.1 **PD:** Stop bit. If 1, Stop mode is entered. 87h.0 **IDL:** Idle bit. If 1, Idle mode is entered.

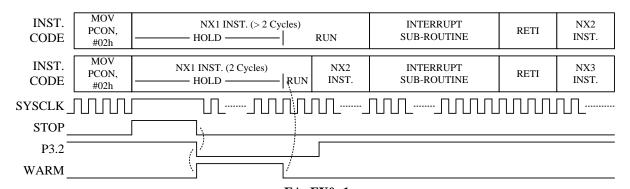
6.4 Stop Mode Wake up and Interrupt

Stop mode wake up is simple, as long as the individual pin interrupt enable bit (ex: EX0) is set, the pin wake up capability is asserted. Set EX0/EX1/EX2 can enable INT0/INT1/INT2 pins' Stop mode wake up capability. Set P1WKUP bit 7~0 can enable P1.7~P1.0's Stop mode wake up capability. Upon Stop wake up, "the first instruction behind PD (PCON.1) setting" is executed immediately before Interrupt service. Interrupt entry needs EA=1 (P1WKUP also needs P1IE=1) and the trigger state of the pin staying sufficiently long to be observed by the System clock. This feature allows CPU to enter or not enter Interrupt sub-routine after Stop mode wake up.

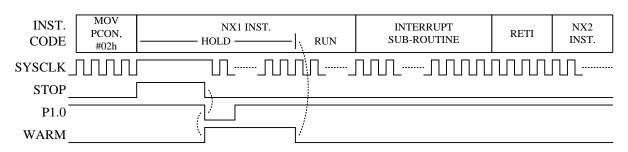
Note: Chip cannot enter Stop Mode if INTn pin is low and wakeup is enable. (INTn=0 and EXn=1, n=0,1,2)

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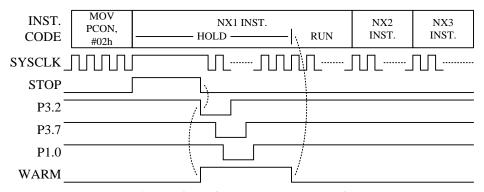




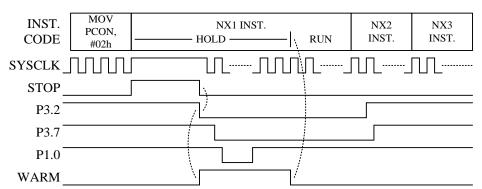
EA=EX0=1
P3.2 (INT0) is sampled after warm-up, Stop mode wake-up and Interrupt.



EA = P1IE = P1WKUP = 1 $P1.0 \ change \ (not \ need \ clock \ sample) \ , Stop \ mode \ wake-up \ and \ Interrupt.$



EA = EX0=EX2=P1WKUP=1, P1IE=0 Stop mode wake-up but not Interrupt, P3.2/P3.7 pulse too narrow.



EX0=EX2=P1WKUP=1=P1IE=1, EA=0 Stop mode wake-up but not Interrupt.

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7. I/O Ports

The Chip has total 30 multi-function I/O pins. All I/O pins follow the standard 8051 "Read-Modify -Write" feature. The instructions that read the SFR rather than the Pin State are the ones that read a port or port bit value, possibly change it, and then rewrite it to the SFR. (ex: ANL P1, A; INC P2; CPL P3.0)

7.1 Port1 & P2.1~P2.0 & P3.6~P3.0

These pins can operate in four different modes as below.

Mode	Port1, P2.1~P2.0, P3 P3.2~P3.0	.6~P3.0 pin function Others	Px.n SFR data	Pin State	Resistor Pull-up	Digital Input
Mode 0	Pseudo	Open Drain	0	Drive Low	N	N
	Open Drain	Open Brum	1	Pull-up	Y	Y
Mode 1	Pseudo	Pseudo On an Duain		Drive Low	N	N
	Open Drain	Open Drain	1	Hi-Z	N	Y
Mode 2	CMOS	Output	0	Drive Low	N	N
	CMOS	Output	1	Drive High	N	N
Mode 3	Alternative Function	, such as LCD/LED,	X		N	N
	ADC and T	Touch Key	(don't care)	_	11	1/

Port1, P2.1~P2.0, P3.6~P3.0 I/O Pin Function Table

If a Port1, P2.1~P2.0 or P3.6~P3.0 pin is used for Schmitt-trigger input, S/W must set the I/O pin to Mode0 or Mode1 and set the corresponding Port Data SFR to 1 to disable the pin's output driving circuitry.

Beside I/O port function, each Port1, P2.1~P2.0 and P3.6~P3.0 pin has one or more alternative functions, such as LCD/LED, ADC and Touch Key. Most of the functions are activated by setting the individual pin mode control SFR to Mode3. Port1/Port3 pins have standard 8051 auxiliary definition such as INT0/1, T0/1/2, or RXD/TXD. These pin functions need to set the pin mode SFR to Mode0 or Mode1 and keep the P1.n/P3.n SFR at 1.

Pin Name	8051	Wake-up	CKO	ADC/TK	LCD/LED	others	Mode3
P1.0	T2	Y	T2O	AD4/TK0	SEG14		AD4/TK0
P1.1	T2EX	Y		AD5/TK1	SEG13		AD5/TK1
P1.2		Y		AD6/TK2	SEG12	PWM0A	AD6/TK2
P1.3		Y		AD7/TK3	SEG11	PWM1A	AD7/TK3
P1.4		Y	CKO	AD8/TK8	SEG10		AD8/TK8
P1.5		Y		AD9/CLD	SEG9		AD9/CLD
P1.6		Y		TK9	SEG8		TK9
P1.7		Y		TK10	SEG7	MISO	TK10
P3.0	RXD			AD3/TK7	SEG15		AD3/TK7
P3.1	TXD			AD2/TK6	SEG16		AD2/TK6
P3.2	INT0	Y		AD1/TK5	SEG17		AD1/TK5
P3.3	INT1	Y		AD0/TK4			AD0/TK4
P3.4	Т0		T0O	TK13	SEG4	SS	TK13
P3.5	T1			TK12	SEG5	MOSI	TK12
P3.6		_		TK11	SEG6	SCK	TK11
P2.0						XI	
P2.1						XO	

Port1, P2.1~P2.0, P3.6~P3.0 multi-function Table

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The necessary SFR setting for Port1/P2.1~P2.0/P3.6~P3.0 pin's alternative function is list below.

Alternative Function	Mode	Px.n SFR data	Pin State	Other necessary SFR setting	
T0, T1, T2, T2EX,	0	1	Input with Pull-up		
INT0, INT1	1	1	Input		
DVD TVD	0	1	Input with Pull-up/Pseudo Open Drain Output		
RXD, TXD	1	1	Input/Pseudo Open Drain Output		
	0	X	Clock Open Drain Output with Pull-up	PINMOD	
T0O, T2O, CKO	1	X	Clock Open Drain Output PINMO		
	2	X	Clock Output (CMOS Push-Pull)	ramodn	
SEG4~17 (<i>Note</i>)	X	X	LCD/LED Waveform Output	LCDPIN	
TK0~TK13	0	1	Touch Key Idling, Pull-up		
1K0~1K15	3	X	Touch Key Scanning		
CLD	3	X	X Touch Key Capacitor Connection		
AD0~AD9	3	X	X ADC Channel		
	0	X	PWM Open Drain Output with Pull-up		
PWM0A, PWM1A	1	X	PWM Open Drain Output	PINMOD	
	2	X	PWM Output (CMOS Push-Pull)		
SPI Master Mode MISO	1	1	1 SPI Data Input		
SPI Master Mode SCK, MOSI	2 X SPI Clock/Data Output (CMOS Push-Pull)		SPCON		
SPI Slave Mode MISO	2	X	X SPI Data Output (CMOS Push-Pull)		
SPI Slave Mode SCK, MOSI	1	1	SPI Clock/Data Input	SPCON	
SS	1	1	SPI Chip Selection	SPCON	
XI, XO	XI, XO 0 1 Crystal oscillation		CLKCON		

Mode Setting for Port1, P2.1~P2.0, P3.6~P3.0 Alternative Function

For tables above, a "COMS Output" pin means it can sink and drive at least 4mA current. It is not recommended to use such pin as input function.

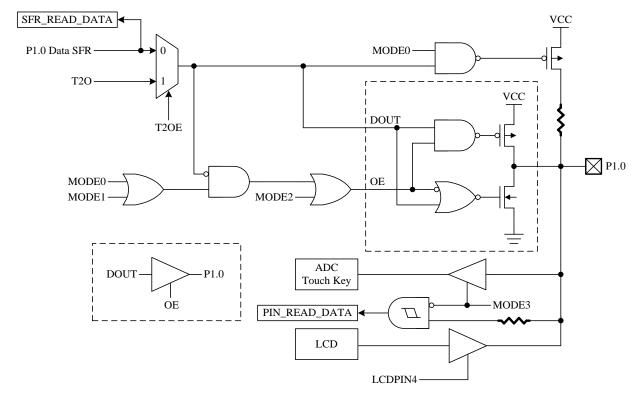
An "Open Drain" pin means it can sink at least 4mA current but only drive a small current ($<20\mu$ A). It can be used as input or output function and typically needs an external pull up resistor.

An 8051 standard pin is a "Pseudo Open Drain" pin. It can sink at least 4mA current when output is at low level, and drives at least 4mA current for $1\sim2$ clock cycle when output transits from low to high, then keeps driving a small current ($<20\mu A$) to maintain the pin at high level. It can be used as input or output function.

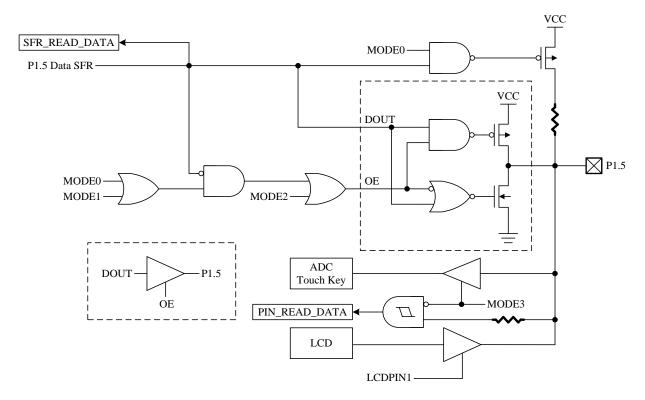
Note: For the necessary SFR setting above, LCDPIN has the highest priority. Therefore, if a pin is not used for Segment (ex: pin is I/O, ADC, TK, SPI...), S/W must disable the pin's LCD/LED Segment function.

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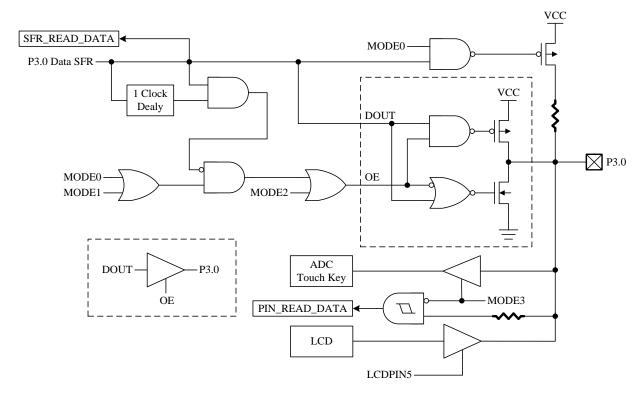
P1.0 Pin Structure



P1.5 Pin Structure

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P3.0 Pin Structure

SFR 90h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
P1	P1.7	P1.6	P1.5	P1.4	P1.3	P1.2	P1.1	P1.0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	1	1	1	1	1	1	1	1

90h.7~0 **P1:** Port1 data

SFR B0h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Р3	P3.7	P3.6	P3.5	P3.4	P3.3	P3.2	P3.1	P3.0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	1	1	1	1	1	1	1	1

B0h.6~0 **P3.6~P3.0:** P3.6~P3.0 data

SFR A0h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
P2	P2.7	P2.6	P2.5	P2.4	P2.3	P2.2	P2.1	P2.0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	1	1	1	1	1	1	1	1

A0h.1~0 **P2.1~P2.0:** P2.1~P2.0 data

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SFR A2h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
P1MODL	P1M	OD3	P1MOD2		P1MOD1		P1MOD0	
R/W	R/	W	R/W R/W		R/	W		
Reset	0	0	0	0	0	0	0	0

A2h.7~6 **P1MOD3:** P1.3 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3, P1.3 is ADC or Touch Key input

A2h.5~4 **P1MOD2:** P1.2 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3, P1.2 is ADC or Touch Key input

A2h.3~2 **P1MOD1:** P1.1 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3, P1.1 is ADC or Touch Key input

A2h.1~0 **P1MOD0:** P1.0 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3, P1.0 is ADC or Touch Key input

SFR A3h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
P1MODH	P1M	OD7	P1MOD6		P1M	OD5	P1MOD4	
R/W	R/	W	R/	W	R/W		R/	W
Reset	0	0	0	0	0	0	0	0

A3h.7~6 **P1MOD7:** P1.7 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3, P1.7 is Touch Key input

A3h.5~4 **P1MOD6:** P1.6 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3, P1.6 is Touch Key input

A3h.3~2 **P1MOD5:** P1.5 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3, P1.5 is ADC input or Touch Key CLD functional pin

A3h.1~0 **P1MOD4:** P1.4 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3, P1.4 is ADC or Touch Key input

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SFR A4h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
P3MODL	P3M	OD3	P3MOD2		P3M	OD1	P3MOD0	
R/W	R/	W	R/W		R/	W	R/	W
Reset	0	1	0	1	0	1	0	1

A4h.7~6 **P3MOD3:** P3.3 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3, P3.3 is ADC or Touch Key input

A4h.5~4 **P3MOD2:** P3.2 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3, P3.2 is ADC or Touch Key input

A4h.3~2 **P3MOD1:** P3.1 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3, P3.1 is ADC or Touch Key input

A4h.1~0 **P3MOD0:** P3.0 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3, P3.0 is ADC or Touch Key input

SFR A5h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
P3MODH	T00E	_	P3MOD6		P3M	OD5	P3MOD4	
R/W	R/W	_	R/W		R/	W	R/	W
Reset	0	_	0	0	0	0	0	0

A5h.7 **T0OE:** Timer0 signal output (T0O) control

0: Disable Timer0 overflow divided by 64 output to P3.4

1: Enable Timer0 overflow divided by 64 output to P3.4

A5h.5~4 **P3MOD6:** P3.6 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3, P3.6 is Touch Key input

A5h.3~2 **P3MOD5:** P3.5 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3, P3.5 is Touch Key input

A5h.1~0 **P3MOD4:** P3.4 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3, P3.4 is Touch Key input

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SFR 93h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
P2MOD		P2	OE		P2M	OD1	P2M	OD0
R/W	R/W				R/	W	R/	W
Reset	0	0	0	0	0	1	0	1

93h.3~2 **P2MOD1:** P2.1 pin control

00: Mode0 01: Mode1 10: Mode2 11: not defined

93h.1~0 **P2MOD0:** P2.0 pin control

00: Mode0 01: Mode1 10: Mode2 11: not defined

SFR A6h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PINMOD	PWM1AOE	PWM1BOE	PWM0AOE	PWM0BOE	TCOE	T2OE	_	_
R/W	R/W	R/W	R/W	R/W	R/W	R/W		_
Reset	0	0	0	0	0	0	_	_

A6h.7 **PWM1A0E:** PWM1A signal output enable

0: Disable PWM1A signal output to P1.31: Enable PWM1A signal output to P1.3

A6h.5 **PWM0AOE:** PWM0A signal output enable

0: Disable PWM0A signal output to P1.2

1: Enable PWM0A signal output to P1.2

A6h.3 **TCOE:** System clock signal output (CKO) control

0: Disable System clock divided by 2 output to P1.4

1: Enable System clock divided by 2 output to P1.4

A6h.2 **T2OE:** Timer2 signal output (T2O) control

0: Disable Timer2 overflow divided by 2 output to P1.01: Enable Timer2 overflow divided by 2 output to P1.0

SFR B3h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
LCDPIN	LCDPIN7	LCDPIN6	LCDPIN5	LCDPIN4	LCDPIN3	LCDPIN2	LCDPIN1	LCDPIN0
R/W								
Reset	0	0	0	0	0	0	0	0

B3h.7 LCDPIN7: P3.2 (SEG17) LCD/LED mode enable
B3h.6 LCDPIN6: P3.1 (SEG16) LCD/LED mode enable
B3h.5 LCDPIN5: P3.0 (SEG15) LCD/LED mode enable
B3h.4 LCDPIN4: P1.0 (SEG14) LCD/LED mode enable
B3h.3 LCDPIN3: P1.1 (SEG13) LCD/LED mode enable
B3h.2 LCDPIN2: P1.2 (SEG12) LCD/LED mode enable
B3h.1 LCDPIN1: P1.3~P1.6 (SEG11~8) LCD/LED mode enable.

Note: SEG9 and Touch Key CLD share the same pin. If this bit is set, the Touch Key function would

be affected.

B3h.0 **LCDPIN0:** P17, P3.6~P3.4 (SEG7~4) LCD/LED mode enable

0: I/O mode

1: LCD/LED mode

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SFR D8h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
CLKCON	SCKTYPE	FCKTYPE	_	STPPCK	STPFCK	SELFCK	CLK	PSC
R/W	R/W	R/W	_	R/W	R/W	R/W	R/	W
Reset	0	0		0	0	0	1	1

D8h.7 **SCKTYPE:** Slow clock type. This bit can be changed only in Fast mode (SELFCK=1).

0: SRC, P2.1~P2.0 are I/O pins 1: SXT, P2.1~P2.0 are crystal pins

D8h.6 **FCKTYPE:** Fast clock type. This bit can be changed only in Slow mode (SELFCK=0).

0: FRC, P2.1~P2.0 are I/O pins 1: FXT, P2.1~P2.0 are crystal pins

SFR BCh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
SPCON	SPEN	MSTR	CPOL	CPHA	SSDIS	LSBF	SP	CR
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
Reset	0	0	0	0	0	0	0	0

BCh.7 **SPEN:** SPI enable

0: SPI disable

1: SPI enable, P1.7, P3.5, P3.6 are SPI functional pins.

BCh.3 **SSDIS:** SS pin disable

0: Enable SS pin, P3.4 is SPI chip selection input.

1: Disable SS pin

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7.2 P3.7

P3.7 can be only used as Schmitt-trigger input or open-drain output, with pull-up resistor always enable. P3.7 pin is shared with RSTn, INT2 and Flash VPP function.

7.3 Port0 & P2.5~P2.2

These pins are shared with LCD/LED. If a Port0/P2.5~P2.2 pin is defined as I/O pin, it can be used as CMOS push-pull output or Schmitt-trigger input. The pin's pull up function is enable while SFR bit PxOE.n=0 and Px.n=1.

Port0, P2.5~P2.2 pin function	PxOE.n	Px.n SFR data	Pin State	Resistor Pull-up	Digital Input
Innut	0	0	Hi-Z	N	Y
Input	0	1	Pull-up	Y	Y
CMOS Output	1	0	Drive Low	N	N
CMOS Output	1	1	Drive High	N	N

Port0, P2.5~P2.2 I/O Pin Function Table

Pin Name	Wake-up	LCD/LED	Others
P0.0		COM3	
P0.1		COM2	
P0.2		COM1	
P0.3		COM0	
P0.4		SEG0	
P0.5		SEG1	
P0.6		SEG2	
P0.7		SEG3	
P2.2			PWM0B
P2.3			PWM1B
P2.4			
P2.5			
P3.7	Y		INT2, RSTn, VPP

Port0, P2.5~P2.2, P3.7 multi-function Table

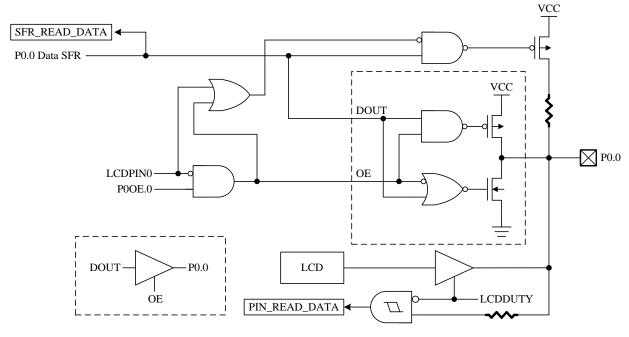
The necessary SFR setting for Port0/Port2.5~P2.2 pin's alternative function is list below.

Alternative Function	PxOE.n	Px.n SFR data	Pin State	other necessary SFR setting
COM0~COM3	X	X	LCD/LED Waveform Output	LCDCON
SEG0~SEG3	X	X	LCD/LED Waveform Output	LCDCON
PWM0B, PWM1B	1	X	PWM Output (CMOS Push-Pull)	PINMOD

Mode Setting for Port0, P2.5~P2.2 Alternative Function Table

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P0.0 Pin Structure

SFR 80h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
P0	P0.7	P0.6	P0.5	P0.4	P0.3	P0.2	P0.1	P0.0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	1	1	1	1	1	1	1	1

80h.7~0 **P0:** Port0 data, also controls the P0.n pin's pull-up function. If the P0.n SFR data is "1" and the corresponding P0OE.n=0 (input mode), the pull-up is enabled.

SFR A0h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
P2	P2.7	P2.6	P2.5	P2.4	P2.3	P2.2	P2.1	P2.0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	1	1	1	1	1	1	1	1

A0h.5~2 **P2.5~P2.2:** P2.5~P2.2 data, also controls the P2.n pin's pull-up function. If the P2.n SFR data is "1" and the corresponding P2OE.n=0 (input mode), the pull-up is enabled.

SFR B0h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Р3	P3.7	P3.6	P3.5	P3.4	P3.3	P3.2	P3.1	P3.0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	1	1	1	1	1	1	1	1

B0h.7 **P3.7:** P3.7 data, also controls the P3.7 pin's I/O mode. If the P3.7 SFR data is "1", the P3.7 is assigned as Schmitt-trigger input mode; otherwise, it is assigned as open-drain output mode.

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SFR 91h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
POOE		POOE							
R/W		R/W							
Reset	0	0	0	0	0	0	0	0	

91h.7~0 **POOE:** Port0 CMOS Push-Pull output enable control

0: Disable 1: Enable

SFR 93h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
P2MOD		P2	OE		P2MOD1 P2MOD0			OD0
R/W	R/W				R/	W	R/	W
Reset	0	0	0	0	0	1	0	1

93h.7~4 **P2OE:** P2.5~P2.2 CMOS Push-Pull output enable control

0: Disable 1: Enable

SFR A6h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PINMOD	PWM1A0E	PWM1BOE	PWM0AOE	PWM0BOE	TCOE	T2OE	_	_
R/W	R/W	R/W	R/W	R/W	R/W	R/W	_	_
Reset	0	0	0	0	0	0	_	_

A6h.6 **PWM1BOE:** PWM1B signal output enable

0: Disable PWM1B signal output to P2.31: Enable PWM1B signal output to P2.3

A6h.4 **PWM0BOE:** PWM0B signal output enable 0: Disable PWM0B signal output to P2.2

1: Enable PWM0B signal output to P2.2

SFR B1h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
LCDCON	LCDON	LCDDUTY	_	_	_	LCDBRIT		
R/W	R/W	R/W	_	_	_	R/W		
Reset	0	1	_	_	_	1	0	0

B1h.7 **LCDON:** LCD/LED enable bit

0: LCD/LED disable

1: LCD/LED enable, P0.7~P0.4 are LCD/LED Segment pins

B1h.6 **LCDDUTY:** LCD/LED duty select

0: 1/3 duty, P0.3~P0.1 are LCD/LED Common pins, P0.0 is I/O pin

1: 1/4 duty, P0.3~P0.0 are LCD/LED Common pins

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8. Timers

Timer0, Timer1 and Timer2 are provided as standard 8051 compatible timer/counter. Compare to the traditional 12T 8051, the Chip's Timer0/1/2 use 2 System clock cycle as the time base unit. That is, in timer mode, these timers increase at every "2 System clock" rate; in counter mode, T0/T1/T2 pin input pulse must be wider than 2 System clock to be seen by this device. In addition to the standard 8051 timers function. The T0O pin can output the "Timer0 overflow divided by 64" signal, and the T2O pin can output the "Timer2 overflow divided by 2" signal. Timer3 is provided for a real-time clock count, when its time base is SXT.

8.1 Timer0/1

TCON and TMOD are used to set the mode of operation and to control the running and interrupt generation of the Timer0/1, with the timer/counter values stored in two pairs of 8-bit registers (TL0, TH0, and TL1, TH1).

SFR 88h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
TCON	TF1	TR1	TF0	TR0	IE1	IT1	IE0	IT0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

88h.7 **TF1:** Timer1 overflow flag

Set by H/W when Timer/Counter 1 overflows.

Cleared by H/W when CPU vectors into the interrupt service routine.

88h.6 **TR1:** Timer1 run control

0: Timer1 stops

1: Timer1 runs

88h.5 **TF0:** Timer0 overflow flag

Set by H/W when Timer/Counter 0 overflows.

Cleared by H/W when CPU vectors into the interrupt service routine.

88h.4 **TR0:** Timer0 run control

0: Timer0 stops1: Timer0 runs

SFR 89h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
TMOD	GATE1	CT1N	TMOD1		GATE0	CT0N	TMO	OD0
R/W	R/W	R/W	R/	R/W		R/W	R/	W
Reset	0	0	0	0	0	0	0	0

89h.7 **GATE1:** Timer1 gating control bit

0: Timer1 enable when TR1 bit is set

1: Timer1 enable only while the INT1 pin is high and TR1 bit is set

89h.6 **CT1N:** Timer1 Counter/Timer select bit

0: Timer mode, Timer1 data increases at 2 System clock cycle rate

1: Counter mode, Timer1 data increases at T1 pin's negative edge

89h.5~4 **TMOD1:** Timer1 mode select

00: 8-bit timer/counter (TH1) and 5-bit prescaler (TL1)

01: 16-bit timer/counter

10: 8-bit auto-reload timer/counter (TL1). Reloaded from TH1 at overflow.

11: Timer1 stops

89h.3 **GATE0:** Timer0 gating control bit

0: Timer0 enable when TR0 bit is set

1: Timer0 enable only while the INT0 pin is high and TR0 bit is set

89h.2 **CT0N:** Timer0 Counter/Timer select bit

0: Timer mode, Timer0 data increases at 2 System clock cycle rate

1: Counter mode, Timer0 data increases at T0 pin's negative edge



89h.1~0 **TMOD0:** Timer0 mode select

00: 8-bit timer/counter (TH0) and 5-bit prescaler (TL0)

01: 16-bit timer/counter

10: 8-bit auto-reload timer/counter (TL0). Reloaded from TH0 at overflow.

11: TL0 is an 8-bit timer/counter. TH0 is an 8-bit timer/counter using Timer1's TR1 and TF1 bits.

SFR 8Ah	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
TL0		TL0							
R/W		R/W							
Reset	0	0	0	0	0	0	0	0	

8Ah.7~0 **TL0:** Timer0 data low byte

SFR 8Bh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
TL1		TL1							
R/W		R/W							
Reset	0	0	0	0	0	0	0	0	

8Bh.7~0 **TL1:** Timer1 data low byte

SFR 8Ch	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
TH0		TH0							
R/W		R/W							
Reset	0	0	0	0	0	0	0	0	

8Ch.7~0 **TH0:** Timer0 data high byte

SFR 8Dh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
TH1		TH1							
R/W		R/W							
Reset	0	0	0	0	0	0	0	0	

8Dh.7~0 **TH1:** Timer1 data high byte

Note: also refer to Section 6 for more information about Timer0/1 Interrupt enable and priority.

Note: also refer to Section 7 for more information about T0O pin output setting.

8.2 Timer2

Timer2 is controlled through the TCON2 register with the low and high bytes of Timer/Counter 2 stored in TL2 and TH2 and the low and high bytes of the Timer2 reload/capture registers stored in RCAP2L and RCAP2H.

SFR C8h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
T2CON	TF2	EXF2	RCLK	TCLK	EXEN2	TR2	CT2N	CPRL2N
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

C8h.7 **TF2:** Timer2 overflow flag

Set by H/W when Timer/Counter 2 overflows unless RCLK=1 or TCLK=1. This bit must be cleared by S/W.

C8h.6 **EXF2:** T2EX interrupt pin falling edge flag

Set when a capture or a reload is caused by a negative transition on T2EX pin if EXEN2=1. This bit must be cleared by S/W.

C8h.5 **RCLK:** UART receive clock control bit

0: Use Timer1 overflow as receive clock for serial port in mode 1 or 3

1: Use Timer2 overflow as receive clock for serial port in mode 1 or 3

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C8h.4 TCLK: UART transmit clock control bit

0: Use Timer1 overflow as transmit clock for serial port in mode 1 or 3

1: Use Timer2 overflow as transmit clock for serial port in mode 1 or 3

C8h.3 **EXEN2:** T2EX pin enable

0: T2EX pin disable

1: T2EX pin enable, it cause a capture or reload when a negative transition on T2EX pin is detected if RCLK=TCLK=0

C8h.2 **TR2:** Timer2 run control

0: Timer2 stops

1: Timer2 runs

C8h.1 CT2N: Timer2 Counter/Timer select bit

0: Timer mode, Timer2 data increases at 2 System clock cycle rate

1: Counter mode, Timer2 data increases at T2 pin's negative edge

C8h.0 CPRL2N: Timer2 Capture/Reload control bit

0: Reload mode, auto-reload on Timer2 overflows or negative transitions on T2EX pin if EXEN2=1

1: Capture mode, capture on negative transitions on T2EX pin if EXEN2=1

If RCLK=1 or TCLK=1, CPRL2N is ignored and timer is forced to auto-reload on Timer2 overflow

SFR CAh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
RCP2L		RCP2L							
R/W		R/W							
Reset	0	0	0	0	0	0	0	0	

CAh.7~0 **RCP2L:** Timer2 reload/capture data low byte

SFR CBh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
RCP2H		RCP2H								
R/W		R/W								
Reset	0	0	0	0	0	0	0	0		

CBh.7~0 **RCP2H:** Timer2 reload/capture data high byte

SFR CCh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
TL2		TL2							
R/W		R/W							
Reset	0	0	0	0	0	0	0	0	

CCh.7~0 TL2: Timer2 data low byte

SFR CDh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
TH2		TH2							
R/W		R/W							
Reset	0	0	0	0	0	0	0	0	

CDh.7~0 TH2: Timer2 data high byte

Note: also refer to Section 6 for more information about Timer2 Interrupt enable and priority.

Note: also refer to Section 7 for more information about T2O pin output setting.

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8.3 Timer3

Timer3 of the Chip works as a time-base counter, which generates interrupts periodically. It generates an interrupt flag (TF3) with the clock divided by 32768, 16384, 8192, or 128 depending on the TM3PSC bits. The Timer3 clock source is Slow clock (SRC or SXT). This is ideal for real-time-clock (RTC) functionality when the clock source is SXT.

SFR 94h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
OPTION	UART1W	MODE3V	WD7	WDTPSC		ADCKS		PSC
R/W	R/W	R/W	R/	R/W		W	R/	W
Reset	0	0	0	0	0	0	0	0

94h.1~0 **TM3PSC:** Timer3 interrupt rate control select

00: Interrupt rate is 32768 Slow clock cycle

01: Interrupt rate is 16384 Slow clock cycle

10: Interrupt rate is 8192 Slow clock cycle

11: Interrupt rate is 128 Slow clock cycle

SFR 95h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
INTFLG	LVD	_	TKIF	ADIF	_	IE2	P1IF	TF3
R/W	R	_	R/W	R/W	_	R/W	R/W	R/W
Reset	_	_	0	0	_	0	0	0

95h.0 **TF3:** Timer 3 interrupt flag

Set by H/W when Timer3 reaches TM3PSC setting cycles. It is cleared automatically when the program performs the interrupt service routine. S/W can write FEh to INTFLG to clear this bit. (*Note2*)

Note2: S/W can write 0 to clear a flag in the INTFLG, but writing 1 has no effect.

SFR F8h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
AUX1	CLRWDT	CLRTM3	TKSOC	ADSOC	CLRPWM0	_	_	DPSEL
R/W	R/W	R/W	R/W	R/W	R/W	_	_	R/W
Reset	0	0	0	0	0	_	_	0

F8h.6 **CLRTM3:** Set to clear Timer3, H/W auto clear it at next clock cycle

Note: also refer to Section 6 for more information about Timer3 Interrupt enable and priority.

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8.4 TOO and T2O Output Control

This device can generate various frequency waveform pin output (in CMOS or Open-Drain format) for Buzzer. The T0O and T2O waveform is divided by Timer0/Timer2 overflow signal. The T0O waveform is Timer0 overflow divided by 64, and T2O waveform is Timer2 overflow divided by 2. User can control their frequency by Timers auto reload speed. Set T0OE and T2OE SFRs can output these waveforms.

SFR A6h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PINMOD	PWM1AOE	PWM1BOE	PWM0AOE	PWM0B0E	TCOE	T2OE	_	_
R/W	R/W	R/W	R/W	R/W	R/W	R/W	_	_
Reset	0	0	0	0	0	0	_	_

A6h.2 **T2OE:** Timer2 signal output (T2O) control

0: Disable Timer2 overflow divided by 2 output to P1.01: Enable Timer2 overflow divided by 2 output to P1.0

SFR A5h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
P3MODH	T0OE	_	P3MOD6		P3MOD5		P3MOD4	
R/W	R/W	_	R/	R/W		W	R/	W
Reset	0	_	0	0	0	0	0	0

A5h.7 **T0OE:** Timer0 signal output (T0O) control

0: Disable Timer0 overflow divided by 64 output to P3.41: Enable Timer0 overflow divided by 64 output to P3.4

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9. UART

The UART uses SCON and SBUF SFRs. SCON is the control register, SBUF is the data register. Data is written to SBUF for transmission and SBUF is read to obtain received data. The received data and transmitted data registers are completely independent. In addition to standard 8051's full duplex mode, this Chip also provides one wire mode. If the UART1W bit is set, both transmit and receive data use P3.1 pin.

SFR 87h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PCON	SMOD	_	_	_	GF1	GF0	PD	IDL
R/W	R/W	_	_	_	R/W	R/W	R/W	R/W
Reset	0	_	_	_	0	0	0	0

87h.7 **SMOD:** UART double baud rate control bit

0: Disable UART double baud rate

1: Enable UART double baud rate

SFR 94h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
OPTION	UART1W	MODE3V	WDTPSC		ADCKS		TM3PSC	
R/W	R/W	R/W	R/W		R/W		R/	W
Reset	0	0	0	0	0	0	0	0

94h.7 **UART1W:** One wire UART mode enable, both TXD/RXD use P3.1 pin

0: Disable one wire UART mode

1: Enable one wire UART mode

SFR 98h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
SCON	SM0	SM1	SM2	REN	TB8	RB8	TI	RI
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

98h.7~6 **SM0,SM1:** Serial port mode select bit 0,1

00: Mode0: 8 bit shift register, Baud Rate=F_{SYSCLK}/2

01: Mode1: 8 bit UART, Baud Rate is variable

10: Mode2: 9 bit UART, Baud Rate=F_{SYSCLK}/32 or /64

11: Mode3: 9 bit UART, Baud Rate is variable

98h.5 **SM2:** Serial port mode select bit 2

SM2 enables multiprocessor communication over a single serial line and modifies the above as follows. In Modes 2 & 3, if SM2 is set then the received interrupt will not be generated if the received ninth data bit is 0. In Mode 1, the received interrupt will not be generated unless a valid stop bit is received. In Mode 0, SM2 should be 0.

98h.4 **REN:** UART reception enable

0: Disable reception

1: Enable reception

98h.3 **TB8:** Transmit Bit 8, the ninth bit to be transmitted in Mode 2 and 3

98h.2 **RB8:** Receive Bit 8, contains the ninth bit that was received in Mode 2 and 3 or the stop bit in Mode 1 if SM2=0

98h.1 **TI:** Transmit interrupt flag

Set by H/W at the end of the eighth bit in Mode 0, or at the beginning of the stop bit in other modes. Must be cleared by S/W.

98h.0 **RI:** Receive interrupt flag

Set by H/W at the end of the eighth bit in Mode 0, or at the sampling point of the stop bit in other modes. Must be cleared by S/W.

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SFR 99h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
SBUF		SBUF								
R/W		R/W								
Reset	_	_	_	_	_	_	_	_		

99h.7~0 **SBUF:** UART transmit and receive data. Transmit data is written to this location and receive data is read from this location, but the paths are independent.

F_{SYSCLK} denotes System clock frequency.

• Mode 0: Baud Rate=F_{SYSCLK}/2

• Mode 1, 3: if using Timer1 auto reload mode Baud Rate= (SMOD+1) xF_{SYSCLK}/ (32x2x (256–TH1))

• Mode 1, 3: if using Timer2
Baud Rate=Timer2 overflow rate/16=F_{SYSCLK}/ (32x (65536–RCP2H, RCP2L))

• Mode 2: Baud Rate= (SMOD+1) xF_{SYSCLK}/64

Note: also refer to Section 6 for more information about UART Interrupt enable and priority. *Note:* also refer to Section 8 for more information about how Timer2 controls UART clock.

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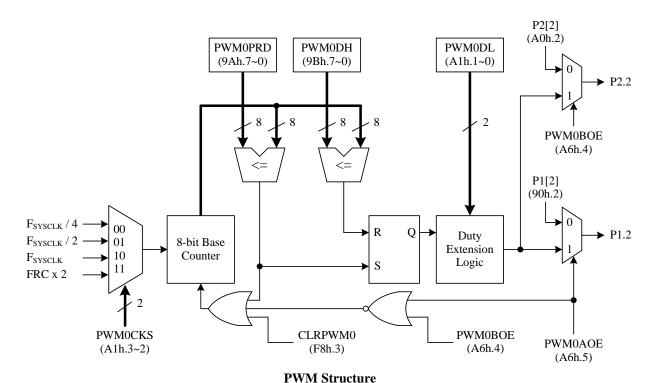


10. PWMs

The Chip has two independent PWM modules, PWM0 and PWM1. Each PWM module's waveform signal can output to two different pins. For example, user can select PWM0 output to P1.2 pin (PWM0A) or P2.2 pin (PWM0B) by PINMOD SFR setting. The PWM can generate a fixed frequency waveform with 1024 duty resolution on the basis of the PWM clock. The PWM clock can select FRC double frequency (FRCx2) or F_{SYSCLK} divided by 1, 2, or 4 as its clock source. A spread LSB technique allows PWM to run its frequency at the "PWM clock divided by 256" instead of at the "PWM clock divided by 1024", which means the PWM is four times faster than normal. The advantage of a higher PWM frequency is that the post RC filter can transform the PWM signal to a more stable DC voltage level.

The PWM output signal resets to a low level whenever the 8-bit base counter matches the 8-bit MSB of the PWM duty register. When the base counter rolls over, the 2-bit LSB of the PWM duty register decides whether to set the PWM output signal high immediately or set it high after one clock cycle delay. The PWM period can be set by writing the period value to the 8-bit PWM period register.

The pin mode SFR controls the PWM output waveform format. Mode1 makes the PWM open drain output and Mode2 makes the PWM CMOS push-pull output. (see section 7)



SFR 9Ah	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
PWM0PRD		PWM0PRD								
R/W		R/W								
Reset	1	1	1	1	1	1	1	1		

9Ah.7~0 **PWM0PRD:** PWM0 8-bit period register

SFR 9Bh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0			
PWM0DH		PWM0DH									
R/W		R/W									
Reset	1	0	0	0	0	0	0	0			

9Bh.7~0 **PWM0DH:** bits 9~2 of the PWM0 10-bit duty register

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SFR 9Ch	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
PWM1PRD		PWM1PRD								
R/W		R/W								
Reset	1	1	1	1	1	1	1	1		

9Ch.7~0 **PWM1PRD:** PWM1 8-bit period register

SFR 9Dh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
PWM1DH		PWM1DH								
R/W		R/W								
Reset	1	0	0	0	0	0	0	0		

9Dh.7~0 **PWM1DH:** bits 9~2 of the PWM1 10-bit duty register

SFR A1h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PWMCON	PWM	1CKS	PWM1DL		PWM	0CKS	PWM0DL	
R/W	R/	W	R/	W	R/	W	R/	W
Reset	1	0	0	0	1	0	0	0

A1h.7~6 **PWM1CKS:** PWM1 clock source

00: F_{SYSCLK}/4 01: F_{SYSCLK}/2 10: F_{SYSCLK} 11: FRCx2

A1h.5~4 **PWM1DL:** bits 1~0 of the PWM1 10-bit duty register

A1h.3~2 **PWM0CKS:** PWM0 clock source

00: $F_{SYSCLK}/4$ 01: $F_{SYSCLK}/2$ 10: F_{SYSCLK} 11: FRCx2

A1h.1~0 **PWM0DL:** bits 1~0 of the PWM0 10-bit duty register

SFR A6h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PINMOD	PWM1AOE	PWM1BOE	PWM0AOE	PWM0BOE	TCOE	T2OE	_	_
R/W	R/W	R/W	R/W	R/W	R/W	R/W	_	_
Reset	0	0	0	0	0	0	_	_

A6h.7 **PWM1AOE:** PWM1A signal output enable

0: Disable PWM1A signal output to P1.31: Enable PWM1A signal output to P1.3

A6h.6 **PWM1BOE:** PWM1B signal output enable (PWM1A and PWM1B signals are identical)

0: Disable PWM1B signal output to P2.3 1: Enable PWM1B signal output to P2.3

A6h.5 **PWM0AOE:** PWM0A signal output enable

0: Disable PWM0A signal output to P1.2 1: Enable PWM0A signal output to P1.2

A6h.4 **PWM0BOE:** PWM0B signal output enable (PWM0A and PWM0B signals are identical)

0: Disable PWM0B signal output to P2.2 1: Enable PWM0B signal output to P2.2

SFR F8h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
AUX1	CLRWDT	CLRTM3	TKSOC	ADSOC	CLRPWM0	_	_	DPSEL
R/W	R/W	R/W	R/W	R/W	R/W	_	_	R/W
Reset	0	0	0	0	0	_	_	0

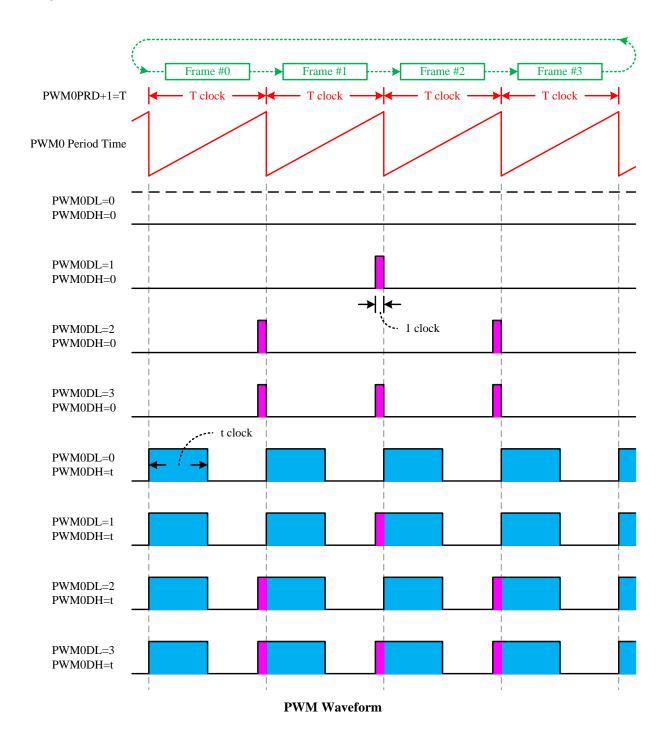
F8h.3 **CLRPWM0:** PWM0 clear enable

0: PWM0 is running

1: PWM0 is cleared and held

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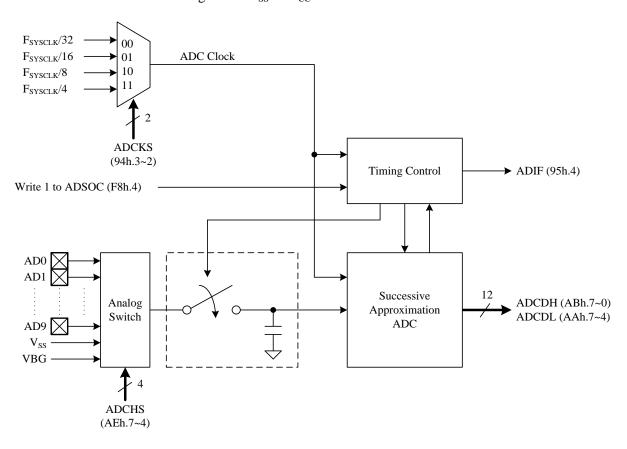






11. ADC

The Chip offers a 12-bit ADC consisting of a 12-channel analog input multiplexer, control register, clock generator, 12-bit successive approximation register, and output data register. To use the ADC, set the ADCKS bit first to choose a proper ADC clock frequency, which must be less than 1 MHz. Then, launch the ADC conversion by setting the ADSOC bit, and H/W will automatic clear it at the end of the conversion. After the end of the conversion, H/W will set the ADIF bit and generate an interrupt if an ADC interrupt is enabled. The ADIF bit can be cleared by writing 0 to this bit or 1 to the ADSOC bit. Because certain channels are shared with the Touch Key, the ADC channel must be configured differently from the Touch Key channel to avoid affecting the channel input sensitivity. The analog input level must remain within the range from $V_{\rm SS}$ to $V_{\rm CC}$.

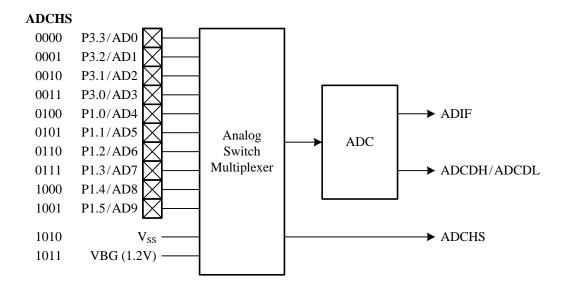


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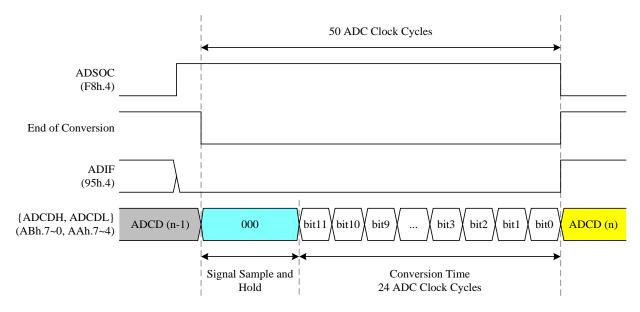
11.1 ADC Channels

The 12-bit ADC has a total of 12 channels, designated AD0~AD9, V_{SS} , and VBG. The ADC channels are connected to the analog input pins via the analog switch multiplexer. The analog switch multiplexer is controlled by the ADCHS register. The Chip offers up to 10 analog input pins, designated AD0~AD9. In addition, there are two analog input pins for voltage reference connections. When ADCHS is set to 1010b, the analog input will connect to V_{SS} , and when ADCHS is set to 1011b, the analog input will connect to VBG. VBG is an internal voltage reference at 1.2V.



11.2 ADC Conversion Time

The conversion time is the time required for the ADC to convert the voltage. The ADC requires two ADC clock cycles to convert each bit and several clock cycles to sample and hold the input voltage. A total of 50 ADC clock cycles are required to perform the complete conversion. When the conversion time is complete, the ADIF interrupt flag is set by H/W, and the result is loaded into the ADCDH and ADCDL registers of the 12-bit A/D result.



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SFR 94h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
OPTION	UART1W	MODE3V	WDTPSC		ADCKS		TM3PSC	
R/W	R/W	R/W	R/	R/W		W	R/	W
Reset	0	0	0	0	0	0	0	0

94h.3~2 **ADCKS:** ADC clock rate select

00: $F_{\text{SYSCLK}}/32$ 01: $F_{\text{SYSCLK}}/16$ 10: $F_{\text{SYSCLK}}/8$

11: F_{SYSCLK}/4

SFR 95h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
INTFLG	LVD	_	TKIF	ADIF		IE2	P1IF	TF3
R/W	R	_	R/W	R/W	_	R/W	R/W	R/W
Reset	_	_	0	0	_	0	0	0

95h.4 **ADIF:** ADC interrupt flag

Set by H/W at the end of conversion. S/W writes EFh to INTFLG or sets the ADSOC bit to clear this flag.

SFR AAh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
ADTKDT		ADO	CDL		TKEOC	TKOVF	TK	DH
R/W		I	2		R	R	F	>
Reset	_	_	_	_	_	_	_	_

AAh.7~4 **ADCDL:** ADC data bit 3~0

SFR ABh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
ADCDH		ADCDH								
R/W				I	₹					
Reset	_	-	_	_	_	_	_	_		

ABh.7~0 **ADCDH:** ADC data bit 11~4

SFR AEh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
CHSEL		ADO	CHS		TKCHS				
R/W		R/	W			R/	W		
Reset	1	1	1	1	1	1	1	1	

AEh.7~4 ADCHS: ADC channel select

0000: ADC0 (P3.3)

0001: ADC1 (P3.2)

0010: ADC2 (P3.1)

0011: ADC3 (P3.0)

0100: ADC4 (P1.0)

0101: ADC5 (P1.1)

0110: ADC6 (P1.2)

0111: ADC7 (P1.3) 1000: ADC8 (P1.4)

1001: ADC9 (P1.5)

 $1010 \colon V_{SS}$

1011: VBG (internal reference voltage)

11xx: Undefined

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SFR F8h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
AUX1	CLRWDT	CLRTM3	TKSOC	ADSOC	CLRPWM0	_	_	DPSEL
R/W	R/W	R/W	R/W	R/W	R/W		_	R/W
Reset	0	0	0	0	0		_	0

ADSOC: Start ADC conversion

F8h.4 Set the ADSOC bit to start ADC conversion, and the ADSOC bit will be cleared by H/W at the end of conversion. S/W can also write 0 to clear this flag.

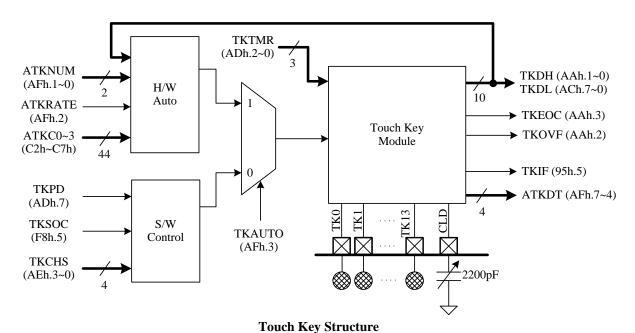
Note: also refer to Section 6 for more information about ADC Interrupt enable and priority.

Note: also refer to Section 7 for more information about ADC pin input setting.



12. Touch Key

The Touch Key offers an easy, simple and reliable method to implement finger touch detection. During the key scan operation, it only requires an external capacitor component on CLD pin. The device support 14 channels touch key detection with S/W manual mode and H/W Auto Mode (ATK). Only one mode can be active at a time.



To use the Touch Key, user must setup the pin mode correctly as below table. Setting Mode0 for an Idling Touch Key pin can pull up the pin and reduce the Key's mutual interference. While a TK pin is under scanning, user must set the pin to Mode3 to disable the pull up resistor.

P1MODx/P3MODx setting for Touch Key	TK0~TK3	TK4~TK8	TK9~TK13	CLD
Pin is not Touch Key	Mode0/1/2/3	Mode0/1/2/3	Mode0/1/2	Mode0/1/2/3
Pin is Touch Key, Idling	Mode0	Mode0	Mode0	Mode3
Pin is Touch Key, S/W Scanning	Mode3	Mode3	Mode3	Mode3
Pin is Touch Key, H/W Auto Scan (ATK)	Mode0	_	_	Mode3

S/W Manual Mode Touch Key Detection

All Touch Key (TK0~TK13) can be used for S/W manual mode. To start the S/W mode, user assigns TKAUTO=0 and TKPD=0, then set the TKSOC bit to start touch key conversion, the TKSOC bit can be automatically cleared while end of conversion. However, if the SYSCLK is too slow, H/W might fail to clear TKSOC due to clock sampling rate. TKEOC=0 means conversion is in process. TKEOC=1 means the conversion is finish, and the touch key counting result is stored into the 10 bits TK Data Counter TKDH and TKDL. After TKEOC=1, user must wait at least 10 µs for next conversion. If TKOVF=1, means the conversion transaction exceeds period time. Reduce/Increase TKTMR can reduce/increase TK Data Count to adapt the system board circumstances.

The Touch Key unit has an internal built-in reference capacitor to simulate the KEY behavior. Set TKCHS=15 and start the S/W scan mode can get the TK Data Count of this capacitor. Since the internal capacitor would not be affected by water or mobile phone, it is useful for comparing the environment background noise.

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H/W Auto Touch Key Detection (ATK)

Only TK0~TK3 are eligible for H/W auto mode. This function can work in Fast/Slow/Idle mode and save the S/W effort as well as minimize the Chip current consumption. To use this function, user need to set TKAUTO=1 and TKPD=1 to enable H/W fully control the TK unit. H/W then automatically detects the TK0~TK3's TK Data Count at every 2048 or 4096 Slow clock cycles. If a Key's TK Data Count is less than the pre-set compare threshold (ATKC0~3), H/W generates interrupt and wake up CPU. User can switch the TK module back to S/W Manual Mode after the TK interrupt and identify/confirm the Key touch event.

SFR 95h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
INTFLG	LVD	_	TKIF	ADIF	_	IE2	P1IF	TF3
R/W	R	_	R/W	R/W	_	R/W	R/W	R/W
Reset	_	_	0	0	_	0	0	0

95h.5 **TKIF:** Touch Key interrupt flag

In the S/W Manual mode: Set by H/W at the end of conversion. S/W writes DFh to INTFLG or sets the TKSOC bit to clear this flag.

In the ATK mode: Set by H/W when a TK channel's touch event is detected. It is cleared automatically when the program performs the interrupt service routine. S/W can write DFh to INTFLG to clear this bit.

Note: In ATK mode, this flag may be cleared improperly by ADC module. User should not start the ADC conversion in ATK mode.

SFR AAh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
ADTKDT		ADCDL				TKOVF	TK	DH
R/W		R				R	F	`
Reset	_	_	_	_	_	_	_	_

AAh.3 **TKEOC:** Touch Key end of conversion flag, TKEOC may have 3uS delay after TKSOC=1, so F/W must wait enough time before polling this Flag.

0: Indicates conversion is in progress

1: Indicates conversion is finished

AAh.2 **TKOVF:** Touch Key counter overflow

0: Indicates that the counter has not overflow

1: Indicates that the counter has overflow

AAh.1~0 **TKDH:** Touch Key counter data bit 9~8

SFR ACh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0			
TKDL		TKDL									
R/W				F	₹						
Reset	_	_	_	_	_	_	_	_			

ACh.7~0 **TKDL:** Touch Key counter data bit 7~0

SFR ADh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
TKCON	TKPD	_	_	_	_	TKTMR		
R/W	R/W	_	_	_	_	R/W		
Reset	1	_	_	_	_	1 0 0		0

ADh.7 **TKPD:** Touch Key power down

0: Touch Key running

1: Touch Key power down

ADh.2~0 **TKTMR:** Touch Key conversion time select

TKTMR adjusts the value of Touch Key reference voltage. A larger value of TKTMR requires a longer charging time, which can affect the sensitivity of touch sensing.

000: Conversion time shortest

. . .

111: Conversion time longest

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SFR AEh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
CHSEL		ADCHS			TKCHS				
R/W		R/W				R/	W		
Reset	1	1 1 1 1			1	1	1	1	

AEh.3~0 TKCHS: Touch Key channel select

0000: TK0 (P1.0)

0001: TK1 (P1.1)

0010: TK2 (P1.2)

0011: TK3 (P1.3)

0100: TK4 (P3.3)

0101: TK5 (P3.2)

0110: TK6 (P3.1)

0111: TK7 (P3.0)

1000: TK8 (P1.4)

1000: TK8 (F1.4) 1001: TK9 (P1.6)

1010: TK10 (P1.7)

1011: TK11 (P3.6)

1100: TK12 (P3.5)

1100: TK12 (F3.5) 1101: TK13 (P3.4)

1110: Undefined

1111: Internal reference capacitor

SFR AFh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
TKCON2	ATKDT			TKAUTO	ATKRATE	ATK	NUM	
R/W	R			R/W	R/W	R/	W	
Reset	_	_	_	_	0	0	1	1

AFh.7~4 **ATKDT:** Touch Key Auto Scan Result (for H/W ATK Mode)

xxx1: TK0 has a Touch event

xx1x: TK1 has a Touch event

x1xx: TK2 has a Touch event

1xxx: TK3 has a Touch event

AFh.3 **TKAUTO:** Touch Key Auto Scan Mode Enable

0: S/W Mode

1: H/W ATK Mode

AFh.2 **ATKRATE:** Touch Key Scan Rate (for H/W ATK Mode)

0: ATK scan rate at every 4096 Slow clock cycles

1: ATK scan rate at every 2048 Slow clock cycles

AFh.1~0 ATKNUM: Touch Key Auto Scan Channel Number (for H/W ATK Mode)

00: ATK only detect TK0

01: ATK detect TK0 and TK1

10: ATK detect TK0~TK2

11: ATK detect TK0~TK3

SFR C2h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
ATKC10H	_		ATKC1H				ATKC0H	
R/W	_		R/W				R/W	
Reset	_	0	0	0	_	0	0	0

C2h.6~4 **ATKC1H:** Data Threshold bit 10~8 Compared with TK1 scan (for H/W ATK Mode)

C2h.2~0 **ATKC0H:** Data Threshold bit 10~8 Compared with TK0 scan (for H/W ATK Mode)

SFR C3h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
ATKC32H	_		ATKC3H		_		ATKC2H	
R/W	_		R/W		_		R/W	
Reset	_	0	0	0	_	0	0	0

C3h.6~4 **ATKC3H:** Data Threshold bit 10~8 Compared with TK3 scan (for H/W ATK Mode)

C3h.2~0 ATKC2H: Data Threshold bit 10~8 Compared with TK2 scan (for H/W ATK Mode)



SFR C4h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
ATKC0L		ATKC0L						
R/W		R/W						
Reset	0	1	0	0	0	0	0	0

C4h.7~0 **ATKC0L:** Data Threshold bit 7~0 Compared with TK0 scan (for H/W ATK Mode)

SFR C5h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
ATKC1L		ATKC1L						
R/W		R/W						
Reset	0	0 1 0 0 0 0 0						

C5h.7~0 **ATKC1L:** Data Threshold bit 7~0 Compared with TK1 scan (for H/W ATK Mode)

SFR C6h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
ATKC2L		ATKC2L						
R/W		R/W						
Reset	0	0 1 0 0 0 0 0						

C6h.7~0 **ATKC2L:** Data Threshold bit 7~0 Compared with TK2 scan (for H/W ATK Mode)

SFR C7h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
ATKC3L		ATKC3L						
R/W		R/W						
Reset	0	1	0	0	0	0	0	0

C7h.7~0 **ATKC3L:** Data Threshold bit 7~0 Compared with TK3 scan (for H/W ATK Mode)

SFR F8h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
AUX1	CLRWDT	CLRTM3	TKSOC	ADSOC	CLRPWM0	_	_	DPSEL
R/W	R/W	R/W	R/W	R/W	R/W	_	_	R/W
Reset	0	0	0	0	0	_	_	0

F8h.5 **TKSOC:** Start Touch Key conversion

Set the TKSOC bit to start Touch Key conversion, and the TKSOC bit will be cleared by H/W at the end of conversion. S/W can also write 0 to clear this flag.

Note: also refer to Section 6 for more information about Touch Key Interrupt enable and priority.

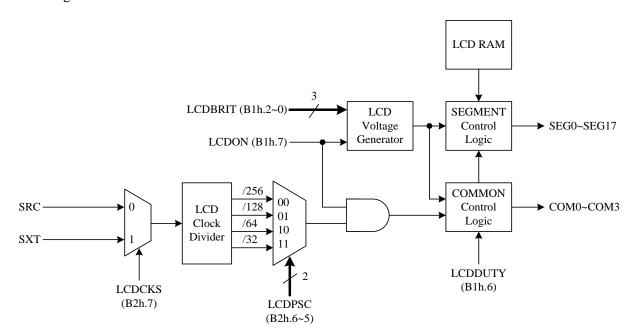
Note: also refer to Section 7 for more information about Touch Key pin input setting.

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13. LCD Controller/Driver

The Chip supports an LCD controller and driver. The LCD driver is capable of driving the LCD panel with 72 dots by 4 Commons and 18 Segments. It is capable of driving 1/3 bias. The LCD clock source is generated from SRC or SXT depends on LCDCKS bit. The clock rate can be divided by 32, 64, 128, and 256 by the LCDPSC bits. If SRC is the LCD clock source, the $V_{\rm CC}$ voltage level would affect the SRC frequency and LCD frame rate. The LCDRAM is located in the 8051's External Data Memory space, addressing from F000h to F008h.



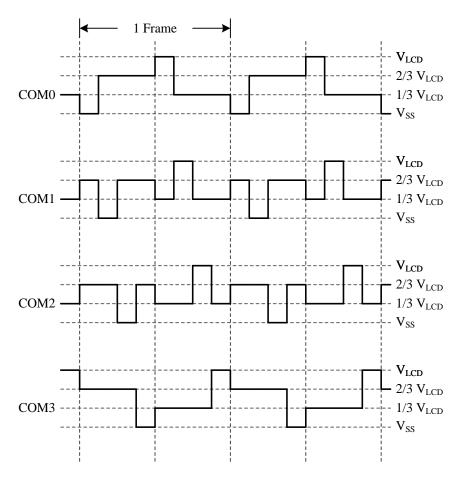
LCD RAM (External Data Memory)

Addr.	COM3	COM2	COM1	COM0	COM3	COM2	COM1	COM0
F000h	SEG1	SEG1	SEG1	SEG1	SEG0	SEG0	SEG0	SEG0
F001h	SEG3	SEG3	SEG3	SEG3	SEG2	SEG2	SEG2	SEG2
F002h	SEG5	SEG5	SEG5	SEG5	SEG4	SEG4	SEG4	SEG4
F003h	SEG7	SEG7	SEG7	SEG7	SEG6	SEG6	SEG6	SEG6
F004h	SEG9	SEG9	SEG9	SEG9	SEG8	SEG8	SEG8	SEG8
F005h	SEG11	SEG11	SEG11	SEG11	SEG10	SEG10	SEG10	SEG10
F006h	SEG13	SEG13	SEG13	SEG13	SEG12	SEG12	SEG12	SEG12
F007h	SEG15	SEG15	SEG15	SEG15	SEG14	SEG14	SEG14	SEG14
F008h	SEG17	SEG17	SEG17	SEG17	SEG16	SEG16	SEG16	SEG16

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The frequency of any repeating waveform output on the COM pin can be used to represent the LCD frame rate. The figure below shows an LCD frame.



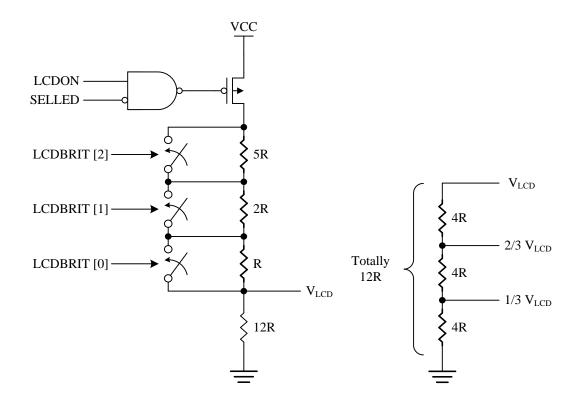
The frame rate table for each lighting system is shown below.

		LCD Fram	e Rate (Hz)		
LCDCKS	LCDPSC	LCDDUTY (B1h.6)			
(B2h.7)	$(B2h.6\sim5)$	0	1		
		(1/3 duty)	(1/4 duty)		
	00 (/256)	15.63	11.72		
0 (SRC)	01 (/128)	31.25	23.44		
24000 Hz	10 (/64)	62.5	46.88		
	11 (/32)	125	93.75		
	00 (/256)	21.33	16.00		
1 (SXT) 32768 Hz	01 (/128)	42.67	32.00		
	10 (/64)	85.33	64.00		
	11 (/32)	170.67	128.00		

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The following figure of the LCD voltage generator shows the internal voltage generator composed by resistors. LCDON and SELLED control the current flows from V_{CC} to ground. If LCDON=0 or SELLED=1, the PMOS will turn off the path so that all LCD voltages will be 0 V. If LCDON=1 and SELLED=0, the resistor divider will work to generate multi voltages to provide the LCD control module for generating the desired waveforms. The LCDBRIT control bits will open/short the switches to determine V_{LCD} . The table below shows V_{LCD} corresponding to LCDBRIT. The voltage divider circuit will consume current because the DC path is always on when LCDON=1 and SELLED=0.

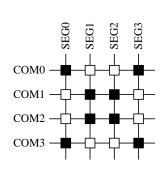


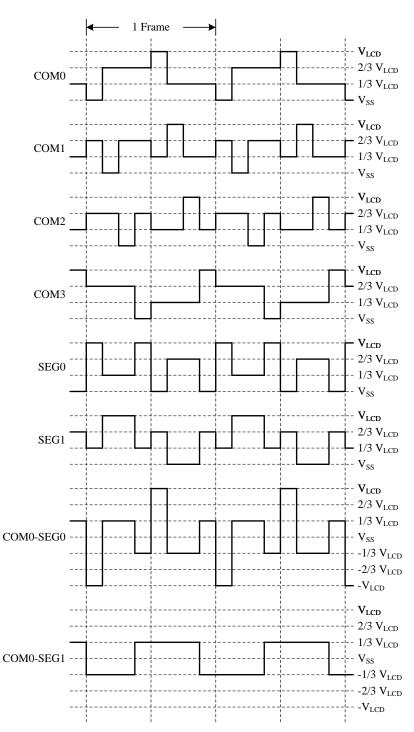
LCDBRIT	V_{LCD}
000	(12/20) x V _{CC}
001	(12/19) x V _{CC}
010	$(12/18) \times V_{CC}$
011	(12/17) x V _{CC}
100	$(12/15) \times V_{CC}$
101	$(12/14) \times V_{CCc}$
110	(12/13) x V _{CC}
111	V_{CC}

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1/4 Duty, 1/3 Bias Output Waveform







SFR B1h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
LCDCON	LCDON	LCDDUTY	_	_	_	LCDBRIT		
R/W	R/W	R/W	_	_	_	R/W		
Reset	0	1	_	_	_	1	0	0

B1h.7 LCDON: LCD/LED enable bit

> 0: LCD/LED disable 1: LCD/LED enable

LCDDUTY: LCD/LED duty select B1h.6

> 0: 1/3 duty 1: 1/4 duty

B1h.2~0 LCDBRIT: LCD brightness select

> 000: (12/20) x V_{CC} 001: (12/19) x V_{CC} 010: (12/18) x V_{CC} 011: (12/17) x V_{CC} 100: (12/15) x V_{CC} 101: (12/14) x V_{CC} 110: (12/13) x V_{CC} 111: V_{CC}

SFR B2h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
LCDCON2	LCDCKS	LCDPSC		SELLED	LEDPOL	LEDDTE	_	_
R/W	R/W	R/W		R/W	R/W	R/W	_	_
Reset	0	0	0	0	0	0	_	

LCDCKS: LCD/LED clock source select

B2h.7 0: SRC

1: SXT

LCDPSC: LCD/LED clock prescaler select

00: LCD/LED clock is divided by 256

B2h.6~5 01: LCD/LED clock is divided by 128

10: LCD/LED clock is divided by 64 11: LCD/LED clock is divided by 32

SFR B3h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
LCDPIN	LCDPIN7	LCDPIN6	LCDPIN5	LCDPIN4	LCDPIN3	LCDPIN2	LCDPIN1	LCDPIN0
R/W								
Reset	0	0	0	0	0	0	0	0

B3h.7 LCDPIN7: P3.2 (SEG17) LCD/LED mode enable B3h.6 LCDPIN6: P3.1 (SEG16) LCD/LED mode enable B3h.5 LCDPIN5: P3.0 (SEG15) LCD/LED mode enable LCDPIN4: P1.0 (SEG14) LCD/LED mode enable B3h.4 B3h.3 LCDPIN3: P1.1 (SEG13) LCD/LED mode enable B3h.2 LCDPIN2: P1.2 (SEG12) LCD/LED mode enable B3h.1

LCDPIN1: P1.3~P1.6 (SEG11~8) LCD/LED mode enable

Note: SEG9 and Touch Key CLD share the same pin. If this bit is set, the Touch Key function would be affected.

B3h.0 LCDPIN0: P17, P3.6~P3.4 (SEG7~4) LCD/LED mode enable

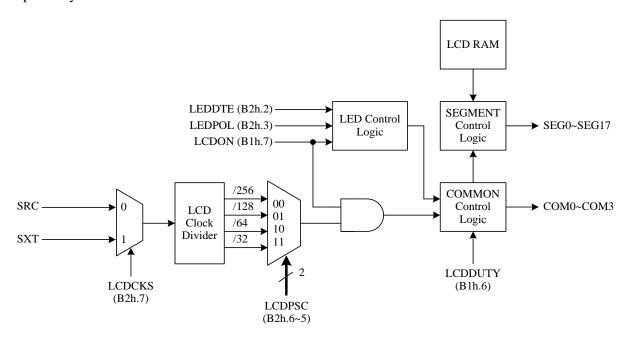
0: I/O mode

1: LCD/LED mode



14. LED Controller/Driver

The Chip supports an LED controller and driver. If the LED mode option SELLED is set, The Chip will switch the LCD driver to the LED driver. It provides 18 Segment pins and 4 Common pins to drive an LED module with 72 pixels. The LED and LCD module share the same clock source and LCDRAM. For LED application, the COM pins have a high sink current, which can drive an LED directly. Besides, the LED provides COM pin polarity and dead time options, by setting the LEDPOL bit and the LEDDTE bit respectively.

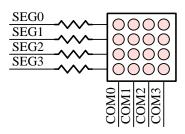


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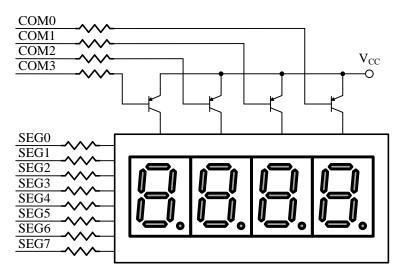


Application Circuit

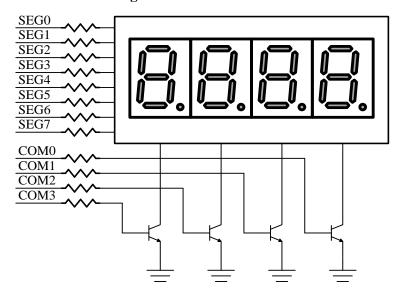
COM Active Low and SEG Active High



COM Active Low and SEG Active Low



COM Active High and SEG Active High

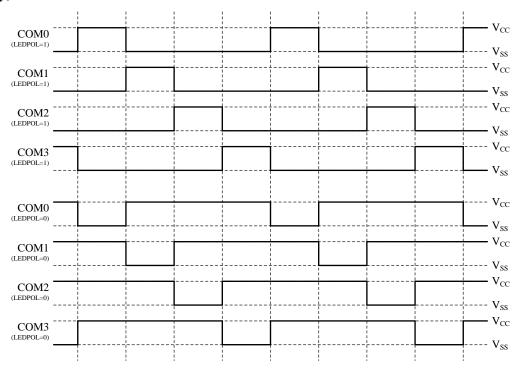


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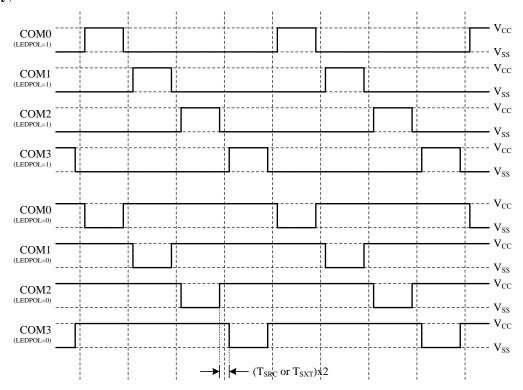


To avoid LED flicker when the common signal is changing, the Chip provides a dead time option. Setting the SELLED bit selects the LED mode, and setting the LEDDTE bit enables the dead time. In the dead time period, a common pin will output a short inactive signal instead of changing the signal immediately.

1/4 Duty, LEDDTE=0



1/4 Duty, LEDDTE=1



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SFR B1h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
LCDCON	LCDON	LCDDUTY	_	_	_	LCDBRIT		
R/W	R/W	R/W	_	_	_	R/W		
Reset	0	1	_	_	_	1	0	0

B1h.7 **LCDON:** LCD/LED enable bit

0: LCD/LED disable 1: LCD/LED enable

SFR B2h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
LCDCON2	LCDCKS	LCDPSC		SELLED	LEDPOL	LEDDTE	_	_
R/W	R/W	R/W		R/W	R/W	R/W	_	_
Reset	0	0	0	0	0	0	_	_

B2h.7 LCDCKS: LCD/LED clock source select

0: SRC 1: SXT

B2h.6~5 LCDPSC: LCD/LED clock prescaler select

00: LCD/LED clock is divided by 256 01: LCD/LED clock is divided by 128 10: LCD/LED clock is divided by 64 11: LCD/LED clock is divided by 32

B2h.4 **SELLED:** LED select mode

0: LCD mode 1: LED mode

B2h.3 **LEDPOL:** LED COM polarity select

0: Active low (with high sink)

1: Active high

B2h.2 **LEDDTE:** LED COM dead time enable

0: LED COM dead time disable 1: LED COM dead time enable

SFR B3h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
LCDPIN	LCDPIN7	LCDPIN6	LCDPIN5	LCDPIN4	LCDPIN3	LCDPIN2	LCDPIN1	LCDPIN0
R/W								
Reset	0	0	0	0	0	0	0	0

B3h.7 LCDPIN7: P3.2 (SEG17) LCD/LED mode enable
B3h.6 LCDPIN6: P3.1 (SEG16) LCD/LED mode enable
B3h.5 LCDPIN5: P3.0 (SEG15) LCD/LED mode enable
B3h.4 LCDPIN4: P1.0 (SEG14) LCD/LED mode enable
B3h.3 LCDPIN3: P1.1 (SEG13) LCD/LED mode enable
B3h.2 LCDPIN2: P1.2 (SEG12) LCD/LED mode enable
B3h.1 LCDPIN1: P1.3~P1.6 (SEG11~8) LCD/LED mode enable

Note: SEG9 and Touch Key CLD share the same pin. If this bit is set, the Touch Key function would

be affected.

B3h.0 **LCDPIN0:** P17, P3.6~P3.4 (SEG7~4) LCD/LED mode enable

0: I/O mode 1: LCD/LED mode

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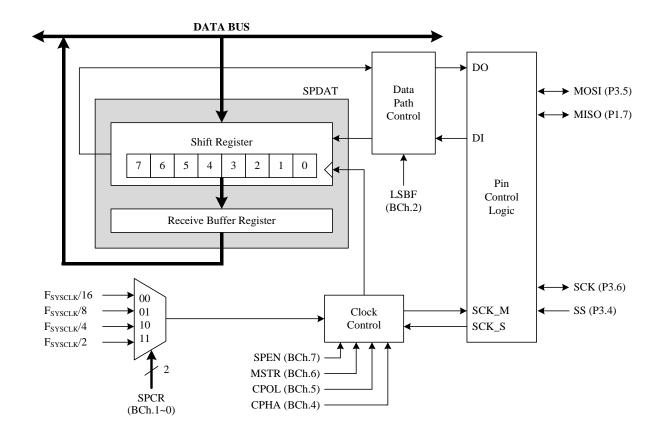


15. Serial Peripheral Interface (SPI)

The Serial Peripheral Interface (SPI) module is capable of full-duplex, synchronous, serial communication between the MCU and peripheral devices. The peripheral devices can be other MCUs, A/D converter, sensors, or flash memory, etc. The SPI runs at a clock rate up to the system clock divided by two. Firmware can read the status flags, or the operation can be interrupt driven. Following figure shows the SPI system block diagram.

The features of the SPI module include:

- Master or Slave mode operation
- 3-wire or 4-wire mode operation
- Full-duplex operation
- Programmable transmit bit rate
- Single buffer receive
- Serial clock phase and polarity options
- MSB-first or LSB-first shifting selectable



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The four signals used by SPI are described below. The MOSI (P3.5) signal is an output from a Master Device and an input to Slave Devices. The MISO (P1.7) signal is an output from a Slave Device and an input to a Master Device. Data is transferred most-significant bit (MSB) or least-significant bit (LSB) first by setting the LSBF bit. The SCK (P3.6) signal is an output from a Master Device and an input to Slave Devices. It is used to synchronize the data on the MOSI and MISO lines of Master and Slave. SPI generates the signal with eight programmable clock rates in Master mode. The SS (P3.4) signal is a low active slave select pin. In 4-wire Slave mode, the signal is ignored when the Slave is not selected (SS=1). The SS is ignored when the SSDIS in SPCON is set in both Master and Slave modes. In Slave mode and the SSDIS is clear, the SPI active when SS stay low. For multiple-slave mode, only one slave device is selected at a time to avoid bus collision on the MISO line. In Master mode and the SSDIS is cleared, the MODF in SPSTA is set when this signal is low. For multiple-master mode, enable SS line to avoid multiple driving on MOSI and SCK lines from multiple masters.

Master Mode

The SPI operates in Master mode by setting the MSTR bit in the SPCON. To start transmit, writing a data to the SPDAT. If the SPBSY bit is cleared, the data will be transferred to the shift register and starts shift out on the MOSI line. The data of the slave shift in from the MISO line at the same time. When the SPIF bit in the SPSTA becomes set at the end of the transfer, the receive data is written to receiver buffer and the RCVBF bit in the SPSTA is set. To prevent an overrun condition, software must read the SPDAT before next byte enters the shift register. The SPBSY bit will be set when writing a data to SPDAT to start transmit, and be cleared at the end of the eighth SCK period in Master mode.

Slave Mode

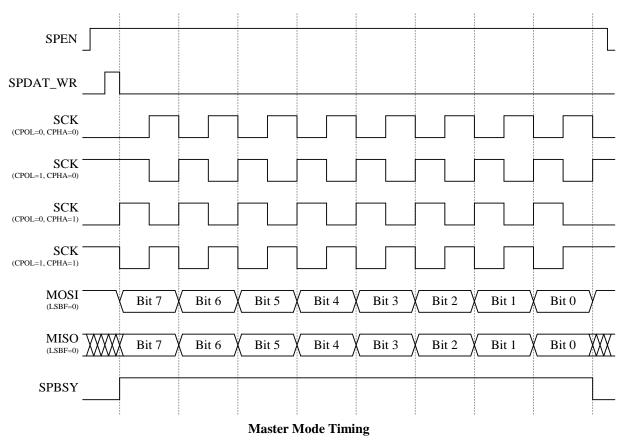
The SPI operates in Slave mode by clearing the MSTR bit in the SPCON. If the SSDIS is cleared, the transmission will start when the SS become low and remain low until the end of a data transfer. If the SSDIS is set, the transmission will start when the SPEN bit in the SPCON is set, and don't care the SS. The data from a master will shift into the shift register through the MOSI line, and shift out from the shift register on the MISO line. When a byte enters the shift register, the data will be transferred to receiver buffer if the RCVBF is cleared. If the RCVBF is set, the newer receive data will not be transferred to receiver buffer and the RCVOVF bit is set. After a byte enters the shift register, the SPIF and RCVBF bits are set. To prevent an overrun condition, software must read the SPDAT or write 0 to RCVBF before next byte enters the shift register. The maximum SCK frequency allowed in Slave mode is $F_{SYSCLK}/4$. In Slave mode, the SPBSY bit refers to the SS pin when the SSDIS bit is cleared, and refer to the SPEN bit when SSDIS bit is set.

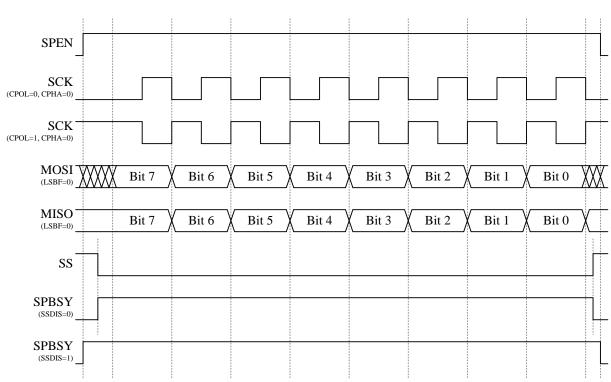
Serial Clock

The SPI has four clock types by setting the CPOL and CPHA bits in the SPCON register. The CPOL bit defines the level of the SCK in SPI idle state. The level of the SCK in idle state is low when the CPOL bit is cleared, and is high when the CPOL bit is set. The CPHA bit defines the edges used to sample and shift data. The SPI sample data on the first edge of SCK period and shift data on the second edge of SCK period when the CPHA bit is cleared. The SPI sample data on the second edge of SCK period and shift data on first edge of SCK period when the CPHA bit is set. The figures below show the detail timing in Master and Slave modes. Both Master and Slave devices must be configured to use the same clock type before the SPEN bit is set. The SPCR controls the Master mode serial clock frequency. This register is ignored when operating in Slave mode. The SPI clock can select System clock divided by 2, 4, 8, or 16 in Master mode.

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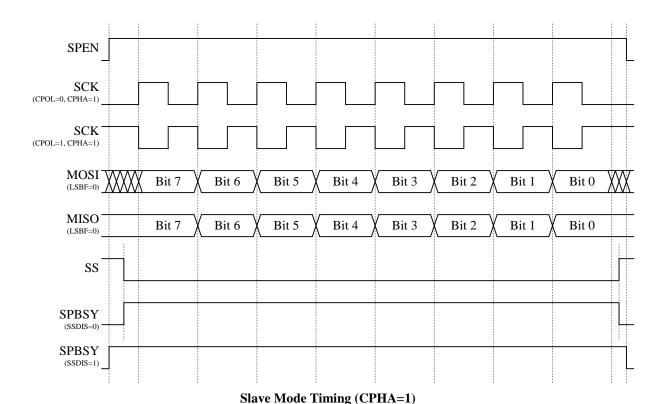






Slave Mode Timing (CPHA=0)





In both Master and Slave modes, the SPIF bit is set by H/W at the end of a data transfer and generates an interrupt if SPI interrupt is enabled. The SPIF bit is cleared automatically when the program performs the interrupt service routines. S/W can also write 0 to clear this flag. If write data to SPDAT when the SPBSY is set, the WCOL bit will be set by H/W and generates an interrupt if SPI interrupt is enabled. When this occurs, the data write to SPDAT will be ignored, and shift register will not be written. Write 0 to this bit or when SPBSY is cleared and rewrite data to SPDAT will clear this flag. The MODF bit is set when SSDIS is cleared and SS pin is pulled low in Master mode. If SPI interrupt is enabled, an interrupt will be generated. When this bit is set, the SPEN and MSTR in SPCON will be cleared by H/W. Write 0 to this bit will clear this flag.

SFR BCh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
SPCON	SPEN	MSTR	CPOL	СРНА	SSDIS	LSBF	SP	CR
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/	W
Reset	0	0	0	0	0	0	0	0

BCh.7 **SPEN:** SPI enable

0: SPI disable 1: SPI enable

BCh.6 MSTR: Master mode enable

0: Slave mode 1: Master mode

BCh.5 **CPOL:** SPI clock polarity

0: SCK is low in idle state 1: SCK is high in idle state

BCh.4 **CPHA:** SPI clock phase

0: Data sample on first edge of SCK period1: Data sample on second edge of SCK period

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BCh.2

BCh.3 **SSDIS:** SS pin disable

0: Enable SS pin 1: Disable SS pin

LSBF: LSB first

0: MSB first

1: LSB first

BCh.1~0 **SPCR:** SPI clock rate

00: F_{SYSCLK}/2 01: F_{SYSCLK}/4 10: F_{SYSCLK}/8 11: F_{SYSCLK}/16

SFR BDh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
SPSTA	SPIF	WCOL	MODF	RCVOVF	RCVBF	SPBSY	_	_
R/W	R/W	R/W	R/W	R/W	R/W	R/W	_	_
Reset	0	0	0	0	0	0	_	_

BDh.7 **SPIF:** SPI interrupt flag

This is set by H/W at the end of a data transfer. Cleared by H/W when an interrupt is vectored into. Writing 0 to this bit will clear this flag.

BDh.6 WCOL: Write collision interrupt flag

Set by H/W if write data to SPDAT when SPBSY is set. Write 0 to this bit or rewrite data to SPDAT when SPBSY is cleared will clear this flag.

BDh.5 **MODF:** Mode fault interrupt flag

Set by H/W when SSDIS is cleared and SS pin is pulled low in Master mode. Write 0 to this bit will clear this flag. When this bit is set, the SPEN and MSTR in SPCON will be cleared by H/W.

BDh.4 **RCVOVF:** Received buffer overrun flag

Set by H/W at the end of a data transfer and RCVBF is set. Write 0 to this bit or read SPDAT register will clear this flag.

BDh.3 **RCVBF:** Receive buffer full flag

Set by H/W at the end of a data transfer. Write 0 to this bit or read SPDAT register will clear this flag.

BDh.2 **SPBSY:** SPI busy flag

Set by H/W when a SPI transfer is in progress.

SFR BEh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
SPDAT		SPDAT								
R/W				R/	W					
Reset	0	0	0	0	0	0	0	0		

BEh.7~0 **SPDAT:** SPI transmit and receive data

The SPDAT register is used to transmit and receive data. Writing data to SPDAT place the data into shift register and start a transfer when in master mode. Reading SPDAT returns the contents of the receive buffer.

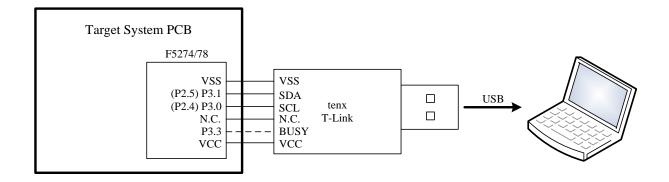
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16. In Circuit Emulation (ICE) Mode

This device can support the In Circuit Emulation Mode. To use the ICE Mode, user just needs to connect P3.0 and P3.1 pin to the tenx proprietary EV Module. The benefit is that user can emulate the whole system without changing the on board target device. But there are some limits for the ICE mode as below.

- 1. The device must be un-protect.
- 2. The device's P3.0 and P3.1 pins must work in input Mode (P3MOD0=0/1 and P3MOD1=0/1).
- 3. During Program Code download, P3.3 sent acknowledge signal to T-Link unit. After download stage, P3.3 can be emulated as any other pins.
- 4. The Program Memory's addressing space 0D00h~0FFFh and 0033h~003Ah are occupied by tenx EV module. So user Program cannot access these spaces.
- 5. The P3.0 and P3.1 pin's function cannot be emulated.
- 6. The P3.0 and P3.1 pin's can be replaced by P2.4 and P2.5.



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SFR & CFGW MAP

Adr	Rst	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0				
80h	1111-1111	PO	P0.7	P0.6	P0.5	P0.4	P0.3	P0.2	P0.1	P0.0				
81h	0000-0111	SP	10.7	10.0	10.5	S		1 0.2	1 0.1	1 0.0				
82h	0000-0000	DPL		DPL										
83h	0000-0000	DPH		DPH										
87h	0xxx-0000	PCON	SMOD	_	_	_	GF1	GF0	PD	IDL				
88h	0000-0000	TCON	TF1	TR1	TF0	TR0	IE1	IT1	IE0	IT0				
89h	0000-0000	TMOD	GATE1	CT1N	TM	OD1	GATE0	CT0N	TM	OD0				
8Ah	0000-0000	TL0				TI	_0							
8Bh	0000-0000	TL1				TL1								
8Ch	0000-0000	TH0				TH	H0							
8Dh	0000-0000	TH1		T	T	TH	H1	T	ı	1				
90h	1111-1111	P1	P1.7	P1.6	P1.5	P1.4	P1.3	P1.2	P1.1	P1.0				
	0000-0000	POOE				P00			ı					
	0000-0101	P2MOD			OE		P2M			OD0				
	0000-0000	OPTION	UART1W	MODE3V		TPSC	ADO	CKS		BPSC				
	xx00-x000	INTFLG	LVDO	=	TKIF	ADIF	- -	IE2	P1IF	TF3				
	0000-0000	P1WKUP				P1W								
	0000-0000	SWCMD	SM0	CM1	CM2	IAPALL REN	TB8	DDO	TI	RI				
		SCON SBUF	SMU	SM1	SM2	SB		RB8	11	KI				
99ll 9Ah	1111 1111	PWM0PRD				PWM								
9Bh		PWM0DH				PWM								
		PWM1PRD				PWM								
		PWM1DH				PWM								
	1111-1111	P2	P2.7	P2.6	P2.5	P2.4	P2.3	P2.2	P2.1	P2.0				
A1h	1000-1000	PWMCON	PWM	1CKS	PWM1DL		PWM	0CKS	PWM	10DL				
A2h	0000-0000	P1MODL	P1M	OD3	P1M	OD2	P1M	OD1	P1MOD0					
A3h	0000-0000	P1MODH	P1M	OD7	P1M	OD6	P1M	OD5	P1MOD4					
A4h	0101-0101	P3MODL	P3M	OD3	P3M	OD2	P3M	OD1	P3MOD0					
A5h	0x00-0000	P3MODH	T00E	-	P3M	OD6	P3M	OD5	P3MOD4					
A6h	0000-00xx	PINMOD	PWM1AOE	PWM1BOE	PWM0AOE	PWM0BOE	TCOE	T2OE	_	-				
A8h	0x00-0000	IE	EA		ET2	ES	ET1	EX1	ET0	EX0				
A9h	0000-0000	INTE1		IAPWE		SPIE	ADTKIE	EX2	P1IE	TM3IE				
	xxxx-xxxx	ADTKDT		ADO	CDL		TKEOC	TKOVF	TK	DH				
	XXXX-XXXX	ADCDH				ADO								
	XXXX-XXXX	TKDL				TK								
-	1xxx-x100	TKCON	TKPD	-	-	_	=	mr.	TKTMR					
	1111-1111	CHSEL			CHS		THE ALITED	TKO	1	NII IN A				
-	xxxx-0011	TKCON2	D2 7	ATI	ı	D2 4	TKAUTO	ATKRATE		NUM P2 0				
-	1111-1111 01xx-x100	P3 LCDCON	P3.7 LCDON	P3.6 LCDDUTY	P3.5	P3.4	P3.3	P3.2	P3.1 LCDBRIT	P3.0				
		LCDCON2	LCDCKS	LCD		SELLED	LEDPOL	LEDDTE	LCDBRII					
	0000-0000		LCDPIN7	LCDPIN6	LCDPIN5	LCDPIN4	LCDPIN3	LCDPIN2	LCDPIN1	LCDPIN0				
	xx00-0000	IP		_	PT2	PS PS	PT1	PX1	PT0	PX0				
	xx00-0000	IPH		_	PT2H	PSH	PT1H	PX1H	PT0H	PX0H				
	xxx0-0000	IP1		_	-	PSPI	PADTKI	PX2	PP1	PT3				
~, 111	0000	** *		l				1112	111	113				



Adr	Rst	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
BBh	xxx0-0000	IP1H	-	-			PADTKIH	PX2H	PP1H	РТ3Н		
BCh	0000-0000	SPCON	SPEN	MSTR	CPOL	СРНА	SSDIS	LSBF SPCR				
BDh	0000-0xxx	SPSTA	SPIF	WCOL	MODF	RCVOVF	RCVBF	SPBSY	=	=		
BEh	0000-0000	SPDAT				SPE	DAT					
C2h	x000-x000	ATKC10H	=		ATKC1H		=		ATKC0H			
C3h	x000-x000	ATKC32H			ATKC3H		_		ATKC2H			
C4h	0100-0000	ATKC0L				ATK	COL					
C5h	0100-0000	ATKC1L				ATK	C1L					
C6h	0100-0000	ATKC2L			ATKC2L							
C7h	0100-0000	ATKC3L		ATKC3L								
C8h	0000-0000	T2CON	TF2	EXF2	RCLK	TCLK	EXEN2	TR2	CT2N	CPRL2N		
CAh	0000-0000	RCP2L				RC	P2L					
CBh	0000-0000	RCP2H				RCI	P2H					
CCh	0000-0000	TL2				TI	L2					
CDh	0000-0000	TH2				TI	H2					
D0h	0000-0000	PSW	CY	AC	F0	RS1	RS0	OV	F1	P		
D8h	00x0-0011	CLKCON	SCKTYPE	FCKTYPE	II	STPPCK	STPFCK	SELFCK	CLK	PSC		
E0h	0000-0000	ACC	ACC.7	ACC.6	ACC.5	ACC.4	ACC.3	ACC.2	ACC.1	ACC.0		
F0h	0000-0000	В	B.7	B.6	B.5	B.4	B.3	B.2	B.1	B.0		
F7h	xxxx-xxxx	CFGWL	WE)TE				FRCF				
F8h	0000-0xx0	AUX1	CLRWDT	CLRTM3	TKSOC	ADSOC	CLRPWM0	-	-	DPSEL		

Flash Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
1FFEh	CFGWL	-	-	-	FRCF				
1FFFh	CFGWH	PROT	XRSTE	LV	RE	VCCFLT	PWRSAV	MVCLOCK	-

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SFR & CFGW DESCRIPTION

SFR	SFR Name	Bit #	Bit Name	R/W	Rst	Description	
Adr				, , ,		-	
80h	P0	7~0	P0	R/W	FFh	Port0 data, also controls the P0.n pin's pull-up function. If the P0.n SFR data is "1" and the corresponding P0OE.n=0	
0.11-	SP	7.0	CD	D/W	071-	(input mode), the pull-up is enabled. Stack Point	
81h 82h	DPL	7~0 7~0	SP	R/W	07h		
			DPL	R/W	00h	Data Point low byte	
83h	DPH	7~0	DPH	R/W	00h	Data Point high byte	
		7	SMOD	R/W	0	UART double baud rate control bit 0: Disable UART double baud rate 1: Enable UART double baud rate	
87h	PCON	3	GF1	R/W	0	General purpose flag bit	
		2	GF0	R/W	0	General purpose flag bit	
		1	PD	R/W	0	Stop bit. If 1 Stop mode is entered.	
		0	IDL	R/W	0	Idle bit. If 1, Idle mode is entered.	
		7	TF1	R/W	0	Timer1 overflow flag Set by H/W when Timer/Counter 1 overflows. Cleared by	
						H/W when CPU vectors into the interrupt service routine.	
						Timer1 run control	
		6	TR1	R/W	0	0: Timer1 stops	
						1: Timer1 runs	
		_	TENEO.	D // I		Timer0 overflow flag	
		5	TF0	R/W	0	Set by H/W when Timer/Counter 0 overflows. Cleared by H/W when CPU vectors into the interrupt service routine.	
						Timer0 run control	
		4	TR0	R/W	0	0: Timer0 stops	
						1: Timer0 runs	
88h	TCON					External Interrupt 1 (INT1 pin) edge flag Set by H/W when an INT1 pin falling edge is detected, no	
		3	IE1	R/W	0	matter the EX1 is 0 or 1. It is cleared automatically when	
						the program performs the interrupt service routine.	
						External Interrupt 1 control bit	
		2	IT1	R/W	0	0: Low level active (level triggered) for INT1 pin	
						1: Falling edge active (edge triggered) for INT1 pin	
						External Interrupt 0 (INT0 pin) edge flag	
		1	IE0	R/W	0	Set by H/W when an INTO pin falling edge is detected, no	
						matter the EX0 is 0 or 1. It is cleared automatically when	
						the program performs the interrupt service routine. External Interrupt 0 control bit	
		0	IT0	R/W	0	0: Low level active (level triggered) for INT0 pin	
		U	110	10, 11	U	1: Falling edge active (edge triggered) for INTO pin	
						Timer1 gating control bit	
		7	CATE1	R/W		0: Timer1 enable when TR1 bit is set	
		7	GATE1	K/W	0	1: Timer1 enable only while the INT1 pin is high and	
						TR1 bit is set	
89h	TMOD					Timer1 Counter/Timer select bit	
			OT 1 N	D/III	0	0: Timer mode, Timer1 data increases at 2 System clock	
			6	6 CT1N R	R/W 0	U	cycle rate
						1: Counter mode, Timer1 data increases at T1 pin's negative edge	
						negative euge	

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SFR	GTT 17	-A: !!				
Adr	SFR Name	Bit #	Bit Name	R/W	Rst	Description
		5~4	TMOD1	R/W	00	Timer1 mode select 00: 8-bit timer/counter (TH1) and 5-bit prescaler (TL1) 01: 16-bit timer/counter 10: 8-bit auto-reload timer/counter (TL1). Reloaded from TH1 at overflow. 11: Timer1 stops
		3	GATE0	R/W	0	Timer0 gating control bit 0: Timer0 enable when TR0 bit is set 1: Timer0 enable only while the INT0 pin is high and TR0 bit is set
89h	TMOD	2	CT0N	R/W	0	Timer0 Counter/Timer select bit 0: Timer mode, Timer0 data increases at 2 System clock cycle rate 1: Counter mode, Timer0 data increases at T0 pin's negative edge
		1~0	TMOD0	R/W	00	Timer0 mode select 00: 8-bit timer/counter (TH0) and 5-bit prescaler (TL0) 01: 16-bit timer/counter 10: 8-bit auto-reload timer/counter (TL0). Reloaded from TH0 at overflow. 11: TL0 is an 8-bit timer/counter. TH0 is an 8-bit timer/counter using Timer1's TR1 and TF1 bits.
8Ah	TL0	7~0	TL0	R/W	00h	Timer0 data low byte
8Bh	TL1	7~0	TL1	R/W	00h	Timer1 data low byte
8Ch	TH0	7~0	TH0	R/W	00h	Timer0 data high byte
8Dh	TH1	7~0	TH1	R/W	00h	Timer1 data high byte
90h	P1	7~0	P1	R/W	FFh	Port1 data
91h	P0OE	7~0	P0OE	R/W	00h	Port0 CMOS Push-Pull output enable control 0: Disable 1: Enable
93h	P2MOD	7~4	P2OE	R/W	0000	P2.5~P2.2 CMOS Push-Pull output enable control 0: Disable 1: Enable
		3~2	P2MOD1	R/W	01	P2.1 pin control
		1~0	P2MOD0	R/W	01	P2.0 pin control
		7	UART1W	R/W	0	One wire UART mode enable, both TXD/RXD use P3.1 pin 0: Disable one wire UART mode 1: Enable one wire UART mode
94h	OPTION	6	MODE3V	R/W	0	3V mode selection control bit If this bit is set, the Chip can be only operated in the condition of V_{CC} <3.6V, and LDO is turned off to save current
		5~4	WDTPSC	R/W	00	Watchdog Timer pre-scalar time select 00: 360ms WDT overflow rate 01: 180ms WDT overflow rate 10: 90ms WDT overflow rate 11: 45ms WDT overflow rate



SFR	SFR Name	Bit #	Bit Name	R/W	Rst	Description
Adr	or K Manie	Вιιπ	Dit Manie	IX/ VV	Kst	-
94h	OPTION	3~2	ADCKS	R/W	00	ADC clock rate select 00: F _{SYSCLK} /32 01: F _{SYSCLK} /16 10: F _{SYSCLK} /8 11: F _{SYSCLK} /4
9411	OFFION	1~0	TM3PSC	R/W	00	Timer3 interrupt rate control select 00: Interrupt rate is 32768 Slow clock cycle 01: Interrupt rate is 16384 Slow clock cycle 10: Interrupt rate is 8192 Slow clock cycle 11: Interrupt rate is 128 Slow clock cycle
		7	LVDO	R		Low Voltage Detect flag Set by H/W when a low voltage occurs. The flag is valid when LVR is 2.0V. This flag is disabled in Stop mode or if MODE3V=1 and PWRSAV=1.
		5	TKIF	R/W	0	Touch Key interrupt flag In the S/W Manual mode: Set by H/W at the end of conversion. S/W writes DFh to INTFLG or sets the TKSOC bit to clear this flag. In the ATK mode: Set by H/W when a TK channel's touch event is detected. It is cleared automatically when the program performs the interrupt service routine. S/W can write DFh to INTFLG to clear this bit. Note: In ATK mode, this flag may be cleared improperly by ADC module. User should not start the ADC conversion in ATK mode.
95h	INTFLG	4	ADIF	R/W	0	ADC interrupt flag Set by H/W at the end of conversion. S/W writes EFh to INTFLG or sets the ADSOC bit to clear this flag.
		2	IE2	R/W	0	External Interrupt 2 (INT2 pin) edge flag Set by H/W when a falling edge is detected on the INT2 pin state, no matter the EX2 is 0 or 1. It is cleared automatically when the program performs the interrupt service routine. S/W can write FBh to INTFLG to clear this bit.
		1	P1IF	R/W	0	Port1 pin change interrupt flag Set by H/W when a P1 pin state change is detected, and its interrupt enable bit is set (P1WKUP). P1IE does not affect this flag's setting. It is cleared automatically when the program performs the interrupt service routine. S/W can write FDh to INTFLG to clear this bit.
		0	TF3	R/W	0	Timer 3 interrupt flag Set by H/W when Timer3 reaches TM3PSC setting cycles. It is cleared automatically when the program performs the interrupt service routine. S/W can write FEh to INTFLG to clear this bit.
96h	P1WKUP	7~0	P1WKUP	R/W	00h	P1.7~P1.0 pin individual Wake up/Interrupt enable control 0: Disable 1: Enable
		7~0	SWRST	W		Write 56h to generate S/W Reset
97h	SWCMD	7~0	IAPALL	W		Write 65h to set IAPALL control flag; Write other value to clear IAPALL flag. It is recommended to clear it immediately after IAP access.
		0	IAPALL	R	0	Flag indicates Flash memory sectors can be accessed by IAP or not. This bit combines with MVCLOCK to define the accessible IAP area.

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SFR Name Bit # Bit Name R/W Rst Description 7 SM0 R/W 0 Serial port mode select bit 0,1 00: Mode0: 8 bit shift register, Baud Rate 01: Mode1: 8 bit UART, Baud Rate is van 10: Mode2: 9 bit UART, Baud Rate is van 11: Mode3: 9 bit UART, Baud Rate is van Serial port mode select bit 2 SM2 enables multiprocessor communicate SM3 enables SM2 enables multiprocessor communicate SM3 enables SM3 e	riable YSCLK/32 or /64 riable
7 SM0 R/W 0 00: Mode0: 8 bit shift register, Baud Rate 01: Mode1: 8 bit UART, Baud Rate is van 10: Mode2: 9 bit UART, Baud Rate = F _{SV} 11: Mode3: 9 bit UART, Baud Rate is van Serial port mode select bit 2 SM2 enables multiprocessor communicat serial line and modifies the above as follows a fixed of the received integenerated if the received ninth data bit the received interrupt will not be generated.	riable YSCLK/32 or /64 riable
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	YSCLK/32 or /64 riable
SM2 enables multiprocessor communicat serial line and modifies the above as follows: SM2 R/W 0 & 3, if SM2 is set then the received integenerated if the received ninth data bit the received interrupt will not be generated.	tion over a single
stop bit is received. In whose 0, SWI2 show	lows. In Modes 2 errupt will not be is 0. In Mode 1, ted unless a valid
98h SCON 4 REN R/W 0 UART reception enable 0: Disable reception 1: Enable reception	
3 TB8 R/W 0 Transmit Bit 8, the ninth bit to be transmand 3	
2 RB8 R/W 0 Receive Bit 8, contains the ninth bit that Mode 2 and 3 or the stop bit in Mode 1 if S	
Transmit interrupt flag Set by H/W at the end of the eighth bit the beginning of the stop bit in other cleared by S/W.	
RI R/W 0 Receive interrupt flag Set by H/W at the end of the eighth bit the sampling point of the stop bit in other cleared by S/W.	r modes. Must be
99h SBUF 7~0 SBUF R/W UART transmit and receive data. Transmit to this location and receive data is read from but the paths are independent.	
9Ah PWM0PRD 7~0 PWM0PRD R/W FFh PWM0 8-bit period register	
9Bh PWM0DH 7~0 PWM0DH R/W 80h bits 9~2 of the PWM0 10-bit duty register	
9Ch PWM1PRD 7~0 PWM1PRD R/W FFh PWM1 8-bit period register	
9Dh PWM1DH 7~0 PWM1DH R/W 80h bits 9~2 of the PWM1 10-bit duty register	
A0h P2 7~0 P2 R/W FFh Port2 data, also controls the P2.n pin's pu the P2.n SFR data is "1" and the correspo (input mode), the pull-up is enabled.	all-up function. If onding P2OE.n=0
7~6 PWM1CKS R/W 10 PWM1 clock source 00: F _{SYSCLK} /4 01: F _{SYSCLK} /2 10: F _{SYSCLK} 11: FRCx2	
A1h PWMCON 5~4 PWM1DL R/W 00 bits 1~0 of the PWM1 10-bit duty register	
A1h PWMCON 3~2 PWM0CKS R/W 10 00: F _{SYSCLK} /2 10: F _{SYSCLK} 11: FRCx2	
1~0 PWM0DL R/W 00 bits 1~0 of the PWM0 10-bit duty register	
7~6 P1MOD3 R/W 00 P1.3 pin control	
5~4 P1MOD2 R/W 00 P1.2 pin control	

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SFR Adr	SFR Name	Bit #	Bit Name	R/W	Rst	Description
		7~6	P1MOD7	R/W	00	P1.7 pin control
A 21	DIMODII	5~4	P1MOD6	R/W	00	P1.6 pin control
A3h	P1MODH	3~2	P1MOD5	R/W	00	P1.5 pin control
		1~0	P1MOD4	R/W	00	P1.4 pin control
		7~6	P3MOD3	R/W	01	P3.3 pin control
		5~4	P3MOD2	R/W	01	P3.2 pin control
A4h	P3MODL	3~2	P3MOD1	R/W	01	P3.1 pin control
		1~0	P3MOD0	R/W	01	P3.0 pin control
		1 0	TSMODO	10 11	01	Timer0 signal output (T0O) control
	D01 (0D1)	7	T0OE	R/W	0	0: Disable Timer0 overflow divided by 64 output to P3.4 1: Enable Timer0 overflow divided by 64 output to P3.4
A5h	P3MODH	5~4	P3MOD6	R/W	00	P3.6 pin control
		3~2	P3MOD5	R/W	00	P3.5 pin control
		1~0	P3MOD4	R/W	00	P3.4 pin control
		7	PWM1AOE	R/W	0	PWM1A signal output enable 0: Disable PWM1A signal output to P1.3 1: Enable PWM1A signal output to P1.3
	- A6h PINMOD -	6	PWM1BOE	R/W	0	PWM1B signal output enable (PWM1A and PWM1B signals are identical) 0: Disable PWM1B signal output to P2.3 1: Enable PWM1B signal output to P2.3
A Ch		5	PWM0AOE	R/W	0	PWM0A signal output enable 0: Disable PWM0A signal output to P1.2 1: Enable PWM0A signal output to P1.2
Aon	PINMOD	4	PWM0BOE	R/W	0	PWM0B signal output enable (PWM0A and PWM0B signals are identical) 0: Disable PWM0B signal output to P2.2 1: Enable PWM0B signal output to P2.2
		3	TCOE	R/W	0	TCOE: System clock signal output (CKO) control 0: Disable System clock divided by 2 output to P1.4 1: Enable System clock divided by 2 output to P1.4
		2	T2OE	R/W	0	Timer2 signal output (T2O) enable 0: Disable Timer2 overflow divided by 2 output to P1.0 1: Enable Timer2 overflow divided by 2 output to P1.0
		7	EA	R/W	0	Global interrupt enable 0: Disable all interrupts 1: Each interrupt is enabled or disabled by its individual interrupt control bit
A8h	A8h IE	5	ET2	R/W	0	Timer2 interrupt enable 0: Disable Timer2 interrupt 1: Enable Timer2 interrupt
		4	ES	R/W	0	Serial Port (UART) interrupt enable 0: Disable Serial Port (UART) interrupt 1: Enable Serial Port (UART) interrupt
		3	ET1	R/W	0	Timer1 interrupt enable 0: Disable Timer1 interrupt 1: Enable Timer1 interrupt



SFR	SFR Name	Bit #	Bit Name	R/W	Rst	Description
Adr						INT1 pin Interrupt enable and Stop mode wake up enable
		2	EX1	R/W	0	0: Disable INT1 pin Interrupt and Stop mode wake up 1: Enable INT1 pin Interrupt and Stop mode wake up, it can wake up CPU from Stop mode no matter EA is 0 or 1.
A8h	ΙE	1	ET0	R/W	0	Timer0 interrupt enable 0: Disable Timer0 interrupt 1: Enable Timer0 interrupt
		0	EX0	R/W	0	INT0 pin Interrupt enable and Stop mode wake up enable 0: Disable INT0 pin Interrupt and Stop mode wake up 1: Enable INT0 pin Interrupt and Stop mode wake up, it can wake up CPU from Stop mode no matter EA is 0 or 1.
		7~5	IAPWE	R/W	000	Set to 101 to enable IAP write. It is recommended to clear it immediately after IAP write.
		4	SPIE	R/W	0	SPI interrupt enable 0: Disable SPI interrupt 1: Enable SPI interrupt
		3	ADTKIE	R/W	0	ADC/Touch Key interrupt enable 0: Disable ADC/Touch Key interrupt 1: Enable ADC/Touch Key interrupt
A9h	A9h INTE1	2	EX2	R/W	0	INT2 pin Interrupt enable and Stop mode wake up enable 0: Disable INT2 pin Interrupt and Stop mode wake up 1: Enable INT2 pin Interrupt and Stop mode wake up, it can wake up CPU from Stop mode no matter EA is 0 or 1.
		1	P1IE	R/W	0	Port1 pin change interrupt enable 0: Disable Port1 pin change interrupt 1: Enable Port1 pin change interrupt
		0	TM3IE	R/W	0	Timer3 interrupt enable 0: Disable Timer3 interrupt 1: Enable Timer3 interrupt
		7~4	ADCDL	R		ADC data bit 3~0
A A 1	ADTIVOT	3	TKEOC	R		Touch Key end of conversion flag 0: Indicates conversion is in progress 1: Indicates conversion is finished
AAh	ADTKDT	2	TKOVF	R		Touch Key counter overflow 0: Indicates that the counter has not overflow 1: Indicates that the counter has overflow
		1~0	TKDH	R		Touch Key counter data bit 9~8
ABh	ADCDH	7~0	ADCDH	R		ADC data bit 11~4
ACh	TKDL	7~0	TKDL	R		Touch Key counter data bit 7~0
		7	TKPD	R/W	1	Touch Key power down 0: Touch Key running 1: Touch Key power down
ADh	TKCON	2~0	TKTMR	R/W	100	Touch Key conversion time select TKTMR adjusts the value of Touch Key reference voltage. A larger value of TKTMR requires a longer charging time, which can affect the sensitivity of touch sensing. 000: Conversion time shortest 111: Conversion time longest

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SFR	SFR Name	Bit #	Bit Name	R/W	Rst	Description
Adr	ADC channel select 0000: ADC0 (P3.3) 0001: ADC1 (P3.2) 0010: ADC2 (P3.1) 0011: ADC3 (P3.0) 0100: ADC4 (P1.0) 0101: ADC5 (P1.1) 0110: ADC6 (P1.2) 0111: ADC7 (P1.3) 1000: ADC8 (P1.4) 1001: ADC9 (P1.5) 1010: V _{SS} 1011: VBG (internal reference voltage) 11xx: Undefined Touch Key channel select		0001: ADC1 (P3.2) 0010: ADC2 (P3.1) 0011: ADC3 (P3.0) 0100: ADC4 (P1.0) 0101: ADC5 (P1.1) 0110: ADC6 (P1.2) 0111: ADC7 (P1.3) 1000: ADC8 (P1.4) 1001: ADC9 (P1.5) 1010: V _{SS} 1011: VBG (internal reference voltage)			
AEh	CHSEL	Touch Key channel select 0000: TK0 (P1.0) 0001: TK1 (P1.1) 0010: TK2 (P1.2) 0011: TK3 (P1.3) 0100: TK4 (P3.3) 0100: TK6 (P3.1) 0110: TK6 (P3.1) 0110: TK7 (P3.0) 1000: TK8 (P1.4) 1001: TK9 (P1.6) 1010: TK10 (P1.7) 1011: TK11 (P3.6) 1100: TK12 (P3.5) 1101: TK13 (P3.4) 1110: Undefined		0000: TK0 (P1.0) 0001: TK1 (P1.1) 0010: TK2 (P1.2) 0011: TK3 (P1.3) 0100: TK4 (P3.3) 0101: TK5 (P3.2) 0110: TK6 (P3.1) 0111: TK7 (P3.0) 1000: TK8 (P1.4) 1001: TK9 (P1.6) 1010: TK10 (P1.7) 1011: TK11 (P3.6) 1100: TK12 (P3.5) 1101: TK13 (P3.4) 1110: Undefined		
		7~4	ATKDT	R		Touch Key Auto Scan Result (for H/W ATK Mode) xxx1: TK0 has a Touch event xx1x: TK1 has a Touch event x1xx: TK2 has a Touch event 1xxx: TK3 has a Touch event
		Touch Key Auto Scan Result (for H/W ATK Mode) ATKDT R ATKDT R Touch Key Auto Scan Result (for H/W ATK Mode) xxx1: TK0 has a Touch event xx1x: TK1 has a Touch event x1xx: TK2 has a Touch event 1xxx: TK3 has a Touch event Touch Key Auto Scan Mode Enable 0: S/W Mode 1: H/W ATK Mode Touch Key Scan Rate (for H/W ATK Mode)				
AFh	Fh TKCON2		ATKRATE	R/W	0	Touch Key Scan Rate (for H/W ATK Mode) 0: ATK scan rate at every 4096 Slow clock cycles 1: ATK scan rate at every 2048 Slow clock cycles
		1~0	ATKNUM	R/W	11	Touch Key Auto Scan Channel Number (for H/W ATK Mode) 00: ATK only detect TK0 01: ATK detect TK0 and TK1 10: ATK detect TK0~TK2 11: ATK detect TK0~TK3
B0h	P3	7~0	P3	R/W	FFh	Port3 data



SFR Adr	SFR Name	Bit #	Bit Name	R/W	Rst	Description	
1101						LCD/LED enable bit	
		7	LCDON	R/W	0	0: LCD/LED disable	
	LCDCON2 LCDPIN					1: LCD/LED enable	
						LCD/LED duty select	
		6	LCDDUTY	R/W	1	0: 1/3 duty	
						1: 1/4 duty	
D 11.	I CDCON					LCD brightness select	
B1h	LCDCON					000: (12/20) x V _{CC}	
						001: (12/19) x V _{CC} 010: (12/18) x V _{CC}	
		2~0	LCDBRIT	R/W	100	011: (12/17) x V _{CC}	
		2 0	Lebbiai	10 11	100	100: (12/15) x V _{CC}	
						101: (12/14) x V _{CC}	
						110: (12/13) x V _{CC}	
						111: V _{CC}	
		_			_	LCD/LED clock source select	
		7	LCDCKS	R/W	0	0: SRC	
						1: SXT	
						LCD/LED clock prescaler select 00: LCD/LED clock is divided by 256	
		6~5	LCDPSC	R/W	00	01: LCD/LED clock is divided by 128	
		0.3	Lebise	10/11	00	10: LCD/LED clock is divided by 64	
						11: LCD/LED clock is divided by 32	
B2h	B2h LCDCON2					LED select mode	
			SELLED	R/W	0	0: LCD mode	
							1: LED mode
		_	2 LEDDOL		_	LED COM polarity select	
		3	LEDPOL	R/W	0	0: Active low (with high sink)	
						1: Active high LED COM dead time enable	
		2	LEDDTE	R/W	0	0: LED COM dead time disable	
		2	LEDDIE	10/11	U	1: LED COM dead time enable	
		7	LCDPIN7	R/W	0	P3.2 (SEG17) LCD/LED mode enable	
		6	LCDPIN6	R/W	0	P3.1 (SEG16) LCD/LED mode enable	
		5	LCDPIN5	R/W	0	P3.0 (SEG15) LCD/LED mode enable	
		4	LCDPIN4	R/W	0	P1.0 (SEG14) LCD/LED mode enable	
		3	LCDPIN3	R/W	0	P1.1 (SEG13) LCD/LED mode enable	
B3h	I CDPIN	2	LCDPIN2	R/W	0	P1.2 (SEG12) LCD/LED mode enable	
ווכם	LCDI IIV		202111	10 11		P1.3~P1.6 (SEG11~8) LCD/LED mode enable	
		1	LCDPIN1	R/W	0	Note : SEG9 and Touch Key CLD share the same pin. If	
						this bit is set, the Touch Key function would be affected.	
						P1.7, P3.6~P3.4 (SEG7~4) LCD/LED mode enable	
		0	LCDPIN0	R/W	0	0: I/O mode	
						1: LCD/LED mode	
		5	PT2	R/W	0	Timer2 interrupt priority low bit	
		4	PS	R/W	0	Serial Port interrupt priority low bit	
B8h	ĮΡ	3	PT1	R/W	0	Timer1 interrupt priority low bit	
		2	PX1	R/W	0	INT1 interrupt priority low bit	
		1	PT0	R/W	0	Timer0 interrupt priority low bit	
		0	PX0	R/W	0	INT0 interrupt priority low bit	



B9h	SFR Adr	SFR Name	Bit #	Bit Name	R/W	Rst	Description	
B9h			5	PT2H	R/W	0	Timer2 interrupt priority high bit	
PH			4	PSH	R/W	0	Serial Port interrupt priority high bit	
PATH R/W 0 INTT interrupt priority high bit	DOI:	IDII	3	PT1H	R/W	0	Timer1 interrupt priority high bit	
BAh	Byn	IPH	2	PX1H	R/W	0	INT1 interrupt priority high bit	
BAh			1	PT0H	R/W	0	Timer0 interrupt priority high bit	
BAh			0	PX0H	R/W	0	INT0 interrupt priority high bit	
BAh			4	PSPI	R/W	0	SPI interrupt priority low bit	
1			3	PADTKI	R/W	0	ADC/Touch Key interrupt priority low bit	
BBh	BAh	IP1	2	PX2	R/W	0	INT2 interrupt priority low bit	
BBh			1	PP1	R/W	0	Port1 pin change interrupt priority low bit	
BBh IPIH 2 PX2H R/W 0 ADC/Touch Key interrupt priority high bit 1 PP1H R/W 0 Port1 interrupt priority high bit 1 PP1H R/W 0 Port1 interrupt priority high bit 1 PP1H R/W 0 Port1 interrupt priority high bit 1 SP1 enable SP1 enable 1 SP1 enable 1 SP1 enable 1 SP1 enable 1 SP2 enable 1 SP3 enable 1 SP3 enable 1 SP4 enable 2 SP4 enable 1 SP4 enable 2 SP4 enable 3 SP4 enable 4 CPHA R/W 0 SP4 enable 3 SP4 enable 4 SP4 enable 3 SP4 enable 4 SP4 enable 5 SP4 enable 6 SP4 enable			0	PT3	R/W	0	Timer3 interrupt priority low bit	
BBh			4	PSPIH	R/W	0	SPI interrupt priority high bit	
1 PPIH R/W 0 Port1 interrupt priority high bit 0 PT3H R/W 0 Timer3 interrupt priority high bit 7 SPEN R/W 0 Timer3 interrupt priority high bit 8 Pl enable 1: SPI enable Master mode enable 1: SPI enable Master mode 1: Master mode 1: Master mode 1: Master mode 5 CPOL R/W 0 O: SCR is low in idle state 1: SCR is high in idle state 1: Disable SS pin disable 2 LSBF R/W 0 O: Enable SS pin 1: Disable SS pin 1: Disable SS pin 1: LSB first 2 LSBF R/W 0 O: MSB first 1: LSB first 2 SPI clock rate 00: Fsyscle/2 10: Fsyscle/4 10: Fsyscle/8 11: Fsyscle/16 SPI interrupt flag This is set by H/W at the end of a data transfer. Cleared by H/W when an interrupt is vectored into. Writing 0 to this bit will clear this flag. BDh SPSTA 6 WCOL R/W 0 Set by H/W i write data to SPDAT when SPBSY is cleared will clear this flag. Mode fault interrupt flag Set by H/W when SSDIS is cleared and SS pin is pulled			3	PADTKIH	R/W	0	ADC/Touch Key interrupt priority high bit	
O PT3H R/W 0 Timer3 interrupt priority high bit SPI enable O: SPI disable 1: SPI enable O: SPI disable 1: SPI enable O: SPI chock polarity SPI clock polarity O: Data sample on first edge of SCK period 1: Data sample on second edge of SCK period D: Data sample on second edge of SCK period SS pin disable SS pin	BBh	IP1H	2	PX2H	R/W	0	INT2 interrupt priority high bit	
7 SPEN R/W 0 0: SPI disable 1: SPI enable 1: Master mode enable 1: Master mode 1:			1	PP1H	R/W	0	Port1 interrupt priority high bit	
Part			0	РТ3Н	R/W	0	Timer3 interrupt priority high bit	
BCh SPCON CPOL R/W O Data sample on first edge of SCK period 1: Data sample on second edge of SCK perio							SPI enable	
BCh SPCON A			7	SPEN	R/W	0		
BCh SPCON SPCON SPCR R/W O O: Slave mode 1: Master mode SPI clock polarity O: SCK is low in idle state 1: SCK is high in idle state 1: SCK is high in idle state SPI clock phase O: Data sample on first edge of SCK period 1: Data sample on second edge of SCK period SS pin disable SS pin disable SS pin SSDIS R/W O: Enable SS pin 1: Disable SS pin 1: Disable SS pin 1: Disable SS pin SPI clock rate O: MSB first SPI clock rate O: Fsyscl.k/4 10: Fsyscl.k/4 10: Fsyscl.k/4 10: Fsyscl.k/8 11: Fsyscl.k/16 SPI interrupt flag This is set by H/W at the end of a data transfer. Cleared by H/W when an interrupt is vectored into. Writing 0 to this bit will clear this flag. Write Oto this bit or rewrite data to SPDAT when SPBSY is set by H/W when SSDIS is cleared and SS pin is pulled. Mode fault interrupt flag Set by H/W when SSDIS is cleared and SS pin is pulled.								
SPCON			_				Master mode enable	
SPI clock polarity O: SCK is low in idle state 1: SCK is high in idle state 1: Data sample on first edge of SCK period 1: Data sample on second edge of SCK period 1: Data sample on second edge of SCK period 1: Data sample on second edge of SCK period 1: Data sample on second edge of SCK period 1: Data sample on second edge of SCK period SS pin disable O: Enable SS pin SS pin disable O: Enable SS pin SS pin disable O: Enable SS pin disable O:			6	MSTR	R/W	0		
SPCON SPCO							1: Master mode SPI clock polarity	
BCh SPCON CPHA R/W 0 0 0 Data sample on first edge of SCK period 1 Data sample on second edge of SCK period 1 Data sample on second edge of SCK period 1 Data sample on second edge of SCK period 1 Data sample on second edge of SCK period SS pin disable SS pin 1 Disable SS pin 1 Disable SS pin 1 Disable SS pin 1 Disable SS pin 1 LSB first 1			5	CPOL	R/W	0		
BCh SPCON 4 CPHA R/W 0 SPI clock phase 0: Data sample on first edge of SCK period 1: Data sample on second edge of SCK period SS pin disable 0: Enable SS pin 1: Disable SS pin 1: LSB first 2 LSBF R/W 0 O: MSB first 1: LSB first SPI clock rate 00: Fsysclk/2 10: Fsysclk/4 10: Fsysclk/8 11: Fsysclk/8 11: Fsysclk/8 11: Fsysclk/16 SPI interrupt flag This is set by H/W at the end of a data transfer. Cleared by H/W when an interrupt is vectored into. Writing 0 to this bit will clear this flag. BDh SPSTA 6 WCOL R/W 0 WCOL R/W 0 Write 0 to this bit or rewrite data to SPDAT when SPBSY is set Write 0 to this bit or rewrite data to SPDAT when SPBSY is cleared will clear this flag. Mode fault interrupt flag Set by H/W when SSDIS is cleared and SS pin is pulled.			5	61 62	10 11	Ü	SPI clock polarity 0: SCK is low in idle state 1: SCK is high in idle state SPI clock phase	
BCh SPCON SPCON							1: SCK is high in idle state SPI clock phase	
BDh SPSTA SSDIS R/W 0 0: Enable SS pin 1: Disable SS pin 2 LSB first 0: MSB first 1: LSB first 1: LSB first 1: LSB first 2: LSB first 3: LSB first 3: LSB first 4: Disable SSPI clock rate 3: Disable S			4	CPHA	R/W	0	SPI clock phase 0	
SPSTA SSDIS R/W 0 0: Enable SS pin 1: Disable SS pin	BCh	SPCON						
BDh SPSTA SPIF R/W 0 1: Disable SS pin			2	aabia	D ATT	0		
BDh SPSTA 2 LSBF R/W 0 USBF first 0: MSB first 1: LSB first 1: LSB first SPI clock rate 00: F _{SYSCLK} /2 01: F _{SYSCLK} /4 10: F _{SYSCLK} /8 11: F _{SYSCLK} /16 SPIF R/W 0 SPIF R/W 0 SPI interrupt flag This is set by H/W at the end of a data transfer. Cleared by H/W when an interrupt is vectored into. Writing 0 to this bit will clear this flag. Write collision interrupt flag Set by H/W if write data to SPDAT when SPBSY is set Write 0 to this bit or rewrite data to SPDAT when SPBSY is cleared will clear this flag. Mode fault interrupt flag Set by H/W when SSDIS is cleared and SS pin is pulled.			3	SSDIS	R/W	0	=	
BDh SPSTA 2 LSBF R/W 0 0: MSB first 1: LSB first 1: LSB first SPI clock rate 00: F _{SYSCLK} /2 10: F _{SYSCLK} /4 10: F _{SYSCLK} /8 11: F _{SYSCLK} /16 SPI interrupt flag This is set by H/W at the end of a data transfer. Cleared by H/W when an interrupt is vectored into. Writing 0 to this bit will clear this flag. Write collision interrupt flag Set by H/W if write data to SPDAT when SPBSY is set Write 0 to this bit or rewrite data to SPDAT when SPBSY is cleared will clear this flag. Mode fault interrupt flag Set by H/W when SSDIS is cleared and SS pin is pulled.								
BDh SPSTA SPCR R/W O0 O1: F _{SYSCLK} /2 O1: F _{SYSCLK} /4 O1: F _{SYSCLK} /8 O2: F _{SYSCLK} /8 O3: F _{SYSCLK} /8 O4: F _{SYSCLK} /16 O4: F _{SYSCLK} /16 O5: F			2	LSBF	R/W	0		
SPI clock rate 00: F _{SYSCLK} /2 01: F _{SYSCLK} /4 10: F _{SYSCLK} /8 11: F _{SYSCLK} /16 7				_~	,			
BDh SPSTA SPCR								
BDh SPSTA This is set by H/W at the end of a data transfer. Cleared by H/W when an interrupt is vectored into. Writing 0 to this bit will clear this flag. WCOL R/W WCOL R/W WCOL WCOL R/W Wite collision interrupt flag Set by H/W if write data to SPDAT when SPBSY is set Write 0 to this bit or rewrite data to SPDAT when SPBSY is cleared will clear this flag. Mode fault interrupt flag Set by H/W when SSDIS is cleared and SS pin is pulled.								
BDh SPSTA This is set by H/W at the end of a data transfer. Cleared by H/W when an interrupt is vectored into. Writing 0 to this bit will clear this flag. WCOL R/W WCOL R/W WCOL R/W WCOL R/W Wite collision interrupt flag Set by H/W if write data to SPDAT when SPBSY is set Write 0 to this bit or rewrite data to SPDAT when SPBSY is cleared will clear this flag. Mode fault interrupt flag Set by H/W when SSDIS is cleared and SS pin is pulled.			1~0	SPCR	R/W	00		
BDh SPSTA 6 WCOL R/W 0 SPI interrupt flag This is set by H/W at the end of a data transfer. Cleared by H/W when an interrupt is vectored into. Writing 0 to this bit will clear this flag. Write collision interrupt flag Set by H/W if write data to SPDAT when SPBSY is set Write 0 to this bit or rewrite data to SPDAT when SPBSY is cleared will clear this flag. Mode fault interrupt flag Set by H/W when SSDIS is cleared and SS pin is pulled.								
BDh SPSTA 6 WCOL R/W 0 This is set by H/W at the end of a data transfer. Cleared by H/W when an interrupt is vectored into. Writing 0 to this bit will clear this flag. Write collision interrupt flag Set by H/W if write data to SPDAT when SPBSY is set Write 0 to this bit or rewrite data to SPDAT when SPBSY is cleared will clear this flag. Mode fault interrupt flag Set by H/W when SSDIS is cleared and SS pin is pulled.								
BDh SPSTA 6 WCOL R/W 0 by H/W when an interrupt is vectored into. Writing 0 to this bit will clear this flag. Write collision interrupt flag Set by H/W if write data to SPDAT when SPBSY is set Write 0 to this bit or rewrite data to SPDAT when SPBSY is cleared will clear this flag. Mode fault interrupt flag Set by H/W when SSDIS is cleared and SS pin is pulled.								
BDh SPSTA 6 WCOL R/W 0 Write collision interrupt flag Set by H/W if write data to SPDAT when SPBSY is set Write 0 to this bit or rewrite data to SPDAT when SPBSY is cleared will clear this flag. Mode fault interrupt flag Set by H/W when SSDIS is cleared and SS pin is pulled.			7	SPIF	R/W	0		
BDh SPSTA 6 WCOL R/W 0 Write collision interrupt flag Set by H/W if write data to SPDAT when SPBSY is set Write 0 to this bit or rewrite data to SPDAT when SPBSY is cleared will clear this flag. Mode fault interrupt flag Set by H/W when SSDIS is cleared and SS pin is pulled.								
BDh SPSTA O WCOL R/W O Write 0 to this bit or rewrite data to SPDAT when SPBSY is cleared will clear this flag. Mode fault interrupt flag Set by H/W when SSDIS is cleared and SS pin is pulled								
is cleared will clear this flag. Mode fault interrupt flag Set by H/W when SSDIS is cleared and SS pin is pulled			6	WCOI	R/W	0		
Mode fault interrupt flag Set by H/W when SSDIS is cleared and SS pin is pulled	BDh	SPSTA	O	WEGE	10/11	U		
Set by H/W when SSDIS is cleared and SS pin is pulled								
I TO I MODE IR/WII () I low in Master mode. Write () to this hit will clear this flag			5	MODF	R/W	0	low in Master mode. Write 0 to this bit will clear this flag.	
			5	MODI	17/ 44	U	When this bit is set, the SPEN and MSTR in SPCON will	
be cleared by H/W.								



SFR	SFR Name	Bit #	Dit Nama	R/W	Dat	Description	
Adr	SFK Name	DIL#	Bit Name	K/VV	Rst	Description	
		4	RCVOVF	R/W	0	Received buffer overrun flag Set by H/W at the end of a data transfer and RCVBF is set. Write 0 to this bit or read SPDAT register will clear this flag.	
BDh	SPSTA	3	RCVBF	R/W	0	Receive buffer full flag Set by H/W at the end of a data transfer. Write 0 to this bit or read SPDAT register will clear this flag.	
		2	SPBSY	R		SPI busy flag Set by H/W when a SPI transfer is in progress.	
BEh	SPDAT	7~0	SPDAT	R/W	0	SPI transmit and receive data The SPDAT register is used to transmit and receive of Writing data to SPDAT place the data into shift regard start a transfer when in master mode. Rea SPDAT returns the contents of the receive buffer.	
C2h	ATKC10H	6~4	ATKC1H	R/W	000	Data Threshold bit 10~8 Compared with TK1 scan (for H/W ATK Mode)	
CZII	AIRCIOH	2~0	ATKC0H	R/W	000	(for H/W ATK Mode) Data Threshold bit 10~8 Compared with TK0 scan (for H/W ATK Mode) Data Threshold bit 10~8 Compared with TK3 scan (for H/W ATK Mode) Data Threshold bit 10~8 Compared with TK2 scan (for H/W ATK Mode) Data Threshold bit 7~0 Compared with TK0 scan (for H/W ATK Mode)	
C21-	ATIZCOLI	6~4	АТКС3Н	R/W	000		
C3h	ATKC32H	2~0	ATKC2H	R/W	000		
C4h	ATKC0L	7~0	ATKC0L	R/W	40h	<u>-</u>	
C5h	ATKC1L	7~0	ATKC1L	R/W	40h	Data Threshold bit 7~0 Compared with TK1 scan (for H/W ATK Mode)	
C6h	ATKC2L	7~0	ATKC2L	R/W	40h	Data Threshold bit 7~0 Compared with TK2 scan	
C7h	ATKC3L	7~0	ATKC3L	R/W	40h	(for H/W ATK Mode)	
		7	TF2	R/W	0	Timer2 overflow flag Set by H/W when Timer/Counter 2 overflows unless RCLK=1 or TCLK=1. This bit must be cleared by S/W.	
		6	EXF2	R/W	0	T2EX interrupt pin falling edge flag Set when a capture or a reload is caused by a negative transition on T2EX pin if EXEN2=1. This bit must be cleared by S/W.	
		5	RCLK	R/W	0	UART receive clock control bit 0: Use Timer1 overflow as receive clock for serial port in mode 1 or 3 1: Use Timer2 overflow as receive clock for serial port in mode 1 or 3	
C8h	C8h T2CON		TCLK	R/W	0	UART transmit clock control bit 0: Use Timer1 overflow as transmit clock for serial port in mode 1 or 3 1: Use Timer2 overflow as transmit clock for serial port in mode 1 or 3	
		3	EXEN2	R/W	0	T2EX pin enable 0: T2EX pin disable 1: T2EX pin enable, it cause a capture or reload when a negative transition on T2EX pin is detected if RCLK= TCLK=0	
		2	TR2	R/W	0	Timer2 run control 0: Timer2 stops 1: Timer2 runs	

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SFR	G== 17	-A. //				
Adr	SFR Name	Bit #	Bit Name	R/W	Rst	Description
		1	CT2N	R/W	0	Timer2 Counter/Timer select bit 0: Timer mode, Timer2 data increases at 2 System clock cycle rate 1: Counter mode, Timer2 data increases at T2 pin's negative edge
C8h	T2CON	0	CPRL2N	R/W	0	Timer2 Capture/Reload control bit 0: Reload mode, auto-reload on Timer2 overflows or negative transitions on T2EX pin if EXEN2=1 1: Capture mode, capture on negative transitions on T2EX pin if EXEN2=1 If RCLK=1 or TCLK=1, CPRL2N is ignored and timer is forced to auto-reload on Timer2 overflow
CAh	RCP2L	7~0	RCP2L	R/W	00h	Timer2 reload/capture data low byte
CBh	RCP2H	7~0	RCP2H	R/W	00h	Timer2 reload/capture data high byte
CCh	TL2	7~0	TL2	R/W	00h	Timer2 data low byte
CDh	TH2	7~0	TH2	R/W	00h	Timer2 data high byte
		7	CY	R/W	0	ALU carry flag
		6	AC	R/W	0	ALU auxiliary carry flag
		5	F0	R/W	0	General purpose user-definable flag
		4 RS1 R/W 0 banks as 00: Ban		0	The contents of (RS1, RS0) enable the working register banks as: 00: Bank 0 (00h~07h)	
D0h	PSW	3	RS0	R/W	0	01: Bank 1 (08h~0Fh) 10: Bank 2 (10h~17h) 11: Bank 3 (18h~1Fh)
		2	OV	R/W	0	ALU overflow flag
		1	F1	R/W	0	General purpose user-definable flag
		0	P	R/W	0	Parity flag. Set/cleared by hardware each instruction cycle to indicate odd/even number of "one" bits in the accumulator.
		7	SCKTYPE	R/W	0	Slow clock type. This bit can be changed only in Fast mode (SELFCK=1). 0: SRC 1: SXT
		6	FCKTYPE	R/W	0	Fast clock type. This bit can be changed only in Slow mode (SELFCK=0). 0: FRC 1: FXT
		4	STPPCK	R/W	0	Set 1 to stop UART/Timer0/Timer1/Timer2/ADC clock in Idle mode
D8h	CLKCON	3	STPFCK	R/W	0	Set 1 to stop Fast clock for power saving in Slow/Idle mode. This bit can be changed only in Slow mode.
			SELFCK	R/W	0	System clock source selection. This bit can be changed only when STPFCK=0. 0: Slow clock 1: Fast clock
		1~0	CLKPSC	R/W	11	System clock prescaler. 00: System clock is Fast/Slow clock divided by 16 01: System clock is Fast/Slow clock divided by 4 10: System clock is Fast/Slow clock divided by 2 11: System clock is Fast/Slow clock divided by 1
E0h	ACC	7~0	ACC	R/W	00h	Accumulator
F0h	В	7~0	В	R/W	00h	B register

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SFR Adr	SFR Name	Bit #	Bit Name	R/W	Rst	Description		
F7h	0x: Watchdog Timer Reset disable 7~6 WDTE R/W 10: Watchdog Timer Reset enable in Fast/Slow		10: Watchdog Timer Reset enable in Fast/Slow mode, disable in Idle/Stop mode					
		4~0	FRCF	R/W		Fast RC frequency adjustment		
		7	CLRWDT	R/W	0	Set to clear WDT, H/W auto clear it at next clock cycle		
		6			Set to clear Timer3, H/W auto clear it at next clock cycle			
	-		TKSOC	R/W	0	Start Touch Key conversion Set the TKSOC bit to start Touch Key conversion, and the TKSOC bit will be cleared by H/W at the end of conversion. S/W can also write 0 to clear this flag.		
F8h	AUX1	4	ADSOC	R/W	0	Start ADC conversion Set the ADSOC bit to start ADC conversion, and the ADSOC bit will be cleared by H/W at the end of conversion. S/W can also write 0 to clear this flag.		
		3	CLRPWM0	R/W	0	PWM0 clear enable 0: PWM0 is running 1: PWM0 is cleared and held		
		0	DPSEL	R/W	0	Active DPTR Select		

Flash Adr	Bit #	Name	Description
1FFEh	4~0	FRCF	Fast RC frequency adjustment
	7	PROT	Flash Memory Code Protect 0: Disable protect 1: Enable protect
	6	XRSTE	External Pin Reset control 0: Disable External Pin Reset 1: Enable External Pin Reset
1FFFh	5~4	LVRE	Low Voltage Reset function select 00: Set LVR at 2.9V 01: Set LVR at 2.3V 10: LVR disable and set LVD at 2.3V 11: Set LVR at 1.8V and LVD at 2.3V
	3	VCCFLT	Set 1 to enhance the Chip's power noise immunity
	2	PWRSAV	Power save function control bit 0: Disable Power save function 1: Enable Power save function
	1	MVCLOCK	If 1, the MOVC & MOVX instruction's accessibility to MOVC-Lock area is limited.

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INSTRUCTION SET

Instructions are 1, 2 or 3 Bytes long as listed in the 'byte' column below. Each instruction takes 2~8 System clock cycles to execute as listed in the 'cycle' column below.

	ARITHMETIC								
Mnemonic	Description	byte	cycle	opcode					
ADD A, Rn	Add register to A	1	2	28-2F					
ADD A, dir	Add direct byte to A	2	2	25					
ADD A, @Ri	Add indirect memory to A	1	2	26-27					
ADD A, #data	Add immediate to A	2	2	24					
ADDC A, Rn	Add register to A with carry	1	2	38-3F					
ADDC A, dir	Add direct byte to A with carry	2	2	35					
ADDC A, @Ri	Add indirect memory to A with carry	1	2	36-37					
ADDC A, #data	Add immediate to A with carry	2	2	34					
SUBB A, Rn	Subtract register from A with borrow	1	2	98-9F					
SUBB A, dir	Subtract direct byte from A with borrow	2	2	95					
SUBB A, @Ri	Subtract indirect memory from A with borrow	1	2	96-97					
SUBB A, #data	Subtract immediate from A with borrow	2	2	94					
INC A	Increment A	1	2	04					
INC Rn	Increment register	1	2	08-0F					
INC dir	Increment direct byte	2	2	05					
INC @Ri	Increment indirect memory	1	2	06-07					
DEC A	Decrement A	1	2	14					
DEC Rn	Decrement register	1	2	18-1F					
DEC dir	Decrement direct byte	2	2	15					
DEC @Ri	Decrement indirect memory	1	2	16-17					
INC DPTR	Increment data pointer	1	4	A3					
MUL AB	Multiply A by B	1	8	A4					
DIV AB	Divide A by B	1	8	84					
DA A	Decimal Adjust A	1	2	D4					

	LOGICAL			
Mnemonic	Description	byte	cycle	opcode
ANL A, Rn	AND register to A	1	2	58-5F
ANL A, dir	AND direct byte to A	2	2	55
ANL A, @Ri	AND indirect memory to A	1	2	56-57
ANL A, #data	AND immediate to A	2	2	54
ANL dir, A	AND A to direct byte	2	2	52
ANL dir, #data	AND immediate to direct byte	3	4	53
ORL A, Rn	OR register to A	1	2	48-4F
ORL A, dir	OR direct byte to A	2	2	45
ORL A, @Ri	OR indirect memory to A	1	2	46-47
ORL A, #data	OR immediate to A	2	2	44
ORL dir, A	OR A to direct byte	2	2	42
ORL dir, #data	OR immediate to direct byte	3	4	43
XRL A, Rn	Exclusive-OR register to A	1	2	68-6F
XRL A, dir	Exclusive-OR direct byte to A	2	2	65
XRL A, @Ri	Exclusive-OR indirect memory to A	1	2	66-67
XRL A, #data	Exclusive-OR immediate to A	2	2	64
XRL dir, A	Exclusive-OR A to direct byte	2	2	62
XRL dir, #data	Exclusive-OR immediate to direct byte	3	4	63
CLR A	Clear A	1	2	E4
CPL A	Complement A	1	2	F4
SWAP A	Swap Nibbles of A	1	2	C4
RL A	Rotate A left	1	2	23

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	LOGICAL			
Mnemonic	Description	byte	cycle	opcode
RLC A	Rotate A left through carry	1	2	33
RR A	Rotate A right	1	2	03
RRC A	Rotate A right through carry	1	2	13

	DATA TRANSFER								
Mnemonic	Description	byte	cycle	opcode					
MOV A, Rn	Move register to A	1	2	E8-EF					
MOV A, dir	Move direct byte to A	2	2	E5					
MOV A, @Ri	Move indirect memory to A	1	2	E6-E7					
MOV A, #data	Move immediate to A	2	2	74					
MOV Rn, A	Move A to register	1	2	F8-FF					
MOV Rn, dir	Move direct byte to register	2	4	A8-AF					
MOV Rn, #data	Move immediate to register	2	2	78-7F					
MOV dir, A	Move A to direct byte	2	2	F5					
MOV dir, Rn	Move register to direct byte	2	4	88-8F					
MOV dir, dir	Move direct byte to direct byte	3	4	85					
MOV dir, @Ri	Move indirect memory to direct byte	2	4	86-87					
MOV dir, #data	Move immediate to direct byte	3	4	75					
MOV @Ri, A	Move A to indirect memory	1	2	F6-F7					
MOV @Ri, dir	Move direct byte to indirect memory	2	4	A6-A7					
MOV @Ri, #data	Move immediate to indirect memory	2	2	76-77					
MOV DPTR, #data	Move immediate to data pointer	3	4	90					
MOVC A, @A+DPTR	Move code byte relative DPTR to A	1	4	93					
MOVC A, @A+PC	Move code byte relative PC to A	1	4	83					
MOVX A, @Ri	Move external data(A8) to A	1	4	E2-E3					
MOVX A, @DPTR	Move external data(A16) to A	1	4	E0					
MOVX @Ri, A	Move A to external data(A8)	1	4	F2-F3					
MOVX @DPTR, A	Move A to external data(A16)	1	4	F0					
PUSH dir	Push direct byte onto stack	2	4	C0					
POP dir	Pop direct byte from stack	2	4	D0					
XCH A, Rn	Exchange A and register	1	2	C8-CF					
XCH A, dir	Exchange A and direct byte	2	2	C5					
XCH A, @Ri	Exchange A and indirect memory	1	2	C6-C7					
XCHD A, @Ri	Exchange A and indirect memory nibble	1	2	D6-D7					

BOOLEAN							
Mnemonic	Description	byte	cycle	opcode			
CLR C	Clear carry	1	2	C3			
CLR bit	Clear direct bit	2	2	C2			
SETB C	Set carry	1	2	D3			
SETB bit	Set direct bit	2	2	D2			
CPL C	Complement carry	1	2	В3			
CPL bit	Complement direct bit	2	2	B2			
ANL C, bit	AND direct bit to carry	2	4	82			
ANL C, /bit	AND direct bit inverse to carry	2	4	В0			
ORL C, bit	OR direct bit to carry	2	4	72			
ORL C, /bit	OR direct bit inverse to carry	2	4	A0			
MOV C, bit	Move direct bit to carry	2	2	A2			
MOV bit, C	Move carry to direct bit	2	4	92			

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BRANCHING							
Mnemonic	Description	byte	cycle	opcode			
ACALL addr 11	Absolute jump to subroutine	2	4	11-F1			
LCALL addr 16	Long jump to subroutine	3	4	12			
RET	Return from subroutine	1	4	22			
RETI	Return from interrupt	1	4	32			
AJMP addr 11	Absolute jump unconditional	2	4	01-E1			
LJMP addr 16	Long jump unconditional	3	4	02			
SJMP rel	Short jump (relative address)	2 2	4	80			
JC rel	Jump on carry=1	2	4	40			
JNC rel	Jump on carry=0	2	4	50			
JB bit, rel	Jump on direct bit=1	3	4	20			
JNB bit, rel	Jump on direct bit=0	3	4	30			
JBC bit, rel	Jump on direct bit=1 and clear	3	4	10			
JMP @A+DPTR	Jump indirect relative DPTR	1	4	73			
JZ rel	Jump on accumulator=0	2	4	60			
JNZ rel	Jump on accumulator 0	2 2	4	70			
CJNE A, dir,rel	Compare A, direct, jump not equal relative	3	4	B5			
CJNE A, #data,rel	Compare A,immediate, jump not equal relative	3	4	B4			
CJNE Rn, #data,rel	Compare register, immediate, jump not equal relative	3	4	B8-BF			
CJNE @Ri, #data,rel	Compare indirect,immediate, jump not equal relative	3	4	B6-B7			
DJNZ Rn, rel	Decrement register, jump not zero relative	2	4	D8-DF			
DJNZ dir, rel	Decrement direct byte, jump not zero relative	3	4	D5			

MISCELLANEOUS							
Mnemonic	Description	byte	cycle	opcode			
NOP	No operation	1	2	00			

In the above table, an entry such as E8-EF indicates a continuous block of hex opcodes used for 8 different registers, the register numbers of which are defined by the lowest three bits of the corresponding code. Non-continuous blocks of codes, shown as 11-F1 (for example), are used for absolute jumps and calls with the top 3 bits of the code being used to store the top three bits of the destination address.

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ELECTRICAL CHARACTERISTICS

1. Absolute Maximum Ratings (T_A=25°C)

Parameter	Rating	Unit
Supply voltage	$V_{SS} - 0.3 \sim V_{SS} + 5.5$	
Input voltage	$V_{SS} - 0.3 \sim V_{CC} + 0.3$	V
Output voltage	$V_{SS} - 0.3 \sim V_{CC} + 0.3$	
Output current high per 1 PIN	-25	
Output current high per all PIN	-80	A
Output current low per 1 PIN	+30	mA
Output current low per all PIN	+150	
Maximum Operating Voltage	5.5	V
Operating temperature	−20 ~ +70	°C
Storage temperature	−65 ~ +150	

2. DC Characteristics ($T_A=25$ °C, $V_{CC}=2.0V \sim 5.5V$)

Parameter	Symbol	Cone	Min.	Typ.	Max.	Unit				
		Fast mode, F _{SYSCLK} =7.3728 MHz		2.3	_	5.5				
		Fast mode, F _{SYS}	_{SCLK} =3.6864 MHz	2.0	_	5.5				
Operating Voltage	V_{CC}	Fast mode, F _{SYS}	_{SCLK} =1.8432 MHz	1.3	_	5.5	V			
Voltage		Fast mode, F _{SYS}	_{SCLK} =0.4608 MHz	1.3	_	5.5				
		Slow m	ode, SRC	1.3	_	5.5				
		All Input, except	V _{CC} =5V	$0.6V_{CC}$	_	_				
Input High	17	P3.7, P2.1	V _{CC} =3V	$0.6V_{CC}$	_	_	V			
Voltage	V_{IH}	P3.7, P2.1	$V_{CC}=5V$	$0.8V_{CC}$	_	_	V			
		F3.7, F2.1	$V_{CC}=3V$	$0.8V_{CC}$	_	_				
Input Low	V_{IL}	All Input	$V_{CC}=5V$	_	_	$0.2V_{CC}$	V			
Voltage	V _{IL}	All Input	$V_{CC}=3V$	_	_	$0.2V_{CC}$	V			
I/O Port Source	${ m I}_{ m OH}$	I_{OH}	I_{OH}	All Output, except	V_{CC} =5V V_{OH} =0.9 V_{CC}	6	12	_	A	
Current				IOH	P3.7	$V_{\text{CC}}=3V$ $V_{\text{OH}}=0.9V_{\text{CC}}$	2.5	5	_	mA
	I _{OL} -	All Output, except	$V_{CC}=5V$ $V_{OL}=0.1V_{CC}$	12	24	_				
I/O Port Sink		T	Ţ	7	P0.0~P0.3	$V_{CC}=3V$ $V_{OL}=0.1V_{CC}$	6	12	_	A
Current		P0.0~P0.3	$V_{CC}=5V$ $V_{OL}=0.1V_{CC}$	35	70	_	mA			
		P0.0~P0.3	V_{CC} =3V V_{OL} =0.1 V_{CC}	20	40	_				
Input Leakage Current (pin high)	$I_{\rm ILH}$	All Input	$V_{in} = V_{CC}$	_	-	1	^			
Input Leakage Current (pin low)	I_{IILL}	All Input	V _{in} =0V	_	_	-1	μA			

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Parameter	Symbol	Con	Min.	Тур.	Max.	Unit	
		Fast, V _{CC} =5V	FXT=8 MHz	_	3.7	_	
		LVR enable	FRC=7.3728 MHz	_	3	_	
		MODE3V=0	FRC=3.6864 MHz	_	1.8	_	
		Fast, V _{CC} =3V	FXT=8 MHz	_	2.7	_	
		LVR enable MODE3V=0	FRC=7.3728 MHz	_	2.5	_	mA
			FRC=3.6864 MHz FXT=8 MHz	_	1.5 2.5	_	
		Fast, V _{CC} =3V LVR enable	FRC=7.3728 MHz		2.3	_	
		MODE3V=1	FRC=3.6864 MHz	_	1.4	_	
		Slow, V _{CC} =5V	SXT=32 KHz	_	220	_	
		LVR enable MODE3V=0	SRC=24 KHz	_	205	_	
		Slow, V _{CC} =3V	SXT=32 KHz	_	180	_	
		LVR enable MODE3V=0	SRC=24 KHz	_	175	_	
		Slow, V _{CC} =3V MODE3V=1	SXT=32 KHz	_	13	_	
		PWRSAV=1	SRC=24 KHz	_	9	_	
		Slow, V _{CC} =3V MODE3V=1	SXT=32 KHz	_	54	_	
		PWRSAV=0	SRC=24 KHz	_	50	_	
		Idle, V _{CC} =5V	SXT=32 KHz	_	205	_	
	I_{CC}	LVR enable MODE3V=0	SRC=24 KHz	_	195	_	
Supply Current		Idle, V _{CC} =3V	SXT=32 KHz	_	168	_	
		LVR enable MODE3V=0	SRC=24 KHz	_	166	_	
		Idle, V _{CC} =3V	SXT=32 KHz	_	5	_	
		MODE3V=1 PWRSAV=1	SRC=24 KHz	_	3	_	μA
		Idle, V _{CC} =3V MODE3V=1	SXT=32 KHz	_	46	_	
		PWRSAV=0	SRC=24 KHz	_	43	_	
		Stop, V _{CC} =5V LVR disable	PWRSAV=1	_	0.1	_	
		MODE3V=0	PWRSAV=0	_	158	_	
		Stop, V _{CC} =3V LVR disable	PWRSAV=1	_	_	0.1	
		MODE3V=0	PWRSAV=0	_	136	_	
		Stop, V _{CC} =5V LVR enable	PWRSAV=1	_	1.7	_	
		MODE3V=0	PWRSAV=0	_	194	_	
		Stop, $V_{CC} = 3V$ LVR enable	PWRSAV=1	_	0.5	_	
		MODE3V=0	PWRSAV=0	_	165	_	
			LVR disable	_	_	0.1	
		Stop, V _{CC} =3V MODE3V=1	LVR enable PWRSAV=1	_	0.5	_	
		MODESV-1	LVR enable PWRSAV=0	_	41	_	



Parameter	Symbol	Con	ditions	Min.	Тур.	Max.	Unit		
Ct Cl1			V _{CC} =2.9V	_	_	8			
System Clock Frequency	F_{SYSCLK}	$V_{CC}>LVR_{th}$	$V_{CC}=2.3V$	_		7.3728	MHz		
1 requerie y			$V_{CC}=2.0V$	-	1	4			
LVR Reference				+3%	2.9	+3%			
Voltage	V_{LVR}	$T_A=25$ °C		+3%	2.3	+3%	V		
Voltage				-8%	1.8	+8%			
LVR Hysteresis Voltage	V_{HYST}	T _A =25°C		_	±0.1	_	V		
LVD Reference Voltage	V_{LVD}	T _A =25°C		_	2.3	_	V		
Low Voltage Detection time	t_{LVR}	T _A =25°C		100	-	_	μs		
Pull-Up Resistor		$V_{IN}=0V$	$V_{CC}=5V$		120				
	D	All except P3.7	$V_{CC}=3V$	_	240	_	ΚΩ		
	R_P	$V_{IN}=0V$	$V_{CC}=5V$		170		K32		
						P3.7	$V_{CC}=3V$	_	170

3. Clock Timing $(T_A = -40^{\circ}\text{C} \sim +85^{\circ}\text{C}, V_{CC} = 2.6\text{V} \sim 5.5\text{V})$

Parameter	Conditions	Min.	Typ.	Max.	Unit
Internal RC Frequency	25° C, V_{CC} = $3.0 \sim 5.5$ V	7.142	7.3728	7.6032	
	25° C, V_{CC} = $2.6 \sim 3.0$ V	7.004	7.3728	7.7414	MHz
	-40 °C ~ 85°C, V_{CC} =2.6 ~ 5.5V	6.192	7.3728	7.8336	

4. Reset Timing Characteristics ($T_A = -40$ °C ~ +85°C, $V_{CC} = 3.0$ V ~ 5.0V)

Parameter	Conditions		Тур.	Max.	Unit
RESET Input Low width	Input V_{CC} =5.0V ±10 %	90	_	_	μs
WDT wakeup time	V_{CC} =5.0V, WDTPSC=11	_	40	-	me
	V_{CC} =3.0V, WDTPSC=11	_	40	ı	ms

5. ADC Electrical Characteristics ($T_A=25$ °C, $V_{CC}=3.0V \sim 5.5V$, $V_{SS}=0V$)

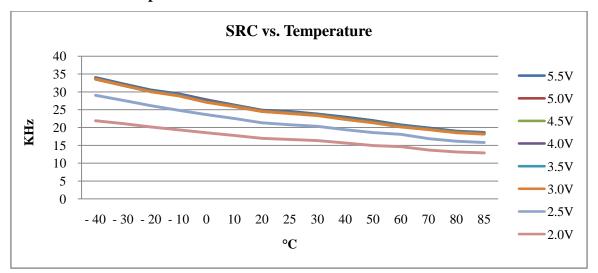
Parameter	Conditions		Typ.	Max.	Unit
Total Accuracy	V _5 12V V _0V	_	±2.5	±4	LSB
Integral Non-Linearity	V_{CC} =5.12V, V_{SS} =0V		±3.2	±5	LSD
Max Input Clock (f _{ADC})	ľ	_	ı	1	MHz
Conversion Time	f _{ADC} =1 MHz	_	50	-	μs
BandGap Voltage	$V_{CC}=3V$	1.14	1.22	1.30	V
Reference	$V_{CC}=5V$	1.15	1.25	1.35	V
Input Voltage	-	V_{SS}	_	V_{CC}	V

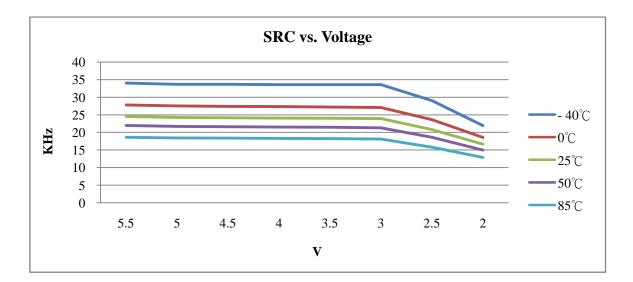
 $\it Note:$ also refer to AP-TM52XXXXX_05S for using ADC to trim BandGap.

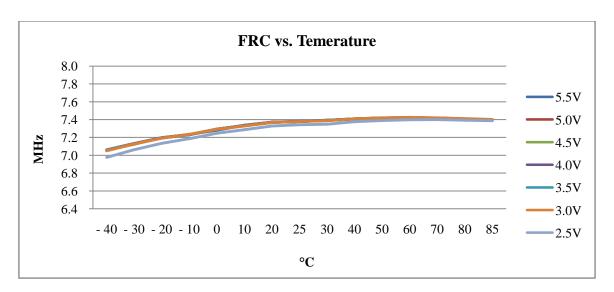
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6. Characteristics Graphs

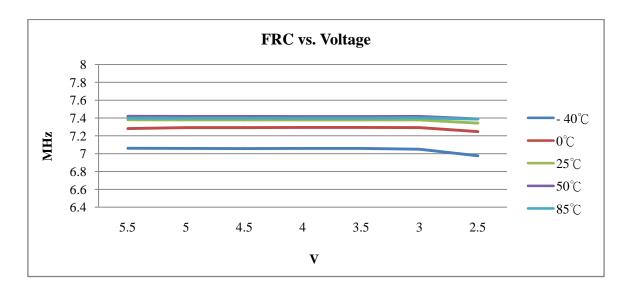


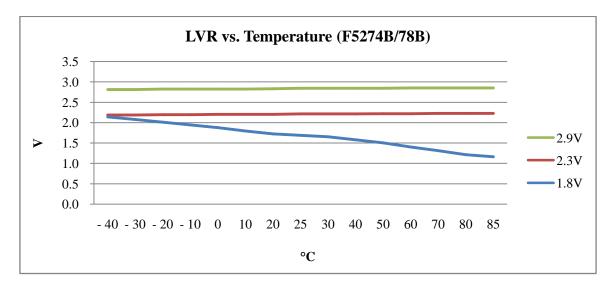


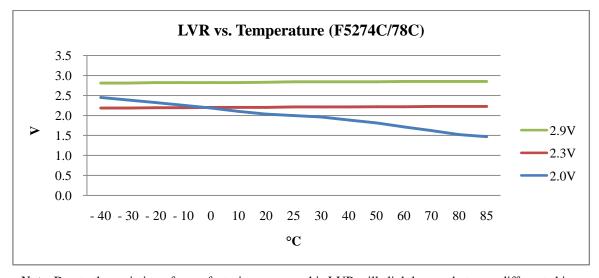


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Note: Due to the variation of manufacturing process, this LVR will slightly vary between different chips.

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Package Information

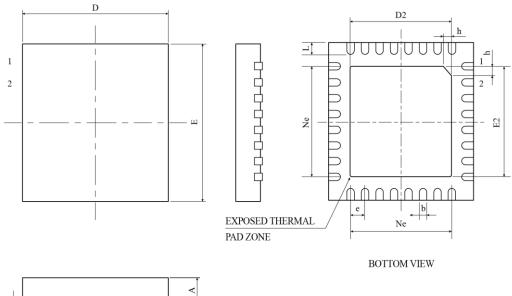
Ordering Information

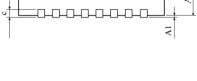
Ordering Number	Package
TM52F0200-MTP-98	QFN32 Pin (5*5*0.75mm)
TM52F0200-COD-98	QFN32 Pin (5*5*0.75mm)

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QFN 32 pin(5*5*0.75 – 0.5mm) Package Dimension





SYMBOL	DIMENSION IN MM			DIMENSION IN INCH			
SIMBOL	MIN	NOM	MAX	MIN	NOM	MAX	
A	0.70	0.75	0.80	0.028	0.030	0.031	
A1		0.02	0.05	-	0.001	0.002	
b	0.18	0.25	0.30	0.007	0.010	0.012	
С	0.18	0.20	0.25	0.007	0.008	0.010	
D	4.90	5.00	5.10	0.193	0.197	0.201	
D2	3.40	3.50	3.60	0.134	0.138	0.142	
e		0.50 BSC		0.020 BSC			
Ne		3.50 BSC		0.138 BSC			
Е	4.90	5.00	5.10	0.193	0.197	0.201	
E2	3.40	3.50	3.60	0.134	0.138	0.142	
L	0.35	0.40	0.45	0.014	0.016	0.018	
h	0.30	0.35	0.40	0.012	0.014	0.016	

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